



Airoha IoT SDK for BT Audio Release Notes V3

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Release date: 28 December 2023

Document Revision History

Revision	Date	Description
1.0.0	1 July 2019	Initial release
1.0.1	15 July 2019	Fixed software issues
1.1.0	6 September 2019	<ul style="list-style-type: none"> Added new features Fixed software issues
1.2.0	28 September 2019	<ul style="list-style-type: none"> Added new features
1.2.1	21 October 2019	<ul style="list-style-type: none"> Fixed software issues
1.3.0	15 November 2019	<ul style="list-style-type: none"> Added new features Added a migration guide to migrate applications from SDK v1.2.1 to SDK v1.3.0
1.3.1	2 December 2019	<ul style="list-style-type: none"> Fixed software issues
1.3.2	23 December 2019	<ul style="list-style-type: none"> Fixed software issues
1.4.0	22 January 2020	<ul style="list-style-type: none"> Added new features Added a migration guide to migrate applications from SDK v1.3.2 to SDK v1.4.0 Fixed software issues
1.5.0	1 March 2020	<ul style="list-style-type: none"> Added new features Fixed software issues
1.6.0	22 April 2020	<ul style="list-style-type: none"> Added new features Fixed software issues
2.0.0.AB1565	30 September 2020	<ul style="list-style-type: none"> Support AB1565A/AB1565 earbuds Fixed software issues
2.1.0.AB1565_AB1568	2 November 2020	<ul style="list-style-type: none"> Support AB1568 earbuds/headset Added new features Fixed software issues Added a migration guide to migrate applications from SDK v2.0.0.AB1565 to SDK v2.1.0.AB1565_AB1568
2.2.0.AB1565_AB1568	30 November 2020	<ul style="list-style-type: none"> Support for 1565M and 1565AM Added new features Fixed software issues
2.2.1.AB1565_AB1568	16 December 2020	<ul style="list-style-type: none"> Fixed software issues Fixed software features typo in the section for SDK Version 2.2.0.AB1565_AB1568.
2.3.0.AB1565_AB1568	5 February 2021	<ul style="list-style-type: none"> Added new features Fixed software issues Added a migration guide to migrate applications from SDK v2.2.1.AB1565_AB1568 to SDK v2.3.0.AB1565_AB1568
2.3.1.AB1565_AB1568	6 April 2021	<ul style="list-style-type: none"> Fixed software issues

Revision	Date	Description
2.4.0.ULL_TWS	29 April 2021	<ul style="list-style-type: none"> Added new features
2.5.0.AB1565_AB1568	31 May 2021	<ul style="list-style-type: none"> Added new features Fixed software issues
2.5.1.AB1565_AB1568	9 June 2021	<ul style="list-style-type: none"> Fixed software issues
2.6.0.ULL_TWS_Headset	30 June 2021	<ul style="list-style-type: none"> Added new features Fixed software issues
2.6.1.ULL_TWS_Headset	9 July 2021	<ul style="list-style-type: none"> Fixed software issues
2.7.0.ULL_TWS_Headset	2 August 2021	<ul style="list-style-type: none"> Added new features Fixed software issues Added a migration guide to migrate applications from SDK v2.6.1.ULL_TWS_Headset to SDK v2.7.0.ULL_TWS_Headset
2.7.1.ULL_TWS_Headset	30 August 2021	<ul style="list-style-type: none"> Fixed software issues
2.8.0.AB1565_AB1568	29 October 2021	<ul style="list-style-type: none"> Added new features Fixed software issues
2.9.0.ULL_TWS_Headset	26 November 2021	<ul style="list-style-type: none"> Added new features Fixed software issues
2.10.0.AB1565_AB1568	26 January 2022	<ul style="list-style-type: none"> Added new features Fixed software issues
2.10.1.AB1565_AB1568	28 January 2022	<ul style="list-style-type: none"> Fixed software issues
2.11.0.AB1565_AB1568	16 March 2022	<ul style="list-style-type: none"> Added new features Fixed software issues
3.0.0.AB1585_AB1588	29 April 2022	<ul style="list-style-type: none"> Added new features Added section 1.3 Flavors Mapping Table
3.1.0.AB1565_AB1568 3.1.0.AB1585_AB1588	1 June 2022	<ul style="list-style-type: none"> Added new features Fixed software issues Added a migration guide to migrate applications from SDK v3.0.0.AB1585_AB1588 to SDK v3.1.0.AB1585_AB1588
3.1.1.AB1565_AB1568	6 June 2022	<ul style="list-style-type: none"> Fixed software issues
3.2.0.AB1565_AB1568 3.2.0.AB1585_AB1588	30 June 2022	<ul style="list-style-type: none"> Added new features Fixed software issues Added a migration guide to migrate applications from SDK v3.1.0.AB1585_AB1588 to SDK v3.2.0.AB1585_AB1588 Added a migration guide to migrate applications from SDK v3.1.1.AB1565_AB1568 to SDK v3.2.0.AB1565_AB1568
3.3.0.AB1565_AB1568 3.3.0.AB1585_AB1588	31 August 2022	<ul style="list-style-type: none"> Added new features Fixed software issues

Revision	Date	Description
		<ul style="list-style-type: none"> Added a migration guide to migrate applications from SDK v3.2.0.AB1585_AB1588 to SDK v3.3.0.AB1585_AB1588 Added a migration guide to migrate applications from SDK v3.2.0.AB1565_AB1568 to SDK v3.3.0.AB1565_AB1568 [Errata] SDK Version 3.1.0.AB1565_AB1568 section 32.1 main changes – SDK. <ul style="list-style-type: none"> Applied 1585 SDK v3 changes to the AB1565_AB1568 package.
3.4.0.AB1565_AB1568 3.4.0.AB1585_AB1588	2 November 2022	<ul style="list-style-type: none"> Added new features Fixed software issues Added a migration guide to migrate applications from SDK v3.3.0.AB1585_AB1588 to SDK v3.4.0.AB1585_AB1588 Added a migration guide to migrate applications from SDK v3.3.0.AB1565_AB1568 to SDK v3.4.0.AB1565_AB1568
3.4.1.AB1565_AB1568 3.4.1.AB1585_AB1588	25 November 2022	<ul style="list-style-type: none"> Fixed software issues
3.5.0.AB1565_AB1568 3.5.0.AB1585_AB1588	30 December 2022	<ul style="list-style-type: none"> Added new features Fixed software issues Added a migration guide to migrate applications from SDK v3.4.1.AB1585_AB1588 to SDK v3.5.0.AB1585_AB1588 Added a migration guide to migrate applications from SDK v3.4.1.AB1565_AB1568 to SDK v3.5.0.AB1565_AB1568
3.5.1.AB1565_AB1568 3.5.1.AB1585_AB1588	15 February 2023	<ul style="list-style-type: none"> Fixed software issues
3.6.0.AB1565_AB1568 3.6.0.AB1585_AB1588	31 March 2023	<ul style="list-style-type: none"> Added new features Fixed software issues [Errata] SDK Version 3.5.0.AB1585_AB1588 section SDK Version 3.5.0.AB1585_AB1588 <ul style="list-style-type: none"> 7.1 main changes – SDK. <ul style="list-style-type: none"> Remove description of wireless mic support on 1585 Added a migration guide to migrate applications from SDK v3.5.1.AB1585_AB1588 to SDK v3.6.0.AB1585_AB1588 Added a migration guide to migrate applications from SDK v3.5.1.AB1565_AB1568 to SDK v3.6.0.AB1565_AB1568
3.6.1.AB1585_AB1588	28 April 2023	<ul style="list-style-type: none"> Fixed software issues
3.6.2.AB1585_AB1588	15 May 2023	<ul style="list-style-type: none"> Fixed software issues
3.7.0.AB1565_AB1568	31 May 2023	<ul style="list-style-type: none"> Added new features

Revision	Date	Description
3.7.0.AB1585_AB1588 3.7.0.AB1577S_AB1571D_AB1571		<ul style="list-style-type: none"> Fixed software issues Added a migration guide to migrate applications from SDK v3.6.0.AB1585_AB1588 to SDK v3.7.0.AB1585_AB1588 Added a migration guide to migrate applications from SDK v3.6.0.AB1565_AB1568 to SDK v3.7.0.AB1565_AB1568 Added new project Speaker reference design
3.8.0.AB156x 3.8.0.AB158x 3.8.0.AB157x	31 July 2023	<ul style="list-style-type: none"> Added new features Fixed software issues Added a migration guide to migrate applications from SDK v3.7.0.AB1577S_AB1571D_AB1571 to SDK v3.8.0.AB157x Added a migration guide to migrate applications from SDK v3.7.0.AB1585_AB1588 to SDK v3.8.0.AB158x Added a migration guide to migrate applications from SDK v3.7.0.AB1565_AB1568 to SDK v3.8.0.AB156x Added a migration guide to migrate memory layout from SDK v3.7.0.AB1571D to SDK v3.8.0.AB1571D Added a migration guide to configure the cache size from 16KB to 32KB.
3.9.0.AB156x 3.9.0.AB158x 3.9.0.AB157x	28 September 2023	<ul style="list-style-type: none"> Added new features Fixed software issues
3.10.0.AB156x 3.10.0.AB158x 3.10.0.AB157x	28 December 2023	<ul style="list-style-type: none"> Added new features Fixed software issues Added a migration guide to migrate applications from SDK v3.9.0.AB157x to SDK v3.10.0.AB157x Added a migration guide to migrate applications from SDK v3.9.0.AB158x to SDK v3.10.0.AB158x Added a migration guide to migrate applications from SDK v3.9.0.AB156x to SDK v3.10.0.AB156x

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1. Introduction

The Airoha IoT Software Development Kit (SDK) for BT Audio provides a comprehensive software solution. The SDK supports hardware abstraction layers (HAL), peripheral drivers, FreeRTOS, and other features.

1.1. Architecture layout of the SDK

The three-layer architecture layout of the SDK for AB1565/AB1568/AB158x/AB157x EVK includes Applications, Middleware, and BSP as shown in Figure 1, Figure 2 and Figure 3.

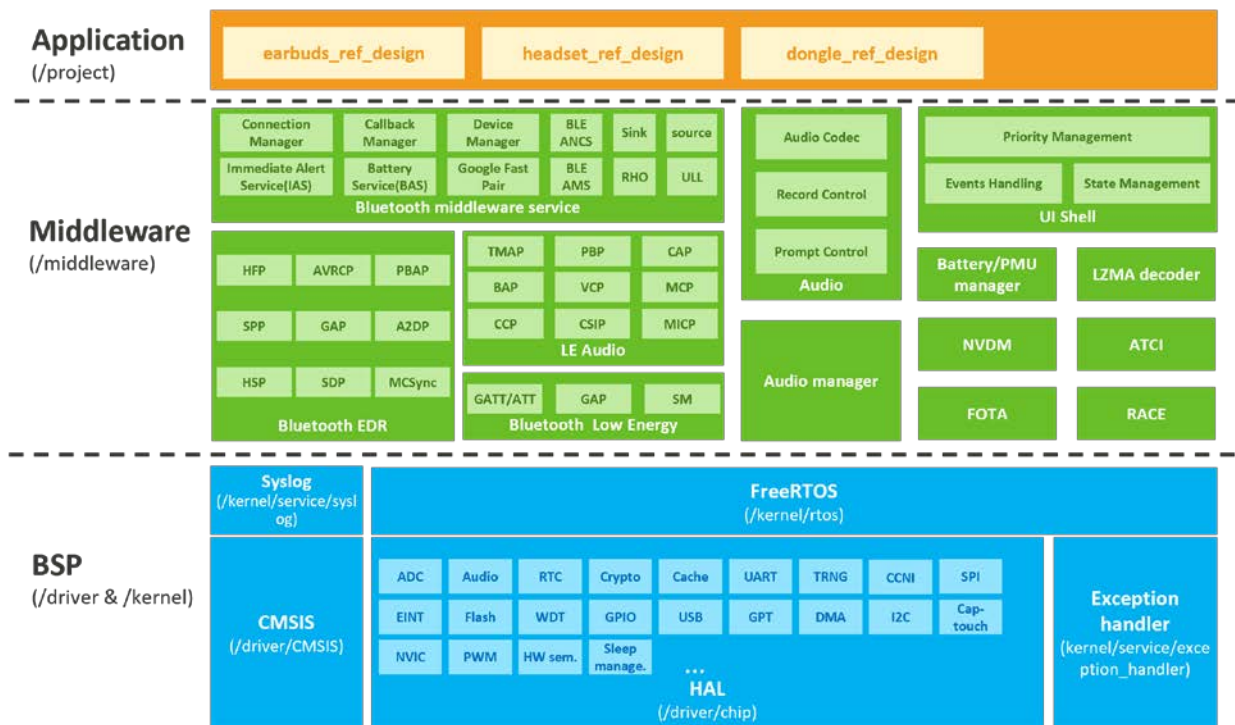


Figure 1. SDK Architecture layout for AB157x EVK

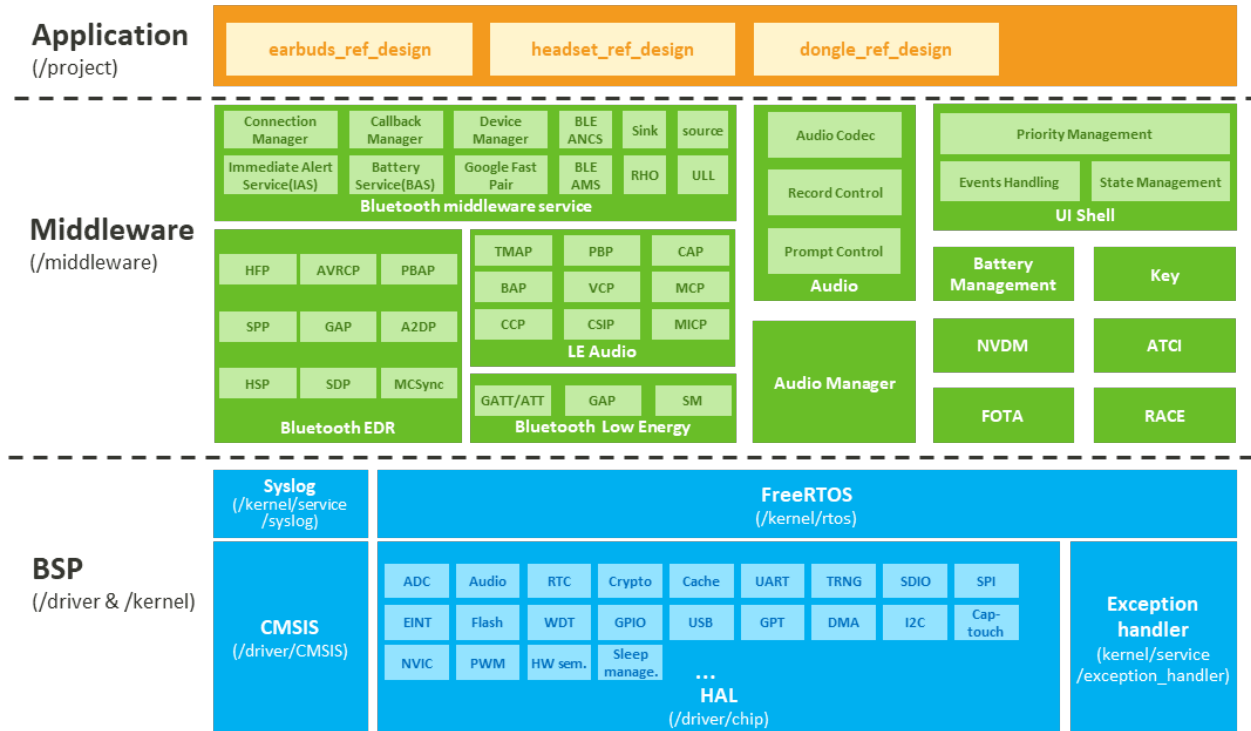


Figure 2. SDK Architecture layout for AB158x EVK

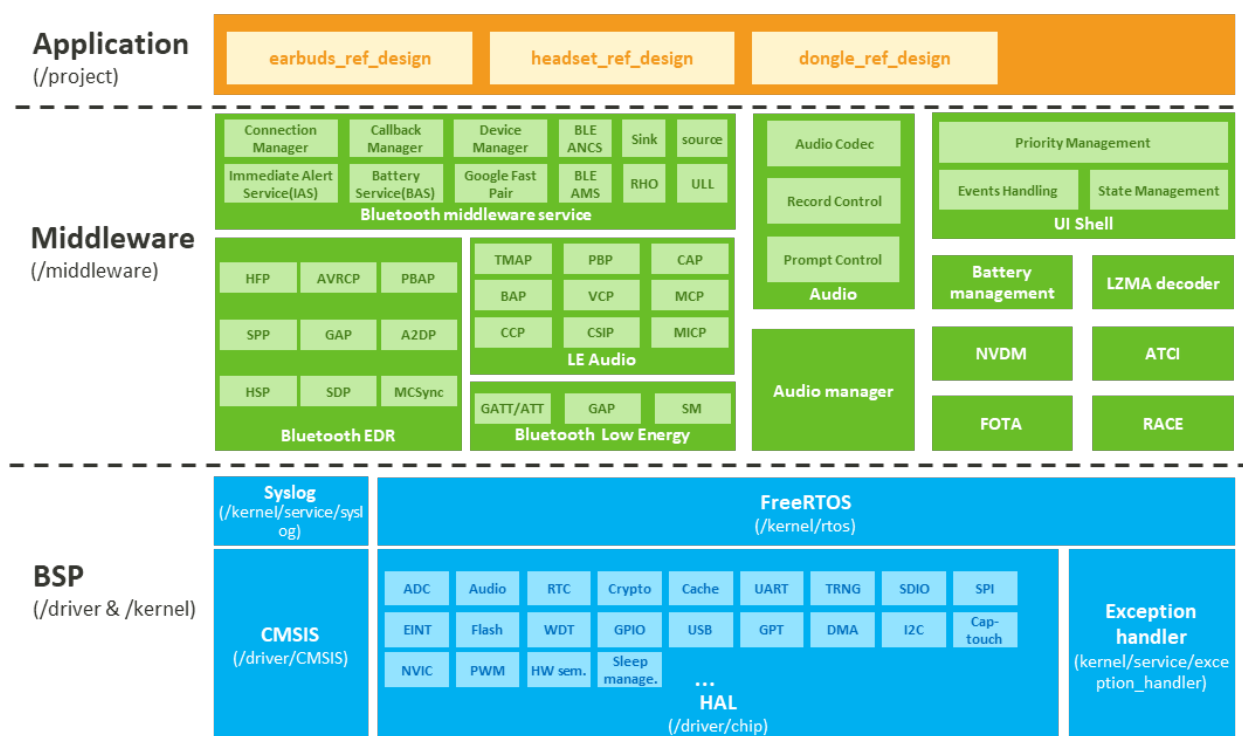


Figure 3. Architecture layout of the SDK for AB1565/AB1568 EVK

The top layer includes the application projects running on the SDK. They are based on the Middleware, OS, and HAL layers. These layers provide rich features for application development. For example, the Middleware layer provides the Bluetooth Low Energy Stack, firmware-over-the-air (FOTA), and ATCI. The FreeRTOS layer provides the underlying real-time operating system.

1.2. Knowledge base

The SDK includes documentation to show developers each module and provide an explanation of the features in a convenient and developer-oriented approach.

The following documentation is available with the SDK.

- *Airoha IoT SDK for BT Audio Get Started Guide* – This document explains the SDK features and shows the procedure for setting up the development environment and its usage.
- *Airoha IoT SDK for BT Audio Power Mode Developer's Guide* – This document provides information about the MCU system's power mode configuration and power consumption measurement focused on the power modes provided by the Airoha IoT SDK.
- *Airoha IoT SDK for BT Audio Build Environment Guide* – This document provides information about how to create and build a project, and how to create a module with the SDK in the BT Audio build environment.
- *Airoha IoT SDK for BT Audio EVK Debug Application Note* – This document is a guide for debugging MCU and DSP with JTAG. It covers setting up the JTAG debug environment, modifying code, and troubleshooting. It also includes software improvements for JTAG debugging and instructions for installing necessary supporting software.
- *Airoha IoT SDK for BT Audio <project> User Guide* – This document aims to assist users in comprehending and effectively utilizing the functionality of the man-machine interface (MMI) layer in the example project.

- *Airoha IoT SDK for BT Audio BT Source Dongle User Guide* – This document introduces the platform architecture and EVK setting of the BT classic dongle, as well as the basic operations on the dongle.
- *Airoha IoT SDK for BT Audio LE Audio Dongle User Guide* – This document introduces the platform architecture and EVK Settings of the LE audio dongle, as well as the basic operations of unicast and broadcast on the dongle.
- *Airoha IoT SDK LE Audio Developers Guide* – This document introduces the Bluetooth Low Energy Audio (LE Audio) that is supported by the Airoha IoT SDK and helps developers to understand the design and code structure of Airoha IoT SDK LE Audio. It also provides details about the methods to do customizations.
- *Airoha IoT SDK for BT Audio FOTA Application Note* – This document provides information on the FOTA application process, generating the FOTA package, and user guides for Android and iOS FOTA applications. It also includes instructions for checking the success of the FOTA process and exporting the application log for troubleshooting purposes.
- *Airoha IoT SDK for BT Audio Mass Production RACE Application Note* – This document provides information on the RACE command format, UART flow control, USB data format, ANC RACE payload ID, and indexes of all types of microphones. It also includes calibration flow charts, examples of RACE commands, and Bluetooth address on smart devices.
- *Airoha IoT SDK DSP Get Started Guide* – This document provides the information that is necessary for using the digital signal processor (DSP) of the EVK, including details about the installation environment, downloading code, and building techniques.
- *Airoha IoT SDK DSP Audio Algorithm Developers Guide* – This guide covers the audio software architecture, supported modules/components, and algorithm integration into Airoha IoT SDK. It also includes information on the SW developer flow for algorithm porting, available algorithms and basic functions in DSP SDK, and frequently asked questions.
- *Airoha IoT SDK Open Source Software Guide* – This document explains the open source modules and the features used in the SDK.
- *Airoha IoT SDK Memory Layout Developer's Guide* – This document provides details about the memory layout of the SDK, and how to adjust the memory layout for custom applications.
- *Airoha IoT SDK Firmware Update Developer's Guide* – This document shows how FOTA operates and how you can adjust the memory usage of FOTA.
- *Airoha IoT SDK Bluetooth Developers Guide* – This document guides you through the supported Bluetooth library and its usage with reference examples.
- *Airoha IoT SDK MCSync Developers Guide* – This document guides you through the supported MCSync library and its usage with reference examples.
- *Airoha IoT SDK Application Developers Guide* – This document provides information about how application layer modules work, and how to customize the keys, LEDs, and voice prompts.
- *Airoha IoT SDK UI Framework Developers Guide* – This guide provides information on how to use the UI shell and its workflow.
- *<chip> API Reference Manual or <chip> DSP API Reference Manual* – This document provides detailed descriptions of the APIs in the SDK.
- *<chip> 3rd-party Software Component Guide* – This guide is a reference for the third-party components bundled in the SDK, including open-source software (OSS) and business software (BS). It provides descriptions of each module, license information, software versions, and links to official websites.

- *Airoha IoT SDK Project Users Guide* – This guide provides guidance on the folder and file structure of available example projects, hardware and software environment, building the project, and troubleshooting tips. It also includes contact information.
- *Airoha RACE Command Specification* – The document provides information on the format of RACE commands, including the type, bytes, and value, along with examples of their usage and important notes.

Table 1-2 shows the documents related to a specific chipset that are under <sdk_root>/mcu/doc and <sdk_root>/dsp/doc.

Table 1-1. Documentation for Chipsets **Table 1-2. Documentation for Chipsets**

Document file name	Airoha IoT SDK for BT Audio
Airoha_IoT_SDK_for_BT_Audio_Release_Notes.pdf	√
Airoha_IoT_SDK_for_BT_Audio_Get_Started_Guide.pdf	√
Airoha_IoT_SDK_for_BT_Audio_Power_Mode_Developers_Guide.pdf	√
Airoha_IoT_SDK_for_BT_Audio_Build_Environment_Guide.pdf	√
Airoha_IoT_SDK_for_BT_Audio_EVK_Debug_Application_Note.pdf	√
Airoha_IoT_SDK_for_BT_Audio_<project>_User_Guide.pdf	√
Airoha_IoT_SDK_for_BT_Audio_BT_Source_Dongle_User_Guide.pdf	√
Airoha_IoT_SDK_for_BT_Audio_LE_Audio_Dongle_User_Guide.pdf	√
Airoha_IoT_SDK_for_BT_Audio_FOTA_Application_Note.pdf	√
Airoha_IoT_SDK_for_BT_Audio_Mass_Production_RACE_Application_Note.pdf	√
Airoha_IoT_SDK_DSP_Get_Started_Guide.pdf	√
Airoha_IoT_SDK_DSP_Audio_Algorithm_Developers_Guide.pdf	√ (Only in AB158x)
Airoha_IoT_SDK_Open_Source_Software_Guide.pdf	√
Airoha_IoT_SDK_Memory_Layout_Developers_Guide.pdf	√
Airoha_IoT_SDK_Firmware_Update_Developers_Guide.pdf	√
Airoha_IoT_SDK_Bluetooth_Developers_Guide.pdf	√
Airoha_IoT_SDK_MCSync_Developers_Guide.pdf	√
Airoha_IoT_SDK_LE_Audio_Developers_Guide.pdf	√
Airoha_IoT_SDK_Application_Developers_Guide.pdf	√
Airoha_IoT_SDK_UI_Framework_Developers_Guide.pdf	√
<chip>_API_Reference_Manual.html	√
<chip>_DSP_API_Reference_Manual.html	
<chip>_3rd-party_Software_Component_Guide.html	√
Airoha_IoT_SDK_Project_Users_Guide.html	√
Airoha_RACE_Command_Specification.html	√



Please note that if there are any documents provided for the addon package, they will also be placed in the <sdk_root>/mcu/doc or <sdk_root>/dsp/doc folder.

1.3. Flavors Mapping Table

We have a variety of flavors with different functions. This section shows a mapping table with different chipsets and flavors of build command, feature makefile, and the required add-on package.

The subsequent table shows the feature configuration file mapped on the MCU and DSP sides. Refer to the `feature_*.mk` file under the project folder for more information about the usage of feature option. You can modify the `feature_*.mk` file to turn a feature on or off or set a specific value.

There are also several add-on packages that are not released in the basic SDK package. Contact Airoha Customer Platform Management (CPM) if you require a specific add-on package.

Table 1-3. Flavors of AB1577AM Headset

Flavor	Description	Build Command	Feature Makefile		Required Add-on
			MCU	DSP	
Default	Basic function	ab1577am_evk headset_ref_design	feature_77am_evk	feature_77_headset	NA
ULL2	Gaming audio; Provides ultra low latency for UL/DL	ab1577am_evk headset_ref_design_ull2	feature_77am_evk_ull2	feature_77_ull2_headset	<ul style="list-style-type: none"> gaming_mode
ULL3	Gaming audio; Provides ultra low delay 10ms DL latency	ab1577am_evk headset_ref_design_ull3	feature_77am_evk_ull3	feature_77_ull3_headset	<ul style="list-style-type: none"> gaming_mode lc3plus fastpair
Dual Chip	Dual chip mixing mode master project	ab1577am_dual_evk headset_master	feature_77am_dual_evk_ master	feature_77_headset_dual_chip_mas ter	<ul style="list-style-type: none"> gaming_mode lc3plus
Dual Chip ULL3	ULL3 support with dual chip mixing master	ab1577am_dual_evk headset_master_ull3	feature_77am_dual_evk_ master_ull3	feature_77_headset_dual_chip_mas ter_ull3	<ul style="list-style-type: none"> gaming_mode lc3plus

Flavor	Description	Build Command	Feature Makefile		Required Add-on
			MCU	DSP	
Full	Full feature set for Airoha internal tests only	ab1577am_evk headset_ref_design_full	feature_77am_evk_full	feature_77_headset_full	<ul style="list-style-type: none"> ama gsound spotify_tap fastpair

Table 1-4. Flavors of AB1571 Headset

Flavor	Description	Build Command	Feature Makefile		Required Add-on
			MCU	DSP	
Default	Basic function	ab1571_evk headset_ref_design	feature_71_evk	feature_71_headset	NA
LE audio	LE audio	ab1571_evk headset_ref_design_leaudio	feature_71_evk_leaudio	feature_71_headset_leaudio	NA
Dual Chip	Dual chip mixing mode slave project	ab1571_dual_evk headset_slave	feature_71_dual_evk_slave	feature_71_headset_dual_chip_slave	NA

Table 1-5: Flavors of AB1571AM Headset

Flavor	Description	Build Command	Feature Makefile		Required Add-on
			MCU	DSP	
Default	Basic function	ab1571am_evk headset_ref_design	feature_71am_evk	feature_71am_headset	NA
ULL2	Gaming audio; Provides ultra low latency of UL/DL	ab1571am_evk headset_ref_design_ull2_full	feature_71am_evk_ull2_full	feature_71am_ull2_headset_full	<ul style="list-style-type: none"> gaming_mode fastpair

Table 1-6. Flavors of AB1577S Earbuds

Flavor	Description	Build Command	Feature Makefile		Required Add-on
			MCU	DSP	
Default	Basic function	ab1577s_evk earbuds_ref_design	feature_77s_evk	feature_77_earbuds	NA
ULL2	Gaming audio; Provides ultra low latency for UL/DL	ab1577s_evk earbuds_ref_design_ull2	feature_77s_evk_ull2	feature_77_ull2_earbuds	<ul style="list-style-type: none"> gaming_mode
Full	Full feature set for Airoha internal tests only	ab1577s_evk earbuds_ref_design_full	feature_77s_evk_full	feature_77_earbuds_full	<ul style="list-style-type: none"> ama gsound spotify_tap fastpair

Table 1-7. Flavors of AB1571 Earbuds

Flavor	Description	Build Command	Feature Makefile		Required Add-on
			MCU	DSP	
Default	Basic function	ab1571_evk earbuds_ref_design	feature_71_evk	feature_71_earbuds	NA
ULL2	ULL2 with opus codec support	ab1571_evk earbuds_ref_design_ull2_opus	feature_71_evk_ull2_opus	feature_71_earbuds_ull2_opus	<ul style="list-style-type: none"> gaming_mode

Table 1-8: Flavors of AB1571AM Earbuds

Flavor	Description	Build Command	Feature Makefile		Required Add-on
			MCU	DSP	
Default	Basic function	ab1571am_evk earbuds_ref_design	feature_71am_evk	feature_71am_earbuds	NA
ULL2	Gaming audio; Provides ultra low latency of UL/DL	ab1571am_evk earbuds_ref_design_ull2_full	Feature_71am_evk_ull2_full	Feature_71am_ull2_earbuds_full	<ul style="list-style-type: none"> gaming_mode fastpair

Table 1-9. Flavors of AB1751D Dongle

Flavor	Description	Build Command	Feature Makefile		Required Add-on
			MCU	DSP	
Enterprise	LE audio	ab1571d_evb leaudio_dongle	feature_71d_evb_leaudio	feature_71_leaudio_dongle	<ul style="list-style-type: none"> ms_teams
ULL2	Gaming audio; Provides ultra low latency for UL/DL	ab1571d_evk dongle_ref_design_ull2_lea udio	feature_71d_evk_ull2_leau dio	feature_71_ull2_dongle	<ul style="list-style-type: none"> gaming_m ode lc3plus ms_teams
ULL3	Gaming audio; Provides ultra low delay 10ms DL latency	ab1571d_evk dongle_ref_design_ull3	feature_71d_evk_ull3	feature_71_ull3_dongle	<ul style="list-style-type: none"> gaming_m ode lc3plus ms_teams
ULL3 AFE dongle	ULL3 dongle with I2S/LINE-IN	ab1571d_evk dongle_ref_design_ull3_afe	feature_71d_evk_ull3_afe	feature_71_ull3_afe_dongle	<ul style="list-style-type: none"> gaming_m ode lc3plus ms_teams
Enterprise with BT Source	LE audio + BT Source Dongle	ab1571d_evk dongle_ref_design_bt	feature_71d_evk_bt	feature_71_evk_leaudio_bt_dongle	<ul style="list-style-type: none"> ms_teams

Table 1-10. Flavors of AB1585H Earbuds

Flavor	Description	Build Command	Feature make file		Required addon
			MCU	DSP	
Hearing Aids	Hearing Aids (HA)	ab1585h_evk earbuds_ref_design_hearing_aid	feature_85h_evk_hearing_aid	feature_85h_earbuds_hearing_aid	<ul style="list-style-type: none"> ha

Table 1-11. Flavors of AB1585 Headset

Flavor	Description	Build Command	Feature Makefile		Required Add-on
			MCU	DSP	
Default	Basic function	ab1585_evk headset_ref_design	feature_85_evk	feature_85_headset	NA
Enterprise	Integrate PC-side dongle for better voice performance with enterprise applications such as conference and UC.	ab1585_evk headset_ref_design_enterprise	feature_85_evk_ent	feature_85_headset_leaudio	<ul style="list-style-type: none"> ms_teams
LE audio	LE audio	ab1585_evk headset_ref_design_leaudio	feature_85_evk_leaudio	feature_85_headset_leaudio	NA
ULL2	Gaming audio; Provides ultra low latency for UL/DL	ab1585_evk headset_ref_design_ull2	feature_85_evk_ull2	feature_85_headset_ull2	<ul style="list-style-type: none"> gaming_mode lc3plus
DCHS	Dual Channel HeadSet	ab1585_evk headset_ref_design_dchs_master ab1585_evk headset_ref_design_dchs_slave	feature_85_dchs_master feature_85_dchs_slave	feature_85_evk_dchs_master feature_85_evk_dchs_slave	<ul style="list-style-type: none"> fastpair gaming_mode iap2 ms_teams lc3plus
Full	Full feature set for Airoha internal tests only	Full	feature_85_evk_full	feature_85_headset_full	NA

Table 1-12. Flavors of AB1585 Earbuds

Flavor	Description	Build Command	Feature make file		Required addon
			MCU	DSP	
Default	Basic function	ab1585_evk earbuds_ref_design	feature_85_evk	feature_85_earbuds	NA
Enterprise	Integrates PC-side dongle for better voice performance	ab1585_evk earbuds_ref_design_enterprise	feature_85_evk_ent	feature_85_earbuds_leaudio	<ul style="list-style-type: none"> ms_teams

Flavor	Description	Build Command	Feature make file		Required addon
			MCU	DSP	
	with enterprise applications such as conference and UC				
LE audio	LE audio	ab1585_evk earbuds_ref_design_leaudio	feature_85_evk_leaudio	feature_85_earbuds_leaudio	NA
ULL2	Gaming audio; Provides ultra low latency for UL/DL	ab1585_evk_earbuds_ref_design_ull2	feature_85_evk_ull2	feature_85_earbuds_ull2	<ul style="list-style-type: none"> gaming_mode lc3plus
Full	Full feature set for Airoha internal test only	full	feature_85_evk_full	feature_85_earbuds_full	NA
PSAP	Personal sound amplification product (PSAP)	ab1585_evk_earbuds_ref_design_psap	feature_85_evk_psap	feature_85_earbuds_psap	<ul style="list-style-type: none"> psap

Table 1-13. Flavors of AB1585 Dongle

Flavor	Description	Build Command	Feature make file		Required addon
			MCU	DSP	
Enterprise	Dongle/LE audio	ab1585_evk dongle_ref_design_leaudio	feature_85_evk_leaudio	feature_85_dongle	ms_teams
ULL2	Gaming audio; Provides ultra low latency for UL/DL	ab1585_evk dongle_ref_design_ull2	feature_85_evk_ull2	feature_8x_ull2_dongle	<ul style="list-style-type: none"> gaming_mode lc3plus

Table 1-14. Flavors of AB1588 Earbuds

Flavor	Description	Build Command	Feature make file		Required addon
			MCU	DSP	
Default	Basic function	ab1588_evk earbuds_ref_design	feature_88_evk	feature_88_earbuds	NA
Full	Full feature set for Airoha internal test only	full	feature_88_evk_full	feature_88_earbuds_full	NA

Table 1-15. Multiple Flavors of AB1565 Headset

Flavor	Description	Build Command	Feature make file		Required addon
			MCU	DSP	
Default	Basic functionality	ab1565_8m_evk headset_ref_design	feature_65_8m_evk	feature_65_8m_headset_evb	NA
LE audio	LE audio	ab1565_8m_evk headset_ref_design_leaudio	feature_65_8m_evk_leaudio	feature_65_8m_evb_leaudio	<ul style="list-style-type: none"> ai nr premium
Full	Full feature set for Airoha internal test only	ab1565_8m_evk headset_ref_design_full	feature_65_8m_evk_full	feature_65_8m_evb_headset_full	NA
Wireless mic	Wireless mic TX project with ULD codec	ab1565_evk wireless_mic_tx_uld	feature_65_evk_mic_tx_uld	feature_65_evb_mic_tx_uld	<ul style="list-style-type: none"> gaming_m ode
Wireless mic	Wireless mic TX project with LC3plus codec	ab1565_evk wireless_mic_tx	feature_65_evk_mic_tx	feature_65_evb_mic_tx	<ul style="list-style-type: none"> gaming lc3plus

Table 1-16. Multiple Flavors of AB1565 Earbuds

Flavor	Description	Build Command	Feature make file		Required addon
			MCU	DSP	
Default	Basic functionality	ab1565_8m_evk earbuds_ref_design	feature_65_8m_evk	feature_65_8m_earbuds_evb	NA
LE audio	LE audio	ab1565_8m_evk earbuds_ref_design_leaudio	feature_65_8m_evk_leaudio	feature_65_8m_evb_leaudio	<ul style="list-style-type: none"> ai nr premium
ULL2	Gaming audio; Provides ultra low latency for UL/DL	ab1565_8m_evk earbuds_ref_design_ull2	feature_65_8m_evk_ull2	feature_65_8m_evb_ull2_earbuds	<ul style="list-style-type: none"> gaming_mode
Full	Full feature set for Airoha internal test only	ab1565_8m_evk earbuds_ref_design_full	feature_65_8m_evk_full	feature_65_8m_evb_earbuds_full	NA

Table 1-17. Flavors of AB1565 Dongle

Flavor	Description	Build Command	Feature make file		Required addon
			MCU	DSP	
Enterprise	Dongle/LE audio	ab1565_evk leaudio_dongle	feature_65_evk_leaudio	feature_65_evb_leaudio_dongle	ms_teams
Wireless mic	Wireless mic RX project with LC3plus&ULD codec	ab1565_evk wireless_mic_rx	feature_65_evk_mic_rx	feature_65_evb_mic_rx	<ul style="list-style-type: none"> gaming_mode lc3plus

2. SDK Version 3.10.0.AB157x

2.1. Main Changes

- Software features:
 - Added LE Audio Gaming Audio Profile support (early release).
 - Added LE Audio support for Intel Evo certification.
 - Modified the max NVDM data item count from 400 to 600.
 - [add-on][dongle_ref_design] Added LE Audio support for LC3plus codec.
 - [add-on][headset_ref_design] AB1577AM + AB1571 dual-chip mixing mode project.
 - Added LE audio
 - LE call only supports WB.
 - [add-on][earbuds_ref_design] Added HW Vivid Passthru (PT) 2.1.
 - [add-on][headset_ref_design] Added support for Ultra Low Latency 3 (ULL3) with dual-chip mixing mode.
 - [add-on][dongle_ref_design] Added support for I2S/LIN-IN with ULL3.
 - [headset_ref_design] Added ULL2.0/ULL2.1 inactive mode feature to address the issue of audio dropping at the start of playback from PCs or smartphones. This update maintains the ULL2.0/ULL2.1 connection with a larger connection interval, ensuring immediate audio servicing once playback is initiated on these devices.
 - [earbuds ref design][headset ref design] Extended Enhanced Multi-Point (EMP) maximum link number from two to three.
 - This feature does not support Bluetooth Low Energy Audio (LEA) or Ultra Low Latency (ULL) link.
 - This feature does not support Hi-resolution codec (ex: LDAC).
 - Device CAN NOT accept the third extended synchronous connection-oriented (eSCO) link setup request if two eSCO links exist.
 - For the three links, one of the links will be disabled and then reconnected with DUT during Role Handover, resulting in the corresponding voice prompt to be heard.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Enabled Personal Sound Application Product (PSAP) pages in customer mode.
 - Updated the library for adaptive Equalization (adaptive EQ) / vivid Passthrough (vivid PT) noise floor calibration.
 - Added support for vivid PT 2.0 tuning / wireless mic gain limiter.
 - Added voice wind switch settings.
 - Added Relay Enable BLE, ULL 1M GC, ULL 2M GC.
 - Improved user experience in USB-HID connection.

- Updated the library used in vivid PT noise floor calibration.
 - Added downlink gain table.
- Labtest Tool
 - Enabled PSAP pages in customer mode.
 - Added ULL BTx, ULL BRx.
- Logging Tool
 - Improved exception UI.
- iOS applications and SDK
 - Fixed the bugs related to Hearing Aid (HA) and PSAP.
 - Fixed the bugs related to Active Noise Cancellation (ANC) and adaptive ANC.
 - Fixed the issue where SDK will repeatedly disconnect and connect device when OTA fails.
 - Added iOS 17 privacy manifest.
- Android SDK
 - Added support to discover nearby devices.
 - Added support for dongle Firmware Over-The-Air (FOTA).
 - Added support for getHearingTestModeSwitchOnOff and setHearingTestModeSwitchOnOff API.
 - Added the notification about wind detection and environment detection.
 - Added getMasterGain and setMasterGain method for PEQ.
 - Added support for Single FOTA if it is an HA project.
 - Improved the reconnection flow of LEA FOTA.
 - Added UNIX timestamp to offline log.
- Windows UT APP
 - Added dual chip DFU in console DFU tool.
 - Added 1577AM_BT_LEA_AFE_Dongle type.
 - Added HYBRID_PASSTHRU and VIVID_PASSTHRU_FILTER.

2.2. Migration

Migrate the following applications when upgrading the SDK from version 3.9.0.AB157x to version 3.10.0.AB157x.

2.2.1. Example project – earbuds, headset, speaker and dongle reference design

- 1) This step excludes the dongle reference design (dongle_ref_design).
Merge the NVDM_PORT_DAT_ITEM_COUNT macro change. The default value is in the following file:
mcu/project/<chip>/apps/bt_audio_common/inc/nvdm_config.h
 - How to migrate:
 - Replace the nvdm_config.h file with the one in SDK 3.10.0.
- 2) Merge the nvkey default value. The default value is in the following file:
mcu/project/<chip>/apps/<project>/config_bin/<board_type>/nvkey.xml

- How to migrate:
 - In general, you need to merge your local changes into the nvkey.xml of SDK 3.10.0.
 - Back up your locally changed items on SDK 3.9.0.
 - Copy the nvkey.xml of 3.10.0 to your folder and overwrite your local file.
 - Replace your locally changed items into the nvkey.xml via entire binary data overwriting, excluding the following:
the 0xE8FC (Name is NVID_DSP_ALG_HW_VIVID_PT_LDNR) in earbuds and headset reference design. Always use this data in SDK 3.10.0.

3. SDK Version 3.10.0.AB158x

3.1. Main Changes

- Software features:
 - Added LE Audio Gaming Audio Profile support (early release).
 - Modified the max NVDM data item count from 400 to 600.
 - [headset_ref_design] Added ULL2.0/ULL2.1 inactive mode feature to address the audio dropping issue during start of playback from PCs or smartphones. This update maintains the ULL2.0/ULL2.1 connection with a larger connection interval, ensuring immediate audio servicing once playback is initiated on these devices.
 - [add-on] [earbuds_ref_design] Vivid PT
 - Added Wind Noise Reduction (WNR) for Vivid PT.
 - [add-on] [earbuds_ref_design] PSAP (early release)
 - Added WNR support for PSAP.
 - Improved Dynamic Range Compression (DRC), Noise Reduction (NR), Beamforming (BF), WNR performance for PSAP.
 - [add-on] [earbuds_ref_design] Hearing Aid (HA) (early release)
 - Improved DRC, NR, BF, WNR performance for HA.
 - Improved ClassD LP mode at low output.
 - [earbuds ref design][headset ref design] Extended EMP maximum link number from two to three.
 - This feature does not support Bluetooth Low Energy Audio (LEA) or Ultra Low Latency (ULL) link.
 - This feature does not support Hi-resolution codec (ex: LDAC).
 - Device CAN NOT accept the third extended synchronous connection-oriented (eSCO) link setup request if two eSCO links exist.
 - For the three links, one of the links will be disabled and then reconnected with DUT during Role Handover, resulting in the corresponding voice prompt to be heard.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Added/modified HA and PSAP related settings.
 - Added support for Assist Equalization (AST EQ) tuning in Active noise Cancellation (ANC) and passthru mode.
 - Improved user experience in USB-HID connection.
 - Updated execution file for beamforming calibration.
 - Updated the library used in vivid PT noise floor calibration.
 - Added downlink gain table.
 - Logging tool
 - Added UI setting to config audio dump file split time.

- Improved exception UI.
- iOS applications and SDK
 - Fixed the bugs related to HA and PSAP.
 - Fixed the bugs related to ANC and adaptive ANC.
 - Fixed the issue where the SDK repeatedly disconnected and reconnected to device when OTA failed.
 - Added iOS 17 privacy manifest.
- Android SDK
 - Added support to discover nearby devices.
 - Added support for dongle Firmware Over-The-Air (FOTA).
 - Added getHearingTestModeSwitchOnOff and setHearingTestModeSwitchOnOff API.
 - Added notification about wind detection and environment detection.
 - Added getMasterGain and setMasterGain method for Parametric Equalization (PEQ).
 - Added support for Single FOTA if it is a HA project.
 - Improved the reconnection flow of LEA FOTA.
 - Added UNIX timestamp to offline log.
- Windows UT APP
 - Added dual chip Device Firmware Upgrade (DFU) in console DFU tool.
 - Added 1577AM_BT_LEA_AFE_Dongle type.
 - Added HYBRID_PASSTHRU and VIVID_PASSTHRU_FILTER.
- Note:
 - [add-on] [earbuds_ref_design] PSAP
 - The PSAP performance can vary based on different mechanical structures, such as internal and external components, as well as acoustic elements.
 - [add-on] [earbuds_ref_design] HA
 - The HA performance can vary based on different mechanical structures, such as internal and external components, as well as acoustic elements.

3.2. Known Issues

There are known issues with this version of the SDK.

- [add-on] [earbuds_ref_design] PSAP
 - If the downlink and PSAP simultaneously appear, the downlink frequency response may be slightly affected by the ANC.
- [add-on] [earbuds_ref_design] HA
 - If the downlink and HA simultaneously appear, the downlink frequency response may be slightly affected by the ANC.

3.3. Migration

Migrate the following applications when upgrading the SDK from version 3.9.0.AB158x to version 3.10.0.AB158x.

3.3.1. Example project – earbuds, headset, speaker and dongle reference design

- 1) This step excludes the dongle reference design (dongle_ref_design).
Merge the NVDM_PORT_DAT_ITEM_COUNT macro change. The default value is in the following file:
mcu/project/<chip>/apps/bt_audio_common/inc/nvdm_config.h
 - How to migrate:
 - Replace the nvdm_config.h file with the one in SDK 3.10.0.
- 2) Merge the nvkey default value. The default value is in the following file:
mcu/project/<chip>/apps/<project>/config_bin/<board_type>/nvkey.xml
 - How to migrate:
 - In general, you need to merge your local changes into the nvkey.xml of SDK 3.10.0.
 - Back up your locally changed items on SDK 3.9.0.
 - Copy the nvkey.xml of 3.10.0 to your folder and overwrite your local file.
 - Replace your locally changed items into the nvkey.xml via entire binary data overwriting, excluding the 0xE8FA (Name is NVID_DSP_ALG_VIVID_PT_LDNR) in the earbuds reference design. Ask for AE's help if you have changed the item in SDK 3.9.0.
- 3) Enable load PIC library to Sysram. Project which supports Bluetooth Low Energy Audio (LEA) will need to migrate.
 - How to migrate:
 - Replace following file with the one in SDK 3.10.0:
dsp\project\ab158x\apps\dsp0_headset_ref_design\src\preloader_pisplit_configure.c

4. SDK Version 3.10.0.AB156x

4.1. Main Changes

- Software features:
 - Added LE Audio Gaming Audio Profile support (early release).
 - [headset_ref_design] Added Ultra Low Latency 2.0 (ULL2.0)/ULL2.1 inactive mode feature to address the audio drop issue during start of playback from PCs or smartphones. This update maintains the ULL2.0/ULL2.1 connection with a larger connection interval, which ensures immediate audio servicing once playback is initiated on these devices.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Improved user experience in USB-HID connection.
 - Supported Assist Equalization (AST EQ) tuning for ANC mode and passthru mode.
 - Improved exception UI.
 - Added downlink gain table.
 - iOS applications and SDK
 - Fixed the bugs related to Hearing Aid (HA) and Personal Sound Application Product (PSAP).
 - Fixed the bugs related to Active noise Cancellation (ANC) and adaptive ANC.
 - Fixed the issue where the SDK repeatedly disconnected and reconnected to device when OTA failed.
 - Added iOS 17 privacy manifest.
 - Android SDK
 - Added support to discover nearby devices.
 - Added support for dongle Firmware Over-The-Air (FOTA) .
 - Added support for getHearingTestModeSwitchOnOff and setHearingTestModeSwitchOnOff API.
 - Added notification about wind detection and environment detection.
 - Added getMasterGain and setMasterGain method for Parametric Equalization (PEQ).
 - Added support for Single FOTA if it is a HA project.
 - Improved the reconnection flow of LE Audio FOTA.
 - Added UNIX timestamp to offline log.
 - Windows UT APP
 - Added dual chip Device Firmware Upgrade (DFU) in console DFU tool.
 - Added 1577AM_BT_LEA_AFE_Dongle type.
 - Added HYBRID_PASSTHRU and VIVID_PASSTHRU_FILTER.
- Note:

- As the SYSRAM usage is already near the upper limit, a build error may occur if the SYSRAM maximum usage is exceeded after the upgrade. If this problem occurs, try to reduce the heap size in project/ab156x/apps/bt_audio_common/inc/FreeRTOSConfig.h.

4.2. Migration

Migrate the following applications when upgrading the SDK from version 3.9.0.AB156x to version 3.10.0.AB156x:

4.2.1. Example project – earbuds, headset, speaker and dongle reference design

- 1) Merge the nvkey default value. The default value is in the following file:
mcu/project/<chip>/apps/<project>/config_bin/<board_type>/nvkey.xml
 - How to migrate:
 - In general, you need to merge your local changes into the nvkey.xml of SDK 3.10.0.
 - Back up your locally changed items on SDK 3.9.0.
 - Copy the nvkey.xml of 3.10.0 to your folder and overwrite your local file.
 - Replace your locally changed items into the nvkey.xml via entire binary data overwriting.

5. SDK Version 3.9.0.AB157x

5.1. Main Changes

- Software features:
 - Added 1571AM earbuds/headset project
 - Added AUX in-out scenario on AB1577AM + AB1571 dual-chip mixing mode project
 - Added ULL3(10ms DL)/ULL2.0 dongle project on AB1571D and headset project on AB1577AM
 - Added LHDC lossless dongle & headset/earbuds
 - Added ULL gaming 2.1 ABR Hi-Res Audio Dongle & Headset
 - Single chip
 - DL 96K/24bits 940Kbps, UL 32K/16bits
 - Support for Multiple link
 - Dual-chip mixing mode
 - DL 96K/24bits 940Kbps, UL 48K/24bits
 - Added hearing protection
 - Added BT classic EVO
 - Added Vivid PT for headset project
 - [dongle_ref_design] bt source dongle on 1571D in A2DP mode
 - Added support for an analog input source, such as aux in or mic in.
 - Added support for i2s slave input source and support for the dynamic sample rate changing from 16K to 192K.
 - Added support for i2s master input source and support for a static or pre-configured fixed sample rate from 16K to 192K.
 - Added support for mixing between analog input source and i2s input source.
 - [dongle_ref_design] LEA dongle on 1571D in BIS mode or CIS mode
 - Added support for an analog input source, such as aux in or mic in.
 - Added support for i2s slave input source and support for the dynamic sample rate changing from 16K to 192K.
 - Added support for i2s master input source and support for a static or pre-configured fixed sample rate from 16K to 192K.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - changed CHG setting limit
 - Added/modified audio related settings
 - Added Teams device SN
 - Added sample rate 96k and 192k for adaptive EQ

- Added multimedia DRC table for HA and PSAP
 - Added voice full-band tuning in engineer mode
- Logging tool
 - Fixed online log parsing fail
- iOS applications and SDK
 - Added multi device
 - Added wind detection
 - Support for full adaptive ANC mode notification from the device
- Android SDK
 - Added Single FOTA switch on UI
 - Support for FF mic ANC only
 - Handle the notification about adaptive ANC
 - Fixed the connection flow for LEA
- Windows UT APP
 - Support for dual-mode dongle paired list
 - Modified the headset EQ to line-in audio path
 - Fixed DFU commit timeout

5.2. Known Issues

There are known issues with this version of the SDK.

- There is sometimes no sound while connected to Audio Precision Instrument on a BT source dongle.
- There are IOT issues with some specific device is under LE mode on BT source dongle

6. SDK Version 3.9.0.AB158x

6.1. Main Changes

- Software features:
 - Added hearing protection
 - [add-on] [earbuds_ref_design] PSAP
 - Improved 2-Mic BF performance
 - [add-on] [earbuds_ref_design] HA
 - Improved 2-Mic BF performance
 - ULL2.0 light mode: Support for two types of audio quality
 - Normal mode: DL 96K/24bits
 - Low power mode: DL 48K/24bits

7. SDK Version 3.9.0.AB156x

7.1. Main Changes

- Software features:
 - [dongle_ref_design] bt source dongle in A2DP mode
 - Added support for an analog input source, such as aux in or mic in.
 - Added support for i2s slave input source and support for the dynamic sample rate changing from 16K to 192K.
 - Added support for i2s master input source, support static or pre-configured fixed sample rate from 16K to 192K.
 - Added support for mixing between the analog input source and i2s input source.
 - [dongle_ref_design] LEA dongle in BIS mode or CIS mode
 - Added support for an analog input source, such as aux in or mic in.
 - Added support for an i2s slave input source and support for a dynamic sample rate changing from 16K to 192K.
 - Added support for an i2s master input source and support for a static or pre-configured fixed sample rate from 16K to 192K.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Fixed a download failure caused by the DA bin
 - Changed the CHG setting limit
 - Support for hearing protection
 - Added an audio related setting
 - Added Teams device SN
 - Logging tool
 - Fixed an online log parsing fail
 - iOS applications and SDK
 - Added multi device
 - Added wind detection
 - Support for full adaptive ANC mode notification from device
 - Android SDK
 - Added Single FOTA switch on UI
 - Support for FF mic ANC only
 - Handled the notification about adaptive ANC
 - Fixed the connection flow for LEA
 - Windows UT APP

- Support for dual-mode dongle paired list
- Modified the headset EQ to line-in audio path
- Fixed the DFU commit timeout

8. SDK Version 3.8.0.AB157x

8.1. Main Changes

Revised the chip name in the SDK version numbers from AB1577S_AB1571D_AB1571 to AB157x. Note that the "x" in the version number represents a variable digit.

- Software features:
 - MCU includes DSP feature.mk
 - Background: It is better to use one configuration on both the MCU and DSP side because some of the feature options should be enabled/disabled at the same time on the MCU and DSP side to make sure the feature is working correctly.
 - Solution: Remove the MCU and DSP shared feature option from the MCU side. Include the DSP feature.mk in the MCU project feature.mk.
 - Note: If the shared feature option is added in the MCU project feature.mk, it prompts the following build error: “\$(VAR) is a MCU-DSP-Shared feature option but defined in MCU. Remove it from MCU feature.mk and define it in the corresponding DSP feature.mk.”
 - Added AB1577M headset project
 - Added ULL gaming 2.1 ABR Hi-Res Audio Dongle & Headset
 - Single chip
 - DL 96K/24bits 940Kbps
 - Dual-chip mixing mode
 - Multiple link early release
 - Added AB1577AM + AB1571 project
 - Added support for BT Classic/ULL 2.0 & 2.1/USB in-out scenario
 - Added HW vivid PT for AB1577S
 - [dongle_ref_design] bt source dongle
 - Added support for SBC codec adaptive bitrate control
 - Added support for LHDC-V codec and adaptive bitrate control
 - Added support for silence detection
 - Added support for mute/unmute on the dongle side
 - Latency optimization for music and calls
 - [dongle_ref_design] Moved the common code in dongle_ref_design into the bt_audio_common folder.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Added support for HW vivid PT FB/FBC tuning
 - Added support for HW vivid PT noise floor calibration
 - Added HW vivid PT wind detection/hybrid PT limiter settings

- Added charger case detection mode
 - Added multiple mic and NR instruction message on UI
 - 1Wire Logging tool
 - Added 9600, 19200, 38400, and 57600 baud rate settings
 - iOS applications and SDK
 - Added HW vivid PT
 - Added support for AB157x dual chip
 - Added support for ANC or passthrough gain with sync mode
 - Android SDK
 - Added HW vivid PT
 - Added support for AB157x dual chip
 - Added support for ANC or passthrough gain with sync mode
 - Windows UT APP
 - Added support for AB157x dual chip
 - Fixed CPU high usage
- Note:
 - Power consumption optimization:
 - Adjusted CM4 cache size from 16KB to 32KB.
 - Adjusted AUD_INTBUS frequency from 99.75MHz to 26MHz in DVFS LV level.
 - Adjusted PMIC voltage to favor power optimization.
 - The corresponding code must be modified. Refer to the migration instructions for when The cache size must change from 16KB to 32KB because of the lower power optimization. and when The cache size must change from 16KB to 32KB because of the lower power optimization. for more information.
 - Optimizing the configuration of HAL features:
 - The HAL features are now controlled by the driver instead of the projects.
 - The file path for hal_feature_config.h has been changed from `mcu/project/ab157x/apps/<project>/inc/boards/<chip>/hal_feature_config.h` to `mcu/driver/chip/ab157x/inc/hal_feature_config.h`.
 - Added DVFS board option with minimum level and maximum levels; the original only supported DVFS minimum level definition in hal_feature_config.h
 - Removed the DVFS minimum level definitions from hal_feature_config.h
 - Removed definitions, i.e. MTK_BOOT_SYS_CLK_XXX
 - Added two options in `mcu/project/ab157x/apps/<project>/GCC/feature_<BOARD_TYPE>.mk`
 - DVFS minimum level option: `AIR_DVFS_MIN_LEVEL = DVFS_LV`
 - DVFS maximum level option: `AIR_DVFS_MAX_LEVEL = DVFS_HV`
 - These two options must not usually be changed.

- Added ANC/Passthrough TWS sync mechanism implemented by the application layer.
 - Option: AIR_APP_ANC_SYNC_ENABLE, default defined in SDK.
 - When this option enabled, ANC/Passthrough TWS behavior would control by application layer.
 - In race commands “ANC ON” and “ANC OFF” mentioned in document AB156x_AB157x_AB158x_Series_Mass_Production_RACE_Application_Note, the “sync mode” value need to set 0x02 for sync by application layer.

8.2. Known Issues

There are known issues with this version of the SDK.

- [BT source dongle] No sound in DL path while the dongle connects to the AP with some specific headsets in BT source dongle project (no such issue while dongle connect to PC/NB).
- [add-on] [BT source dongle] [Teams] Teams call control fail probably after dongle plug-in/out stress test with some specific PC/NB.
- [lossless dongle] There is unexpected BT disconnection problem probably under BT idle mode in lossless dongle.

8.3. Migration

Migrate the following applications when upgrading the SDK from version 3.7.0. AB1577S_AB1571D_AB1571 to version 3.8.0.AB157x:

8.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) The debugging mechanism has been changed due to the restructuring of the Bluetooth host stack.
 - How to migrate:
 - Add a dummy “bt_debug.h” to the folder:
mcu/project/ab157x/apps/bt_audio_common/inc/bt_app_utility/
- 2) Improved battery resolution. Changed the length and value of NVkey 0x2000.
 - How to migrate:
 - Copy the NVKey value of KeyID=“0x2000” from the latest SDK and replace the existing NVKey value of KeyID=“0x2000” in mcu/project/ab157x/apps/<project>/config_bin/<board_type>/nvkey.xml
- 3) The cache size must change from 16KB to 32KB because of the lower power optimization.
 - How to migrate:
 - Change cache size configuration in mcu/project/ab157x/apps/bt_audio_common/src/sys_init.c by replacing

```
hal_cache_set_size(HAL_CACHE_SIZE_16KB)

with

#ifdef AIR_BTA_IC_STEREO_HIGH_G3
hal_cache_set_size(HAL_CACHE_SIZE_32KB);
#else
hal_cache_set_size(HAL_CACHE_SIZE_16KB)
```



```
#endif
```

- Change the used linker script file in `mcu/project/ab157x/apps/project/GCC/` by replacing

```
TCM (rwx) : ORIGIN = 0X04000000, LENGTH = 208K
```

with

```
TCM (rwx) : ORIGIN = 0X04000000, LENGTH = 192K
```

- Due to the optimization of the configuration of HAL features, if you have customized any HAL features in `mcu/project/ab157x/apps/<project>/inc/boards/<chip>/hal_feature_config.h`, it should perform the migration as follow.

- How to migrate:

- Please merge the differences from

`mcu/project/ab157x/apps/<project>/inc/boards/<chip>/hal_feature_config.h` to

`mcu/driver/chip/ab157x/inc/hal_feature_config.h`.

8.3.2. Example project – dongle_ref_design

- Move the common code in `dongle_ref_design` into the `bt_audio_common` folder. The moved folders are under `dongle_ref_design` project:

- `src/apps/app_fota`
- `src/apps/app_battery`
- `src/apps/app_power_save`
- `src/apps/app_state_report`
- `src/apps/config`
- `src/apps/led`
- `src/apps/utils`
- `src/apps/app_line_in`
- `src/apps/audio_trans_mgr`
- `inc/apps/app_fota`
- `inc/apps/app_battery`
- `inc/apps/app_power_save`
- `inc/apps/app_state_report`
- `inc/apps/config`
- `inc/apps/led`
- `inc/apps/utils`
- `inc/apps/app_line_in`
- `inc/apps/audio_trans_mgr`

- How to migrate:

- Change the directory structure in the old SDK to the new format.
 - Copy the `mcu/tools/scripts/migration/3.8.0/move_bt_audio_common.sh` from the new SDK code in your old project `ab157x/apps/dongle_ref_design` and `cd` to the `dongle_ref_design` folder. Input the command `./move_dongle_to_common.sh`.
 - Compare the Makefile in the old SDK and new SDK. Copy the new line2 into the old SDK.

```
APP_COMMON_PATH := project/$(IC_CONFIG)/apps/bt_audio_common
APP_COMMON_SRC  := $(APP_COMMON_PATH)/src
```

Search “APP_PATH_SRC”, most of them are replaced by “APP_COMMON_SRC”, merge them in your old SDK.

Search "APP_PATH", most of them are replaced by "APP_COMMON_PATH", merge them in your old SDK.

- Open `bt_audio_common/src/apps/module.mk`, replace the "APP_PATH" to "APP_COMMON_PATH".

2) The debug and log mechanism has been changed due to the restructuring of the Bluetooth host stack.

- How to migrate:
- Add a dummy "bt_debug.h" to the folder:
`mcu/project/ab157x/apps/dongle_ref_design/inc/bt_app_utility/`
- Delete the following text in
`mcu/project/ab157x/apps/<project>/src/apps/app_dongle_air/app_le_audio_air.c`

```
#include "bt_le_audio_msglog.h"
```

- Add the following text in
`mcu/project/ab157x/apps/<project>/src/apps/app_dongle_air/app_le_audio_air.c`

```
#include "syslog.h"
```

3) Improved battery resolution. Changed the length and value of NVkey 0x2000.

- How to migrate:
- Copy the NVKey value of KeyID="0x2000" from the latest SDK and replace the existing NVKey value of KeyID="0x2000" in `mcu/project/ab157x/apps/<project>/config_bin/<board_type>/nvkey.xml`

4) The memory layout of AB1571D needs adjustment because some features have been added on the DSP side. If this change is not merged, there will be a build error on the DSP side.

- How to migrate:
- Replace the following files with the ones in the latest SDK.
 - `mcu/project/ab157x/apps/<project>/GCC/ab1571d_flash.ld`
 - `dsp/project/ab157x/apps/dsp0_headset_ref_design/XT-XCC/ab1571d_dsp0_flash.lcf`

5) Due to the optimization of the configuration of HAL features, if you have customized any HAL features in `mcu/project/ab157x/apps/<project>/inc/boards/<chip>/hal_feature_config.h`, it should perform the migration as follow.

- How to migrate:
- Please merge the differences from
`mcu/project/ab157x/apps/<project>/inc/boards/<chip>/hal_feature_config.h` to
`mcu/driver/chip/ab157x/inc/hal_feature_config.h`.

6) The cache size must change from 16KB to 32KB because of the lower power optimization.

- How to migrate:

- Change cache size configuration in `mcu/project/ab157x/apps/bt_audio_common/src/sys_init.c` by replacing

with

```
hal_cache_set_size(HAL_CACHE_SIZE_16KB)
```

```
#ifdef AIR_BTA_IC_STEREO_HIGH_G3
hal_cache_set_size(HAL_CACHE_SIZE_32KB);
#else
hal_cache_set_size(HAL_CACHE_SIZE_16KB)
#endif
```

- Change the used linker script file in `mcu/<project>/ab157x/apps/*/GCC/` by replacing

with

```
TCM (rwx) : ORIGIN = 0X04000000, LENGTH = 208K
```

```
TCM (rwx) : ORIGIN = 0X04000000, LENGTH = 192K
```

9. SDK Version 3.8.0.AB158x

9.1. Main Changes

Revised the chip name in the SDK version numbers from AB1585_AB1588 to AB158x.

Note that the "x" in the version numbers represents a variable digit.

- Software features:
 - [dongle_ref_design] Moved the common code in dongle_ref_design into the bt_audio_common folder.
 - [speaker_ref_design] Moved the common code in speaker_ref_design into the bt_audio_common folder.
 - MCU include DSP feature.mk
 - Refer to the details about "MCU include DSP feature.mk" in the SDK v3.8.0 Main Changes section 8.1 in the AB157x.
 - [add-on] [Teams] Added support for Teams version 5
 - Native Bluetooth support (Early Release)
 - ASP (Accessory Signaling Protocol) Multi connection support
 - Voice activity detection while muted
 - Enabled the DSP feature option AIR_AUDIO_VAD_ON_MUTE_ENABLE to support this feature.
 - [add-on] [earbuds_ref_design] Software vivid passthrough (SW Vivid PT)
 - Low delay noise reduction (LDNR)
 - 0.5ms total system delay
 - Adaptive Feedback Cancellation (AFC) with howling suppression
 - Support ANC
 - [add-on] [earbuds_ref_design] PSAP
 - 12-band 4-knee point Dynamic range control (DRC)
 - 9-level Hearing Loss Compensation (HLC) can be applied on PSAP and A2DP/LE-Audio/SCO/VP
 - 2-Mic Beamforming (BF)
 - Noise reduction (NR)
 - AFC with Howling suppression
 - Support ANC
 - [add-on] [earbuds_ref_design] HA
 - Only support AB1585H
 - 50-band 4-knee point DRC
 - 16-level HLC can be applied on HA and A2DP/LE-Audio/SCO/VP
 - Impulse noise reduction (INR)

- 2-Mic BF
- NR
- 2-Mic Wind noise reduction (WNR)
- AFC with howling suppression
- ANC support
- Airoha Tool Kit (ATK)
 - Config Tool
 - Added support for hearing protection.
 - Added support for beamforming calibration for HA and PSAP.
 - Added support for Vivid PT noise floor calibration.
 - Added support for HA/PSAP/Vivid PT wind detection and environment detection settings.
 - Added multiple mic and NR instruction message on UI.
 - 1Wire Logging tool
 - Added 9600, 19200, 38400, and 57600 baud rate settings
- iOS applications and SDK
 - Added read/write NVKey API for HA DRC
- Android SDK
 - Added read/write NVKey API for HA DRC
- Windows UT APP
 - Fixed CPU high usage
- Note:
 - Optimizing the configuration of HAL features:
 - The HAL features are now controlled by the driver instead of the projects.
 - The file path for hal_feature_config.h has been changed from `mcu/project/ab158x/apps/<project>/inc/boards/<chip>/hal_feature_config.h` to `mcu/driver/chip/ab158x/inc/hal_feature_config.h`.
 - Added DVFS board option with minimum level and maximum levels; the original only supported DVFS minimum level definition in hal_feature_config.h
 - Removed the DVFS minimum level definitions from hal_feature_config.h
 - Removed definitions, i.e. `MTK_BOOT_SYS_CLK_XXX`
 - Added two options in `mcu/project/ab158x/apps/<project>/GCC/feature_<BOARD_TYPE>.mk`
 - DVFS minimum level option: `AIR_DVFS_MIN_LEVEL = DVFS_LV`
 - DVFS maximum level option: `AIR_DVFS_MAX_LEVEL = DVFS_HV`
 - These two options must not be changed.
 - Added ANC/Passthrough TWS sync mechanism implemented by the application layer.
 - Option: `AIR_APP_ANC_SYNC_ENABLE`, default defined in SDK.

- When this option enabled, ANC/Passthrough TWS behavior would control by application layer.
- In race commands “ANC ON” and “ANC OFF” mentioned in document AB156x_AB157x_AB158x_Series_Mass_Production_RACE_Application_Note, the “sync mode” value need to set 0x02 for sync by application layer.

9.2. Known Issues

There are known issues with this version of the SDK.

- [add-on] [earbuds_ref_design]
 - 300-tap FIR version of sidetone does not work with one of the feature options of SW Vivid PT, PSAP, and HA enabled.
 - Adaptive EQ does not work with one of the feature options of SW Vivid PT, PSAP, and HA enabled.

9.3. Migration

Migrate the following applications when upgrading the SDK from version 3.7.0. AB1585_AB1588 to version 3.8.0.AB158x:

9.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) The debugging mechanism has been changed due to the restructuring of the Bluetooth host stack.
 - How to migrate:
 - Add a dummy “bt_debug.h” to the folder:
mcu/project/ab158x/apps/bt_audio_common/inc/bt_app_utility/
- 2) Improved battery resolution. Changed the length and value of NVkey 0x2000.
 - How to migrate:
 - Copy the NVKey value of KeyID=“0x2000” from the latest SDK and replace the existing NVKey value of KeyID=“0x2000” in
mcu/project/ab158x/apps/<project>/config_bin/<board_type>/nvkey.xml
- 3) Add a new prevention mechanism for the inconsistency between NR option config and Mic config.
 - How to migrate:
 - When using the latest Config Tool to modify Mic or NR option, do so according to the tool prompts shown in the following figure to ensure that the number of Mics is the same as the corresponding NR option.

4) If the project enables ESC with Flash or PSRAM, it should perform the migration as follows.

- How to migrate:
- If it had enabled "HAL_ESC_MODULE_ENABLED" in `mcu/project/ab158x/apps/<project>/inc/boards/<chip>/hal_feature_config.h`, it must do the next migration:
 - Add the feature option `AIR_HAL_EXTERNAL_FLASH_TYPE` in `mcu/project/ab158x/apps/<project>/GCC/feature_*.mk`. Please set `esc_flash` if use ESC with Flash.
 - `spi_flash`: connect Flash with SPI interface
 - `esc_flash`: connect Flash with ESC interface
 - `none`: not support
 - Add the feature option `AIR_HAL_EXTERNAL_RAM_TYPE` in `mcu/project/ab158x/apps/<project>/GCC/feature_*.mk`. Please set `esc_psram` if use ESC with PSRAM.
 - `esc_psram`: connect PSRAM with ESC interface
 - `none`: not support

- 5) Due to the optimization of the configuration of HAL features, if you have customized any HAL features in `mcu/project/ab158x/apps/<project>/inc/boards/<chip>/hal_feature_config.h`, it should perform the migration as follow.

- How to migrate:
 - Please merge the differences from `mcu/project/ab158x/apps/<project>/inc/boards/<chip>/hal_feature_config.h` to `mcu/driver/chip/ab158x/inc/hal_feature_config.h`.

9.3.2. Example project – dongle_ref_design

- 1) First, refer to the SDK v.3.8.0.AB156x migration section 10.2.2 Example project – dongle_ref_design.
- 2) Improved battery resolution. Changed the length and value of NVkey 0x2000.

- How to migrate:
 - Copy the NVKey value of KeyID="0x2000" from the latest SDK and replace the existing NVKey value of KeyID="0x2000" in `mcu/project/ab158x/apps/<project>/config_bin/<board_type>/nvkey.xml`

9.3.3. Example project – speaker_ref_design

- 1) Same as SDK v.3.8.0.AB156x migration section 10.2.3 Example project – speaker_ref_design.

10. SDK Version 3.8.0.AB156x

10.1. Main Changes

Revised the chip name in the SDK version numbers from AB1565_AB1568 to AB156x.

Note that the "x" in the version numbers represents a variable digit.

- Software features:
 - [dongle_ref_design] Moved a part of code in dongle_ref_design into the bt_audio_common folder.
 - [speaker_ref_design] Moved the common code in speaker_ref_design into the bt_audio_common folder.
 - MCU include DSP feature.mk
 - Refer to the details about “MCU include DSP feature.mk” in the SDK v3.8.0 Main Changes section 8.1 in the AB157x.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Improved Dual_MIC_NR UI
 - Added support for noise floor calibration for wireless mic
 - MP tool
 - Updated DA.bin
 - Added the baud rate parameter
 - 1Wire Logging tool
 - Added 9600, 19200, 38400, and 57600 baud rate settings
 - iOS applications and SDK
 - Applied a new UI
 - Android SDK
 - Applied a new UI
 - Windows UT APP
 - Added support for 6x dual chip
 - Fixed the CPU high usage
- Note:
 - Optimizing the configuration of HAL features:
 - The HAL features are now controlled by the driver instead of the projects.
 - The file path for hal_feature_config.h has been changed from mcu/project/ab156x/apps/<project>/inc/boards/<chip>/hal_feature_config.h to mcu/driver/chip/ab156x/inc/hal_feature_config.h.
 - Added DVFS board option with minimum level and maximum levels; the original only supported DVFS minimum level definition in hal_feature_config.h

- Removed the DVFS minimum level definitions from hal_feature_config.h
- Removed definitions, i.e. MTK_BOOT_SYS_CLK_XXX
- Added two options in
mcu/project/ab156x/apps/<project>/GCC/feature_<BOARD_TYPE>.mk
 - DVFS minimum level option: AIR_DVFS_MIN_LEVEL = DVFS_LV
 - DVFS maximum level option: AIR_DVFS_MAX_LEVEL = DVFS_HV
- These two options should not usually be changed!
- Added ANC/Passthrough TWS sync mechanism implemented by the application layer.
 - Option: AIR_APP_ANC_SYNC_ENABLE, default defined in SDK.
 - When this option enabled, ANC/Passthrough TWS behavior would control by application layer.
 - In race commands “ANC ON” and “ANC OFF” mentioned in document
AB156x_AB157x_AB158x_Series_Mass_Production_RACE_Application_Note, the “sync mode”
value need to set 0x02 for sync by application layer.

10.2. Migration

Migrate the following applications when upgrading the SDK from version 3.7.0. AB1565_AB1568 to version 3.8.0.AB156x:

10.2.1. Example project – earbuds_ref_design & headset_ref_design

- 1) The debugging mechanism has been changed due to the restructuring of the Bluetooth host stack.
 - How to migrate:
 - Add a dummy “bt_debug.h” to the folder:
mcu/project/ab156x/apps/bt_audio_common/inc/bt_app_utility/
- 2) If the project enables ESC with Flash or PSRAM, it should perform the migration as follows.
 - How to migrate:
 - Merge the changes of file
mcu/project/ab156x/apps/<project>/inc/boards/<chip>/hal_feature_config.h to
file mcu/driver/chip/ab156x/inc/hal_feature_config.h.
 - If it had enabled “HAL_ESC_MODULE_ENABLED” in
mcu/project/ab156x/apps/<project>/inc/boards/<chip>/hal_feature_config.h, it
must do the next migration:
 - Add the feature option AIR_HAL_EXTERNAL_FLASH_TYPE in
mcu/project/ab156x/apps/<project>/GCC/feature_*.mk. Please set esc_flash if
use ESC with Flash.
 - spi_flash: connect Flash with SPI interface
 - esc_flash: connect Flash with ESC interface
 - none: not support

- Add the feature option AIR_HAL_EXTERNAL_RAM_TYPE in `mcu/project/ab156x/apps/<project>/GCC/feature_*.mk`. Please set `esc_psram` if use ESC with PSRAM.
 - `esc_psram`: connect PSRAM with ESC interface
 - `none`: not support
- 3) Due to the optimization of the configuration of HAL features, if you have customized any HAL features in `mcu/project/ab156x/apps/<project>/inc/boards/<chip>/hal_feature_config.h`, it should perform the migration as follow.
 - How to migrate:
 - Please merge the differences from `mcu/project/ab156x/apps/<project>/inc/boards/<chip>/hal_feature_config.h` to `mcu/driver/chip/ab156x/inc/hal_feature_config.h`.

10.2.2. Example project – dongle_ref_design

- 1) The debugging and log mechanism has been changed due to the restructuring of the Bluetooth host stack.
 - How to migrate:
 - Add a dummy “`bt_debug.h`” to the folder: `mcu/project/ab156x/apps/dongle_ref_design/inc/bt_app_utility/`
 - Delete the following text in `mcu/project/ab156x/apps/<project>/src/apps/app_dongle_air/app_le_audio_air.c`

```
#include "bt_le_audio_msglog.h"
```

- Add the following text in `mcu/project/ab156x/apps/<project>/src/apps/app_dongle_air/app_le_audio_air.c`

```
#include "syslog.h"
```

- 2) Move the common code in `dongle_ref_design` into the `bt_audio_common` folder. The moved folders are under `dongle_ref_design` project:
 - `src/apps/app_fota`
 - `src/apps/app_battery`
 - `src/apps/app_power_save`
 - `src/apps/app_state_report`
 - `src/apps/config`
 - `src/apps/led`
 - `src/apps/utils`
 - `src/apps/app_line_in`
 - `src/apps/audio_trans_mgr`
 - `inc/apps/app_fota`
 - `inc/apps/app_battery`
 - `inc/apps/app_power_save`

- inc/apps/app_state_report
- inc/apps/config
- inc/apps/led
- inc/apps/utils
- inc/apps/app_line_in
- inc/apps/audio_trans_mgr
- How to migrate:
 - Change the directory structure in the old SDK to the new format.
 - Copy the mcu/tools/scripts/migration/3.8.0/move_bt_audio_common.sh from the new SDK code in your old project/ab156x/apps/dongle_ref_design and cd to the dongle_ref_design folder. Input the command ./move_dongle_to_common.sh.
 - Compare the Makefile in the old SDK and new SDK. Copy the new line2 into the old SDK.

```
APP_COMMON_PATH := project/${IC_CONFIG}/apps/bt_audio_common
APP_COMMON_SRC  := ${APP_COMMON_PATH}/src
```

Search "APP_PATH_SRC", most of them are replaced by "APP_COMMON_SRC", merge them in your old SDK.

Search "APP_PATH", most of them are replaced by "APP_COMMON_PATH", merge them in your old SDK.

- Open bt_audio_common/src/apps/module.mk, replace the "APP_PATH" to "APP_COMMON_PATH".

3) If the project enables ESC with Flash or PSRAM, it should do the migration as follows:

- How to migrate:
- Merge the changes of file
mcu/project/ab156x/apps/<project>/inc/boards/<chip>/hal_feature_config.h to file mcu/driver/chip/ab156x/inc/hal_feature_config.h.
- If it had enabled "HAL_ESC_MODULE_ENABLED" in
mcu/project/ab156x/apps/<project>/inc/boards/<chip>/hal_feature_config.h, it must do the next migration:
 - Add the feature option AIR_HAL_EXTERNAL_FLASH_TYPE in
mcu/project/ab156x/apps/<project>/GCC/feature_*.mk. Please set esc_flash if use ESC with Flash.
 - spi_flash: connect Flash with SPI interface
 - esc_flash: connect Flash with ESC interface
 - none: not support
 - Add the feature option AIR_HAL_EXTERNAL_RAM_TYPE in
mcu/project/ab156x/apps/<project>/GCC/feature_*.mk. Please set esc_psram if use ESC with PSRAM.
 - esc_psram: connect PSRAM with ESC interface
 - none: not support

4) Due to the optimization of the configuration of HAL features, if you have customized any HAL features in mcu/project/ab156x/apps/<project>/inc/boards/<chip>/hal_feature_config.h, it should perform the migration as follow.

- How to migrate:
- Please merge the differences from
`mcu/project/ab156x/apps/<project>/inc/boards/<chip>/hal_feature_config.h` to
`mcu/driver/chip/ab156x/inc/hal_feature_config.h`.

10.2.3. Example project – speaker_ref_design

- 1) Move the common code in speaker_ref_design into bt_audio_common folder. All files exclude “boards” folder in “src” and “inc” folder are moved into the project/ab156x/apps/bt_audio_common folder. The directory structure inside the “src” and “inc” folder does not change.

- How to migrate:
 - Change the directory structure in the old SDK to the new format.
 - Copy the `mcu/tools/scripts/migration/3.7.0/move_bt_audio_common.sh` from the new SDK code in your old project/ab156x/apps/speaker_ref_design and cd to the speaker_ref_design folder. Input the command `./move_bt_audio_common.sh`.
 - Compare the Makefile in the old SDK and new SDK. Copy the new line2 into the old SDK.

```
APP_COMMON_PATH := project/${IC_CONFIG}/apps/bt_audio_common
APP_COMMON_SRC  := ${APP_COMMON_PATH}/src
```

Search “APP_PATH_SRC”, most of them are replaced by “APP_COMMON_SRC”, merge them in your old SDK.

Search “APP_PATH”, most of them are replaced by “APP_COMMON_PATH”, merge them in your old SDK.

- Open `bt_audio_common/src/apps/module.mk`, replace the “APP_PATH” to “APP_COMMON_PATH”.

11. SDK Version 3.7.0.AB1577S_AB1571D_AB1571

11.1. Main Changes

- Software features:
 - AB1577S/AB1571 earbuds reference design
 - TWS, Hybrid ANC, AINR, mcsync business (multipoint),
 - AMA, Gsound, Google fast pair, MS teams, FOTA
 - Ultra Low Latency (ULL) 2.0 multi-link
 - AB1571 headset reference design
 - TWS, Hybrid ANC, AINR, mcsync business (multipoint),
 - AMA, Gsound, Google fast pair, MS teams, FOTA
 - Audio line-in, USB-in (Early Release)
 - Ultra Low Latency (ULL) 2.0 multi-link
 - [add-on] Ultra Low Latency (ULL) 2.0
 - AB1571D dongle reference design
 - Support for audio source from line in/i2s in/USB
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Support silence detection/adaptive ANC/ HW vivid PT
 - Modify reset flow
 - iOS applications and SDK
 - [SDK] Modify default mode of passthrough
 - Windows UT APP
 - Support personal sharing
 - [add-on] LE audio/MS teams
 - Support profiles BAP, VCP, CSIP, MCP, CCP, MICP, CAP, TMAP, HAP and PBP.
 - Use high reliability QoS parameters when Targeted latency is Target balanced latency and reliability.
 - Support BT source and LE audio dual mode.
 - Support silence detection for BT source dongles.
 - Bluetooth Secure Connection
 - Secure connection is enabled to support LE Audio dual mode.
 - Bluetooth packets will be encrypted by the AES algorithm when the BT version of host is 5.3 and the LE audio feature is enabled.

11.2. Known Issues

There is a known issue with this version of the SDK.

- [add-on] LE Audio
 - LE Audio cannot be reconnected with Swift pair.

12. SDK Version 3.7.0.AB1585_AB1588

12.1. Main Changes

- Software features:
 - New example project [add-on] speaker_ref_design. The main changes based on SDK 2.8.0 are listed below:
 - Include LEA Audio (CIS, BIS).
 - Disable MCSync Broadcast mode.
 - Support Multi-link in MCSync Double mode.
 - Keep the Music and ACL link during mode switching between double and single.
 - [earbuds_ref_design] [headset_ref_design] Move the common code in earbuds_ref_design and headset_ref_design into the bt_audio_common folder.
 - [add-on] LE audio/MS Teams
 - Use high reliability QoS parameters when Targeted latency is Target balanced latency and reliability.
 - Remove HAS to prevent an Android phone threat that affects Hearing Aid devices.
 - Support BT source and LE audio dual mode.
 - Support silence detection for BT source dongles.
- Bug fixes:
 - [add-on] LE Audio
 - Fixed an LE Audio device appearance issue and use targeted announcement for reconnection.
 - Fixed an assertion issue that occurred when LE Audio call streaming with Intel platform.

12.2. Known Issues

There is a known issue with this version of the SDK.

- [add-on] LE Audio
 - LE Audio cannot be reconnected with Swift pair.

12.3. Migration

Migrated the following applications when upgrading the SDK from version 3.6.0. AB1585_AB1588 to version 3.7.0.AB1585_AB1588:

12.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Move the common code in earbuds_ref_design and headset_ref_design into bt_audio_common folder. All files exclude “boards” folder in “src” and “inc” folder are moved into the project/ab158x/apps/bt_audio_common folder. The directory structure inside the “src” and “inc” folder does not change.
- How to migrate:

- Recommended methods: Change the directory structure in the old SDK to the new format.
 - Copy the mcu/tools/scripts/migration/3.7.0/move_bt_audio_common.sh from the new SDK code in your old project/ab158x/apps/earbuds_ref_design or headset_ref_design and cd to the earbuds_ref_design or headset_ref_design folder. Input the command `./move_bt_audio_common.sh`.
 - Compare the Makefile in the old SDK and new SDK. Copy the new line2 into the old SDK.

```
APP_COMMON_PATH := project/$(IC_CONFIG)/apps/bt_audio_common
APP_COMMON_SRC  := $(APP_COMMON_PATH)/src
```

Search “APP_PATH_SRC”, most of them are replaced by “APP_COMMON_SRC”, merge them in your old SDK.

Search “APP_PATH”, most of them are replaced by “APP_COMMON_PATH”, merge them in your old SDK.

- Open bt_audio_common/src/apps/module.mk, replace the “APP_PATH” to “APP_COMMON_PATH”.
- Another method: Keeps the old directory structure.
 - Compare the files in bt_audio_common of the new SDK and earbuds_ref_design/headset_ref_design folder manually. Merge the code if you need the new changes or features.
- 2) The callback function bt_sink_srv_a2dp_int_user_conf_get may callback and parameter is NULL.
- How to migrate:
 - Open the project/ab158x/apps/<project>/src/apps/app_fast_pair/app_fast_pair_idle_activity.c and search for the function “bt_sink_srv_a2dp_int_user_conf_get”. Add the three (3) lines at the top of the function.

```
if (coming_addr == NULL || cur_addr == NULL) {
    return BT_SINK_SRV_A2DP_INT_USER_CONF_BYPASS;
}
```

- 3) The folder structure of the pre_libloader is changed.

- How to migrate:
 - Open the dsp\project\ab158x\apps\<project>\XT-XCC\Makefile. Modify path of the pre_libloader module.mk, the modified path is as follows:

```
include
$(ROOTDIR)/kernel/pre_libloader/dsp0/module.mk
```

12.3.2. Example project – dongle_ref_design

- 1) The folder structure of the pre_libloader is changed.

- How to migrate:
 - Open the dsp\project\ab158x\apps\<project>\XT-XCC\Makefile. Modify path of the pre_libloader module.mk, the modified path is as follows.

```
include
$(ROOTDIR)/kernel/pre_libloader/dsp0/module.mk
```

13. SDK Version 3.7.0.AB1565_AB1568

13.1. Main Changes

- Software features:
 - New example project [add-on] speaker_ref_design. The main changes based on SDK 2.8.0 are listed below:
 - Include LEA Audio (CIS, BIS).
 - Disable MCSync Broadcast mode.
 - Support Multi-link in MCSync Double mode.
 - Keep the Music and ACL link during mode switching between double and single.
 - Wireless mic project supports safety mode and TX side volume monitor
 - Wireless mic ULD project has PLC support
 - Move the common code in earbuds_ref_design and headset_ref_design into bt_audio_common folder.
 - [add-on] LE audio/MS Teams
 - Use high reliability QoS parameters when Targeted latency is Target balanced latency and reliability.
 - Remove HAS to prevent Android phone threat that affects Hearing Aid devices.
 - Support BT source and LE audio dual mode.
 - Support silence detection for BT source dongles.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Add detach mic1 settings
 - Modify Audio IO UI
- Bug fixes:
 - iOS applications and SDK
 - Fix adaptive ANC
 - Windows UT APP
 - Fix UI bug
 - Android APP
 - Fix FOTA progress error on headset
 - Audio_HW/IO_Config
 - Fix MicBias0 Level Select/ MixBias1 Level Select/ Mic/Line in Mode value cannot be tuned by Config Tool
 - [add-on] LE Audio
 - Fixed LE Audio device appearance issue and use targeted announcement for reconnection.

- Fixed assertion issue that occurred when LE Audio call streaming with Intel platform

13.2. Known Issues

There is a known issue with this version of the SDK.

- [add-on] LE Audio
 - LE Audio cannot be reconnected with Swift pair.

13.3. Migration

Migrate the following applications when upgrading the SDK from version 3.6.0. AB1565_AB1568 to version 3.7.0.AB1565_AB1568:

13.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Move the common code in earbuds_ref_design and headset_ref_design into the bt_audio_common folder. All files excluding “boards” folder in “src” and “inc” folder are moved into the project/ab156x/apps/bt_audio_common folder. The directory structure inside the “src” and “inc” folder does not change.

- How to migrate:
 - Recommended methods: Change the directory structure in the old SDK to the new format.
 - Copy the mcu/tools/scripts/misc/migration/3.7.0/move_bt_audio_common.sh from new SDK code in your old project/ab156x/apps/earbuds_ref_design or headset_ref_design and cd to the earbuds_ref_design or headset_ref_design folder. Input the command ./move_bt_audio_common.sh.
 - Compare the Makefile in old SDK and new SDK. Copy the new line2 into the old SDK.

```
APP_COMMON_PATH := project/$(IC_CONFIG)/apps/bt_audio_common
APP_COMMON_SRC := $(APP_COMMON_PATH)/src
```

Search “APP_PATH_SRC”, most of them are replaced by “APP_COMMON_SRC”, merge them in your old SDK.

Search “APP_PATH”, most of them are replaced by “APP_COMMON_PATH”, merge them in your old SDK.

- Open bt_audio_common/src/apps/module.mk, replace the “APP_PATH” to “APP_COMMON_PATH”.
- Another methods: Keeps the old directory structure.
 - Compare the files in bt_audio_common of new SDK and earbuds_ref_design/headset_ref_design folder manually. And merge the code if you need the new changes or features.
- 2) The callback function bt_sink_srv_a2dp_int_user_conf_get may callback and parameter is NULL.
 - How to migrate:
 - Open the project/ab156x/apps/<project>/src/apps/app_fast_pair/app_fast_pair_idle_activity.c and search the function “bt_sink_srv_a2dp_int_user_conf_get”. Add the 3 lines at the top of the function.

```
if (coming_addr == NULL || cur_addr == NULL) {  
    return BT_SINK_SRV_A2DP_INT_USER_CONF_BYPASS;  
}
```

3) The folder structure of the pre_libloader is changed.

- How to migrate:
 - Open the dsp\project\ab156x\apps\<project>\XT-XCC\Makefile. Modify path of the pre_libloader module.mk, the modified path below.

```
include  
$(ROOTDIR)/kernel/pre_libloader/dsp0/module.mk
```

13.3.2. Example project – dongle_ref_design

1) The folder structure of the pre_libloader is changed.

- How to migrate:
 - Open the dsp\project\ab156x\apps\<project>\XT-XCC\Makefile. Modify path of the pre_libloader module.mk, the modified path below.

```
include  
$(ROOTDIR)/kernel/pre_libloader/dsp0/module.mk
```

14. SDK Version 3.6.2.AB1585_AB1588

14.1. Main Changes

- Bug fixes:
 - Passed the software quality test for HA (ANC is not supported).
 - Fixed the issue where no sound was heard at the remote end with SCO when the Talk mic was set as Mic 1 and WNR/BF was enabled.
 - Fixed the issue with the AFC cut-off frequency setting where the 3kHz item had the same effect as the 2.5kHz item.
 - Fixed the configuration tool's HLC table import error issue.

15. SDK Version 3.6.1.AB1585_AB1588

15.1. Main Changes

- Bug fixes:
 - Passed the software quality test for hearing aids (HA) (ANC is not supported).
 - Fixed the long latency that occurred when switching on HA while A2DP/eSCO was streaming.
 - Fixed the noise with A2DP that occurred when the HA main mic was set as the talk mic.
 - Fixed the discontinuous VP that occurred when switching beamforming on/off.

16. SDK Version 3.6.0.AB1585_AB1588

16.1. Main Changes

- Software features:
 - SDK
 - Folder name revision – Airoha includes different SDK packages for different chips with each SDK version, such as AB1585_AB1588 and AB1565_AB1568. Some customers may want to merge the two packages into one for easy maintenance. We have made minor changes to the folder name and file name to avoid conflicts between the different chip packages when merging. The changed folder/files are listed as follows:
 - The folders in mcu/prebuilt
 - The folders in dsp/prebuilt
 - dsp/kernel/rtos
 - mcu/kernel/rtos
 - mcu/driver/CMSIS/Include
 - Code alignment of earbuds_ref_design and headset_ref_design - In previous SDK releases, earbuds_ref_design and headset_ref_design were two independent projects. Most of the source code was similar in the two projects. We plan to consolidate the two projects into a single project in the future. We align the two projects in preparation for the projects consolidation.
 - [earbuds_ref_design] ANC
 - passthrough filter adjustment by wind detection
 - seamless switch ANC/PT on earbuds project
 - Bluetooth Secure Connection
 - To support LE Audio dual mode, secure connection is enabled.
 - Bluetooth packet will be encrypted by AES algorithm when the BT version of host is 5.3 and LE audio feature is enabled.
 - Wired audio
 - Added 96K/24bit output support for USB audio downlink path.
 - Added Dual-PEQ support for USB audio downlink path.
 - Added 96K/24bit output and two (2) channel support for USB MIC path.
 - Headtracking protocol
 - Support for Google spatial audio feature by implementing the head tracking protocol.
 - [add-on] [earbuds_ref_design] Software vivid passthrough/PSAP (early release)
 - Software vivid passthrough mode.
 - PSAP mode.
 - Compensation for multimedia.
 - [add-on] [earbuds_ref_design] Support AB1585H (early release)

- Hearing aid mode.
 - Compensation for multimedia.
- Airoha Tool Kit (ATK)
 - Config Tool
 - Added dual USB audio settings including EQ/DRC, etc. of USB0 and USB1.
 - PEQ supports LHDC including 96k and 192k sample rates.
 - Added support for hearing aids and PSAP.
- Android applications and SDK
 - Added support LEA FOTA for the Android 13 smartphone.
 - Added support for hearing aids and PSAP.
 - Removed AEA, MFA and Howling control on HA UI
- iOS applications and SDK
 - Added support for hearing aids and PSAP.
 - Removed AEA, MFA and Howling control on HA UI.
- Bug fixes:
 - Windows UT APP
 - Fixed device status notification.
 - Fixed UI crash.
 - Fixed an incorrect progress status when resuming DFU.
 - Android application and SDK
 - Hid the debugging menu on LE connections.
 - Fixed the log dump crash that occurred when stopping the parser.
 - iOS applications and SDK
 - Fixed the issue where a customized read nv cmd caused a no API callback.

16.2. Known Issues

There are known issues with this version of the SDK.

- [add-on] [earbuds_ref_design] For more details for software vivid passthrough/ PSAP/ hearing aids, please refer to the document in the add-on packages. (early release)
- [add-on] [earbuds_ref_design] FOTA update slow when LE Audio is streaming.

16.3. Migration

Migrated the following applications when upgrading the SDK from version 3.5.1. AB1585_AB1588 to version 3.6.0.AB1585_AB1588:

16.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) The prebuilt folder path changed.

- How to migrate:
 - Open the mcu/project/ab158x/bootloader/GCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “prebuilt”, the latest SDK code should contain a “\$(IC_CONFIG)” at the same line. Copy and replace the line from latest SDK code into your local code.
 - Replace the “driver/CMSIS/Include” to “driver/CMSIS/Source/\$(IC_CONFIG)/Include”
 - Replace the “kernel/rtos” to “kernel/rtos/\$(IC_CONFIG)”
 - Open the mcu/project/ab158x/<project>/GCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “prebuilt”; The latest SDK code should contain a “\$(IC_CONFIG)” at the same line. Copy and replace the line from latest SDK code into your local code.
 - Scan for “Start to generate language model binary” in the file. Use the latest SDK code below the keyword to replace your local code.
 - Replace the “prebuilt/\$(MIDDLEWARE_PROPRIETARY)/psap/module.mk” to “prebuilt/\$(MIDDLEWARE_PROPRIETARY)/psap/\$(IC_CONFIG)/module.mk”
 - Replace the “driver/CMSIS/Include” to “driver/CMSIS/Source/\$(IC_CONFIG)/Include”
 - Replace the “kernel/rtos” to “kernel/rtos/\$(IC_CONFIG)”
 - Open the file mcu/project/ab158x/<project>/config_bin/<your_board>/config.xml. Replace the “gsound/ab158x” to “gsound”.
 - Open the file dsp/project/ab158x/apps/dsp0_headset_ref_design/XT-XCC/Makefile. Replace “kernel/rtos/FreeRTOS/” to “kernel/rtos/\$(IC_CONFIG)/FreeRTOS”.

2) New addon feature: Software vivid passthrough/PSAP/Hearing-aid (early release).

- How to migrate:
 - Open the dsp/project/ab158x/apps/dsp0_headset_ref_design/XT-XCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “AIR_PASSTHRU_ENABLE_TYPE”, extend new types “PASSTHRU_VIVID”, “PASSTHRU_PSAP”, “PASSTHRU_HEARING_AID” for feature option definition. Copy the content from latest SDK code into your local code.
 - Search for the keyword “AIR_HEARTHROUGH_MAIN_ENABLE” from latest SDK code, replace the feature option “AIR_HEARING_AID_ENABLE” and its content with “AIR_HEARTHROUGH_MAIN_ENABLE”.

3) Passthrough filter adjustment by wind detection

- How to migrate:
 - Open the dsp/project/ab158x/apps/dsp0_headset_ref_design/XT-XCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “AIR_PASSTHRU_ENABLE_TYPE”, extend new types “PASSTHRU_ADAPTIVE” for feature option definition. Copy the content from latest SDK code into your local code.

16.3.2. Example project – dongle_ref_design

1) The prebuilt folder path changed.

- How to migrate:
 - Open the mcu/project/ab158x/bootloader/GCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “prebuilt”, the latest SDK code should contain a “\$(IC_CONFIG)” at the same line. Copy and replace the line from latest SDK code into your local code.
 - Replace the “driver/CMSIS/Include” to “driver/CMSIS/Source/\$(IC_CONFIG)/Include”
 - Replace the “kernel/rtos” to “kernel/rtos/\$(IC_CONFIG)”
 - Open the mcu/project/ab158x/<project>/GCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “prebuilt”, the latest SDK code should contain a “\$(IC_CONFIG)” at the same line. Copy and replace the line from latest SDK code into your local code.
 - Replace the “driver/CMSIS/Include” to “driver/CMSIS/Source/\$(IC_CONFIG)/Include”
 - Replace the “kernel/rtos” to “kernel/rtos/\$(IC_CONFIG)”
 - Open the file dsp/project/ab158x/apps/dsp0_headset_ref_design/XT-XCC/Makefile, replace “kernel/rtos/FreeRTOS/” to “kernel/rtos/\$(IC_CONFIG)/FreeRTOS”.

2) The broadcast assistant folder path has changed.

- How to migrate:
 - Open the file
\\mcu\project\ab158x\apps\dongle_ref_design\src\apps\app_le_audio\app_le_audio_ba.c in the latest SDK and compare with your local code.
 - Copy and replace the line from latest SDK code into your local code.

17. SDK Version 3.6.0.AB1565_AB1568

17.1. Main Changes

- Software features:
 - SDK
 - Folder name revise – Airoha pack different SDK packages for different chips at each SDK version, such as AB1585_AB1588 and AB1565_AB1568. Some customers may want to merge the two packages into one for easy maintenance. We made minor changes to the folder name and file names to avoid any conflict that may occur when merging different chip packages. The changed folder/files are listed as follows:
 - The folders in mcu/prebuilt
 - The folders in dsp/prebuilt
 - dsp/kernel/rtos
 - mcu/kernel/rtos
 - mcu/driver/CMSIS/Include
 - Code alignment of earbuds_ref_design and headset_ref_design - In previous SDK release, earbuds_ref_design and headset_ref_design are two independent projects. Most of the source code is similar in the two projects. We plan to consolidate the two projects into one. We align the two projects in preparation for the projects consolidation in future.
 - Bluetooth Secure Connection
 - To support LE Audio dual mode, secure connection is enabled.
 - Bluetooth packet will be encrypted by AES algorithm when the BT version is 5.3 and LE audio feature is enabled.
 - Windows UT APP
 - Support dual, LEA and BT dongle mode.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - PEQ supports 192k sample rate.
 - Add Voice SWB related pages and settings.
 - headtracking protocol
 - Support for the Google spatial audio feature by implementing the head tracking protocol.
 - AB1565/AB1568 Ultra Low Latency (ULL) 2.0 Dongle and headset reference design
 - Support for one dongle to connect with two headsets playing stereo music at the same time.
 - Dual chip mixing mode
 - AB1565M supports master headset project (Gaming side). Only AB1568 supports master headset project on the previous SDK.
- Bug fixes:

- Windows UT APP
 - Fixed UI related issues.
- iOS applications and SDK
 - Fixed an OTA failure that occurred when the user canceled.

17.2. Migration

Migrated the following applications when upgrading the SDK from version 3.5.1. AB1565_AB1568 to version 3.6.0.AB1565_AB1568:

17.2.1. Example project – earbuds_ref_design & headset_ref_design

1) The prebuilt folder path changed.

- How to migrate:
 - Open the mcu/project/ab156x/bootloader/GCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “prebuilt”, the latest SDK code should contain a “\$(IC_CONFIG)” at the same line. Copy and replace the line from latest SDK code into your local code.
 - Replace the “driver/CMSIS/Include” to “driver/CMSIS/Source/\$(IC_CONFIG)/Include”
 - Replace the “kernel/rtos” to “kernel/rtos/\$(IC_CONFIG)”
 - Open the mcu/project/ab156x/<project>/GCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “prebuilt”, the latest SDK code should contain a “\$(IC_CONFIG)” at the same line. Copy and replace the line from latest SDK code into your local code.
 - Scan for “Start to generate language model binary” in the file. Use the latest SDK code below the keyword to replace your local code.
 - Replace the “driver/CMSIS/Include” to “driver/CMSIS/Source/\$(IC_CONFIG)/Include”
 - Replace the “kernel/rtos” to “kernel/rtos/\$(IC_CONFIG)”
 - Replace the “prebuilt/\$(MIDDLEWARE_PROPRIETARY)/psap/module.mk” to “prebuilt/\$(MIDDLEWARE_PROPRIETARY)/psap/\$(IC_CONFIG)/module.mk”
 - Open the file dsp/project/ab156x/apps/dsp0_headset_ref_design/XT-XCC/Makefile, replace “kernel/rtos/FreeRTOS/” to “kernel/rtos/\$(IC_CONFIG)/FreeRTOS”.

17.2.2. Example project – dongle_ref_design

1) The prebuilt folder path changed.

- How to migrate:
 - Open the mcu/project/ab156x/bootloader/GCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “prebuilt”, the latest SDK code should contain a “\$(IC_CONFIG)” at the same line. Copy and replace the line from latest SDK code into your local code.

- Replace the “driver/CMSIS/Include” to “driver/CMSIS/Source/\$(IC_CONFIG)/Include”
 - Replace the “kernel/rtos” to “kernel/rtos/\$(IC_CONFIG)”
 - Open the mcu/project/ab156x/<project>/GCC/Makefile in the latest SDK and compare with your local code.
 - Search for the keyword “prebuilt”, the latest SDK code should contain “\$(IC_CONFIG)” on the same line. Copy and replace the line from latest SDK code into your local code.
 - Replace the “driver/CMSIS/Include” to “driver/CMSIS/Source/\$(IC_CONFIG)/Include”
 - Replace the “kernel/rtos” to “kernel/rtos/\$(IC_CONFIG)”
 - Open the file dsp/project/ab156x/apps/dsp0_headset_ref_design/XT-XCC/Makefile, replace “kernel/rtos/FreeRTOS/” to “kernel/rtos/\$(IC_CONFIG)/FreeRTOS”.
- 2) The broadcast assistant folder changed.
- How to migrate:
 - Open the file
\\mcu\project\ab156x\apps\dongle_ref_design\src\apps\app_le_audio\app_le_audio_ba.c in the latest SDK and compare with your local code.
 - Copy and replace the line from latest SDK code into your local code.

18. SDK Version 3.5.1.AB1585_AB1588

18.1. Main Changes

- Bug fixes:
 - [earbuds_ref_design] Resolved an issue in which NVID_APP_BT_RECONNECT_INFO NVkey was not cleared via the SmartCharger key to unpair BT bond info.
 - [earbuds_ref_design] Resolved an issue where the controller exception and reconnection to a smartphone to fail.
 - [earbuds_ref_design] [headset_ref_design] Resolved an issue where power consumption may be increased when ANC was enabled and disabled.
 - [headset_ref_design] [dongle_ref_design] Fixed the wrong usage of USB TX endpoint number for the microphone's sample size and channel callback function.
 - [dongle_ref_design] Resolved an issue in which the dongle asserted when changing the USB mode to 10 (APPS_USB_MODE_GAMING_ULL2).
 - [dongle_ref_design] Fixed a memory overlap issue in ab158x_flash_8m.ld where there was SYSRAM memory corruption if the SYSRAM size used by MCU exceeded 724KB.
 - [dongle_ref_design] Resolved an issue where the dongle failed to send ULL2 user data to a headset.
 - [ULL2.0 multi-link] [headset_ref_design] Resolved an issue with jumpiness where the Lepin phone played music after the devices were connected to a dongle and phone.
 - [ULL2.0] [dongle_ref_design] Removed a limitation to the audio channel number of the silence detection feature.
 - [ULL2.0] [dongle_ref_design] Resolve an issue where the volume control did not operate as expected with a dongle line-in/i2s input.
 - [ULL2.0] [earbuds_ref_design] Resolved an issue where the partner might have jumpiness when earbuds wasn't connected to each other.
 - [ULL2.0] [earbuds_ref_design] Fixed a bug where pairing earbuds and the dongle failed.
 - [add-on] [LE Audio] [earbuds_ref_design] Resolved an issue in which earbuds asserted when an LE call was active with a Lenovo desktop.
 - [add-on] [LE Audio] [headset_ref_design] Resolved an issue in which the headset asserted when stopping LEA Broadcasting.

19. SDK Version 3.5.1.AB1565_AB1568

19.1. Main Changes

- Bug fixes:
 - [earbuds_ref_design] Resolved an issue in which NVID_APP_BT_RECONNECT_INFO NVkey was not cleared via the SmartCharger key to unpair BT bond info.
 - [earbuds_ref_design] Resolved an issue where pressing the key could not accept incoming calls while ULL music was playing.
 - [headset_ref_design] [dongle_ref_design] Fixed the wrong usage of USB TX endpoint number for the microphone's sample size and channel callback function.
 - [dongle_ref_design] Resolved an issue in which the dongle asserted when changing the USB mode to 10 (APPS_USB_MODE_GAMING_ULL2).
 - [dongle_ref_design] Resolved an issue in which the dongle failed when sending ULL2 user data to headset.
 - [ULL2.0] [earbuds_ref_design] Resolve an issue where the partner might have jumpiness when earbuds were not connected to each other.
 - [ULL2.0] [dongle_ref_design] Resolved a limitation to the audio channel number of the silence detection feature.
 - [ULL2.0] [dongle_ref_design] Resolved an issue in which the volume control did not operate as expected with a dongle line in/i2s input.
 - [add-on] [LE Audio] [earbuds_ref_design] Resolved an issue in which earbuds asserted when an LE call was active with a Lenovo desktop.
 - [add-on] [LE Audio] [headset_ref_design] Resolved an issue in which the headset asserted when stopping LEA Broadcasting.
 - [Common] Resolved an issue of unable to query the I2C status.

20. SDK Version 3.5.0.AB1585_AB1588

20.1. Main Changes

- Software features:
 - AB1585/AB1588 headset reference design and earbuds reference design
 - Ultra Low Latency (ULL) 2.0 multi-link
 - Improved A2DP standby mode stability
 - ULL 2.0 Earbuds sidetone support for both L and R
 - DCHS: Dual Channel Headset Solution with two ICs; One in each side of the headphone. One IC is for LEA/Classic audio to connect with SP and one IC is for ULL2.0 to connect with Dongle.
 - Wired USB audio
 - Wired USB audio out now supports high resolution (96K/192K, 24bit, 1-ch) USB MIC; Added real time monitor support.
 - ANC
 - Hybrid Passthru
 - Added feedback MIC to the original feedforward MIC-only Passthru
 - Adaptive Passthru (WND/ED)
 - Added wind noise detection and environment detection for Passthru/sidetone modes.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Added detach MIC 2 settings.
 - Added environment detection settings and wind detection settings for sidetone/passthrough modes.
 - Added support for hearing aids.
 - Applied correct analog output gain when speak out mode changed.
 - Logging Tool
 - The Port Type/Vendor_ID/Product_ID settings are now stored.
 - Added support for offline dump OFFLINE_DUMP_V2_OFFLINE_LOG.
 - 1Wire UART Lab Test Tool
 - This is the initial release.
 - Airoha Flash Tool
 - Added RACE_DA_LOCK_OTP command with CRC check.
 - Windows UT APP
 - Fixed build warning/cross-platform issues.

- Android applications
 - Changed the minimum support version to Android 8.
 - Added offline log on/off.
 - Added support for exception dump, log config, online log, and 2 mic dump.
 - Added support for hearing aids.
 - UI enhancement.
- iOS applications and SDK
 - Added support for adaptive passthrough.
 - Added support for hearing aids.
 - Added the API to show specific features.
 - Changed the minimum supported version to be iOS 11.0.
 - Updated HA EQ Utils lib
 - Removed armv7, armv7s architecture.
 - Removed OTA package file sha256 check.
- Bug fixes:
 - AB1585/AB1588 headset reference design and earbuds reference design
 - [ULL2.0] fix BT/AWS disconnect when ULL2.0 is streaming
 - [ULL2.0] fix system crash when ULL2.0 is streaming
 - [common] fix noise at low frequency due to NLE feature

20.2. Known Issues

There is a known issue with this version of the SDK.

- [earbuds_ref_design] [headset_ref_design] The microphone power consumption may be increased when ANC is enabled and disabled.

20.3. Migration

Migrated the following applications when upgrading the SDK from version 3.4.1. AB1585_AB1588 to version 3.5.0.AB1585_AB1588:

20.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Update SBC and EC libraries to optimize their functionality and add ULD library.
 - How to migrate:
 - Replace the following files with the ones in the latest SDK.
 - i. `dsp/project/ab158x/apps/dsp0_headset_ref_design/inc/preloader_split_configure.h`
- 2) Add `bt_connection_manager.h` to fix a missing BT connection manager type definition
 - How to migrate:

- Add the following text in
mcu/project/ab158x/apps/<project>/src/apps/utils/apps_dongle_sync_event.c

```
#include "bt_connection_manager.h"
```

3) Update audio format type for codebase optimization

- How to migrate:
 - Replace the following types to the new one in these two files.

Before	After
AFE_PCM_FORMAT_S24_LE	HAL_AUDIO_PCM_FORMAT_S24_LE
AFE_PCM_FORMAT_S16_LE	HAL_AUDIO_PCM_FORMAT_S16_LE

- mcu/project/ab158x/apps/headset_ref_design/src/apps/app_usb_audio/app_usb_audio_idle_activity.c
- mcu/project/ab158x/apps/headset_ref_design/src/apps/app_line_in/app_line_in_idle_activity.c

4) Optimize the PEQ flow for API calls

- How to migrate:
 - Add the following text in
mcu/project/ab158x/apps/earbuds_ref_design/src/apps/app_adaptive_eq/app_adaptive_eq_idle_activity.c

```
#include "peq_setting.h"
```

5) Increase the stack size of UI_REALTIME_TASK for log module optimization

- How to migrate:
 - Increase the UI shell stack size to the new one in
mcu/project/ab158x/apps/<project>/inc/task_def.h

```
#define UI_REALTIME_TASK_STACKSIZE (415)
```

6) Add four NVkey for Adaptive Passthru (WND/ED)

- How to migrate:
 - Copy the NVkeys of NVID 0xE306/0xE307/0xE308/0xE309 from the latest SDK
mcu/project/ab158x/apps/<project>/config_bin/<project>/nvkey.xml to the
corresponding nvkey.xml in SDK version 3.4.1

7) One feature option renames in the project makefile

- How to migrate:
 - Rename the AIR_BT_BLE_SWB_ENABLE to AIR_BT_BLE_UL_SWB_ENABLE in the
following makefiles
 - mcu/project/ab158x/apps/<project>/GCC/Makefile
 - dsp/project/ab158x/apps/<project>/XT-XCC/Makefile

20.3.2. Example project – dongle_ref_design

1) Update audio format type for codebase optimization

- How to migrate:
- Replace the following types to the new one in `mcu/project/ab158x/apps/<project>/src/apps/app_le_audio/app_le_audio_usb.c`

Before	After
<code>AFE_PCM_FORMAT_S8</code>	<code>HAL_AUDIO_PCM_FORMAT_S8</code>
<code>AFE_PCM_FORMAT_S16_LE</code>	<code>HAL_AUDIO_PCM_FORMAT_S16_LE</code>
<code>AFE_PCM_FORMAT_S24_LE</code>	<code>HAL_AUDIO_PCM_FORMAT_S24_LE</code>
<code>AFE_PCM_FORMAT_S32_LE</code>	<code>HAL_AUDIO_PCM_FORMAT_S32_LE</code>

- Replace `AFE_PCM_FORMAT_S24_LE` with `HAL_AUDIO_PCM_FORMAT_S24_LE` in `mcu/project/ab158x/apps/<project>/src/apps/app_line_in/app_line_in_utils.c`
- Replace `AFE_PCM_FORMAT_S24_LE` with `HAL_AUDIO_PCM_FORMAT_S24_LE` in `mcu/project/ab158x/apps/<project>/src/apps/app_usb_audio/app_usb_audio_utils.c`

2) Added `bt_connection_manager.h` for a missing BT connection manager type definition

- How to migrate:
- Add the following text in `mcu/project/ab158x/apps/<project>/src/apps/utis/apps_dongle_sync_event.c`

```
#include "bt_connection_manager.h"
```

3) Update SBC and EC libraries to optimize their functionality and add ULD library.

- How to migrate:
- Replace the following files with the ones in the latest SDK.
`dsp/project/ab158x/apps/dsp0_headset_ref_design/inc/preloader_split_config.h`

4) Increase the stack size of `UI_REALTIME_TASK` for log module optimization

- How to migrate:
- Increase the UI shell stack size to the new one
`mcu/project/ab158x/apps/<project>/inc/task_def.h`

```
#define UI_REALTIME_TASK_STACKSIZE (415)
```

5) Merge registering callback of USB event because Wired USB MIC supports multiple sample sizes.

- How to migrate:

- Add the following text in

mcu\project\ab158x\apps\<project>\src\apps\events\apps_events_usb_event.c

```
USB_Audio_Register_Mic_SetSampleSize_Callback(0,  
apps_event_usb_sample_size_cb);  
USB_Audio_Register_Mic_SetChannel_Callback(0,  
apps_event_usb_channel_cb);
```

6) One feature option renames in the project makefile

- How to migrate:
 - Rename the “AIR_BT_BLE_SWB_ENABLE” to “AIR_BT_BLE_UL_SWB_ENABLE” in the following Makefiles
 - mcu/project/ab158x/apps/<project>/GCC/Makefile
 - dsp/project/ab158x/apps/<project>/XT-XCC/Makefile

21. SDK Version 3.5.0.AB1565_AB1568

21.1. Main Changes

- Software features:
 - AB1565/AB1568 headset reference design and earbuds reference design
 - ULL (Ultra Low Latency) 2.0 multi-link
 - Improved A2DP standby mode stability
 - ULL2.0 Earbuds sidetone support both L and R
 - ULL2.0 Earbuds Music mode low power optimized
 - [ANC] Hybrid Passthru mode
 - Added feedback MIC to the original feedforward MIC-only Passthru
 - [ANC] Adaptive Passthru (WND/ED)
 - Added wind detection and environment detection for Passthru/sidetone modes.
 - Wireless mic
 - Added support for the ULD (ultra-low delay) codec solution which can achieve a much lower latency (i.e. <10ms) from TX to RX.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Removed talk through mode of wireless MIC settings.
 - Changed the increment steps of Battery settings.
 - Added environment detection settings and wind detection settings for sidetone/passthru modes.
 - Logging Tool
 - Offline dump support OFFLINE_DUMP_V2_OFFLINE_LOG.
 - iOS applications and SDK
 - [FOTA] remove ota package file sha256 check
 - [SDK] minimum support version changed to iOS 11.0
 - [SDK] remove armv7, armv7s architecture
 - Windows UT APP
 - Added support for the BT link dongle
- Bug fixes:
 - AB1565/AB1568 headset reference design and earbuds reference design
 - [ULL2.0] fix BT/AWS disconnect when ULL2.0 is streaming
 - [ULL2.0] fix system crash when ULL2.0 is streaming
 - iOS applications and SDK

- [FOTA] fix TWS FOTA will callback twice OTA start
- [SDK] fix SDK build warning
- Windows UT APP
- Fix build warning/cross-platform issue

21.2. Migration

Migrated the following applications when upgrading the SDK from version 3.4.1. AB1565_AB1568 to version 3.5.0.AB1565_AB1568:

21.2.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Update SBC and EC libraries to optimize their functionality and add ULD library.

- How to migrate:
 - Replace the following files with the ones in the latest SDK.
 - i. dsp/project/ab156x/apps/dsp0_headset_ref_design/inc/preloader_pli_split_configure.h

- 2) Added bt_connection_manager.h to fix a missing BT connection manager type definition

- How to migrate:
 - Add the following text in mcu/project/ab156x/apps/<project>/src/apps/utls/apps_dongle_sync_event.c

```
#include "bt_connection_manager.h"
```

- 3) Update audio format type for codebase optimization

- How to migrate:
 - Replace the following types to the new one in these two files.

Before	After
AFE_PCM_FORMAT_S24_LE	HAL_AUDIO_PCM_FORMAT_S24_LE
AFE_PCM_FORMAT_S16_LE	HAL_AUDIO_PCM_FORMAT_S16_LE

- mcu/project/ab156x/apps/headset_ref_design/src/apps/app_usb_audio/app_usb_audio_idle_activity.c
- mcu/project/ab156x/apps/headset_ref_design/src/apps/app_line_in/app_line_in_idle_activity.c

- 4) Increase the stack size of UI_REALTIME_TASK_STACKSIZE for log module optimization

- How to migrate:
 - Increase the UI shell stack size to the new one in mcu/project/ab156x/apps/<project>/inc/task_def.h

```
#define UI_REALTIME_TASK_STACKSIZE (415)
```

5) Add four NVkey for Adaptive Passthru (WND/ED)

- How to migrate:
 - Copy the NVkeys of NVID 0xE306/0xE307/0xE308/0xE309 from the latest SDK mcu/project/ab158x/apps/<project>/config_bin/<project>/nvkey.xml to the corresponding nvkey.xml in SDK version 3.4.1

21.2.2. Example project – dongle_ref_design

1) Update SBC and EC libraries to optimize their functionality and add ULD library.

- How to migrate:
 - Replace the following files with the ones in the latest SDK.
 - dsp/project/ab156x/apps/dsp0_headset_ref_design/inc/preloader_pispl_it_configure.h

2) Added “bt_connection_manager.h” to fix missing BT connection manager type definition

- How to migrate:
 - Add the following text in mcu/project/ab156x/apps/<project>/src/apps/utis/apps_dongle_sync_event.c

```
#include "bt_connection_manager.h"
```

3) Update audio format type for codebase optimization

- How to migrate:
 - Replace the following types to the new one in mcu/project/ab156x/apps/<project>/src/apps/app_le_audio/app_le_audio_usb.c

Before	After
AFE_PCM_FORMAT_S8	HAL_AUDIO_PCM_FORMAT_S8
AFE_PCM_FORMAT_S16_LE	HAL_AUDIO_PCM_FORMAT_S16_LE
AFE_PCM_FORMAT_S24_LE	HAL_AUDIO_PCM_FORMAT_S24_LE
AFE_PCM_FORMAT_S32_LE	HAL_AUDIO_PCM_FORMAT_S32_LE

- Replace AFE_PCM_FORMAT_S24_LE with HAL_AUDIO_PCM_FORMAT_S24_LE in mcu/project/ab156x/apps/<project>/src/apps/app_line_in/app_line_in_util.c
- Replace AFE_PCM_FORMAT_S24_LE with HAL_AUDIO_PCM_FORMAT_S24_LE in mcu/project/ab156x/apps/<project>/src/apps/app_usb_audio/app_usb_audio_utils.c

4) Increase the stack size of UI_REALTIME_TASK_STACKSIZE for log module optimization

- How to migrate:

- Increase the UI shell stack size to the new one
mcu/project/ab156x/apps/<project>/inc/task_def.h

```
#define UI_REALTIME_TASK_STACKSIZE (415)
```

5) Merge registering callback of USB event, since Wired USB MIC support multiple sample sizes.

- How to migrate:
- Add the following text in
mcu\project\ab156x\apps\<project>\src\apps\events\apps_events_usb_event.c

```
USB_Audio_Register_Mic_SetSampleSize_Callback(0,  
apps_event_usb_sample_size_cb);  
USB_Audio_Register_Mic_SetChannel_Callback(0,  
apps_event_usb_channel_cb);
```


22. SDK Version 3.4.1.AB1585_AB1588

22.1. Main Changes

- Bug fixes:
 - Resolved an issue in which some NVkey items were not reserved during the factory reset.
 - Resolved an issue in which the LE connection with an LE Audio stream could be disconnected when a headset was performing a device firmware update via USB.
 - Fixed a problem in which the DSP could crash when a different sampling rate was used during the LE Audio downlink/uplink.
 - Fixed a problem where stopping or playing during an ULL2.0 test would sometimes cause it to crash.
 - Resolved an issue in where the encryption key would not change when ULL2.0 was streaming.
 - Fixed a problem in which line-in scenarios did not support 96K output (i.e. modified the memory layout and changed the SYSRAM region size to 732KB on the MCU side).

23. SDK Version 3.4.1.AB1565_AB1568

23.1. Main Changes

- Bug fixes:
 - Resolved an issue in which some NVkey items were not reserved during factory reset.
 - Resolved an issue in which the LE connection with an LE Audio stream could be disconnected when a headset was performing a device firmware update via USB.
 - Fixed a problem in which the DSP could crash when a different sampling rate was used during the LE Audio downlink/uplink.
 - Resolved an issue where activating ANC could cause a crash on iOS 16.
 - Resolved an issue where one of the earbuds would sometimes have no sound when playing or stopping ULL2.0 streaming.
 - Fixed a problem where stopping or playing during an ULL2.0 test would sometimes cause it to crash.
 - Resolved an issue where the encryption key would not change when ULL2.0 was streaming.
 - Fixed a problem where turning on AIR_GAME_CHAT_VOLUME_SMART_BALANCE_ENABLE caused the wired audio to crash.

24. SDK Version 3.4.0.AB1585_AB1588

24.1. Main Changes

- Software features:
 - AB1585/AB1588 headset reference design and earbuds reference design
 - ULL (Ultra Low Latency) 2.0 Multi-Link
 - Support connections with one ULL2.0 dongle and another source (e.g., BT Audio/LE Audio) at the same time. ULL2.0 Latency is dependent on the coexisting source.

Standby Mode	HFP	A2DP	LE Audio	Connecting
ULL2.0 Latency	20ms	30ms	25ms	40ms

- [Add-on] Added payment AINR Pro/Distractor (TWS form factor distractor performance improve)
- Full adaptive ANC
 - Adaptive adjustment ANC performance according to each user's method of application (i.e. how the device is worn) and the different environmental noises.
- Adaptive EQ
 - Adaptive EQ is used to detect the air tightness of the current headset at all times to evaluate the tightness and switch EQ to achieve sound balance.
- Airoha Tool Kit (ATK)
 - Config Tool
 - 1-Wire UART COM mode baud rate support 9600, 19200, 38400 and 57600.
 - Added silence detection page to the DSP_Audio tab.
 - Added secondary path (Sz) charts and interpolation function for active EQ.
 - Added adaptive EQ enable/disable setting.
 - Appended tool UI NV only if the FW NV exists.
 - Logging Tool
 - Added option 'When COM port close, also disconnect Wireshark'.
- Android applications
 - Support DCHS FOTA.
 - Support adaptive ANC.
 - Support adaptive EQ.
- iOS applications and SDK
 - Added adaptive ANC.
 - Added adaptive PEQ.
 - Added iAP2 protocol type.

- Changed default battery threshold to 20%.
- Windows UT APP
 - Added Dual Chip HEADSET in device selection menu.
 - Support dongle LEA/ULL2.0 coexist mode.

24.2. Known Issues

There are known issues with this version of the SDK.

- The LE connection with an LE Audio stream may be disconnected when a headset is performing a device firmware update (DFU) via USB.
- The incoming HFP call may fail to accept when a ULL2.0 call is streaming.
- This is an issue with Line-in and USB audio in ULL2.0 LC3+ headset project if the input rate is not 96K because the download sampling rate is fixed to 96K.

24.3. Migration

Migrated the following applications when upgrading the SDK from version 3.3.0. AB1585_AB1588 to version 3.4.0.AB1585_AB1588:

24.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Provided more flexibility for customizing the interactive behaviors of call and music.
 - How to migrate:
 - Replace the C function "bt_customer_config_allow_play" with the ones in the latest SDK in the following files.
 - project/ab158x/apps/headset_ref_design/src/bt_app_utility/bt_customer_config.c
 - project/ab158x/apps/earbuds_ref_design/src/bt_app_utility/bt_customer_config.c
- 2) Changed the integration of PMU management
 - How to migrate:
 - Changed the C function "pmu_config_lp" to "pmu_init" and use #define HAL_PMU_MODULE_ENABLED to replace original define in project/ab158x/apps/<project>/src/sys_init.c file.
 - Changed the return value of the C function "pmu_get_power_on_reason" in project/ab158x/apps/<project>/src/apps/app_battery/app_battery_idle_activity.c file
 - Before update


```
if (s_battery_context.charger_exist_state == 0 || !(0x04 & pmu_get_power_on_reason()))
```
 - After update


```
if (s_battery_context.charger_exist_state == 0 || ((~PMU_CHRIN) & pmu_get_power_on_reason()) || pmu_get_power_on_reason() == 0)
```
- 3) Updated LC3, LC3PLUS and EC libraries to optimize their functionality

- How to migrate:
 - Replace the following files with the ones in the latest SDK.
 - i. dsp/project/ab158x/apps/dsp0_headset_ref_design/inc/preloader_pisplit_configure.h
 - ii. dsp/project/ab158x/apps/dsp0_headset_ref_design/XT-XCC/Makefile
- 4) Enhanced the ANC feature option to support more types
- How to migrate:
 - Change “AIR_ANC_ENABLE = y” to “AIR_ANC_ENABLE_TYPE = ANC_STATIC” in the project/ab158x/apps/<project>/GCC/feature_*.mk and use AIR_ANC_ENABLE_TYPE to replace original option naming.
 - Change “AIR_HYBRID_PT_ENABLE = y” to “AIR_PASSTHRU_ENABLE_TYPE = PASSTHRU_HYBRID” in the project/ab158x/apps/<project>/GCC/feature_*.mk and use AIR_PASSTHRU_ENABLE_TYPE to replace original option naming.
 - Change “AIR_HYBRID_PT_ENABLE = n” to “AIR_PASSTHRU_ENABLE_TYPE = PASSTHRU_FF” in the project/ab158x/apps/<project>/GCC/feature_*.mk and use AIR_PASSTHRU_ENABLE_TYPE to replace original option naming.
 - Change “AIR_ANC_ENABLE = n” to “AIR_ANC_ENABLE_TYPE = none” & “AIR_PASSTHRU_ENABLE_TYPE = none” in the project/ab158x/apps/<project>/GCC/feature_*.mk file.
- 5) Updated the ULL latency definition
- How to migrate:
 - Update the following definitions with the ones in the latest SDK in the project/ab158x/apps/<project>/inc/bt_app_utility/bt_app_common.h file.
 - BT_APP_COMMON_ULL_STREAM_RETRY_COUNT_FOR_DISCOVER
 - BT_APP_COMMON_ULL_STREAM_RETRY_COUNT_FOR_CONNECTING
 - BT_APP_COMMON_ULL_STREAM_RETRY_COUNT_FOR_MULTI_LINK
 - BT_APP_COMMON_ULL_STREAM_RETRY_COUNT_FOR_MULTI_LINK_A2DP

24.3.2. Example project – dongle_ref_design

- 1) Changed the integration of PMU management
- How to migrate:
 - Changed the C function “pmu_config_lp” to “pmu_init” and use #define HAL_PMU_MODULE_ENABLED to replace original define in project/ab158x/apps/<project>/src/sys_init.c file.
 - Changed the return value of the C function “pmu_get_power_on_reason” in project/ab158x/apps/<project>/src/apps/app_battery/app_battery_idle_activity.c file
 - Before update

```
if (s_battery_context.charger_exist_state == 0 || !(0x04
& pmu_get_power_on_reason()))
```

- After update

```
if (s_battery_context.charger_exist_state == 0 ||  
    ((~PMU_CHRIN) & pmu_get_power_on_reason()) ||  
    pmu_get_power_on_reason() == 0)
```

2) Enhanced the ANC feature option to support more types

- How to migrate:
 - Changed “AIR_ANC_ENABLE = n” to “AIR_ANC_ENABLE_TYPE = none” & “AIR_PASSTHRU_ENABLE_TYPE = none” in the project/ab158x/apps/<project>/GCC/feature_*.mk file.

3) Updated LC3, LC3PLUS and EC libraries to optimize their functionality

- How to migrate:
 - Replace the following files with the ones in the latest SDK.
 - i. dsp/project/ab158x/apps/dsp0_headset_ref_design/inc/preloader_pisplit_configure.h
 - ii. dsp/project/ab158x/apps/dsp0_headset_ref_sdesign/XT-XCC/Makefile

25. SDK Version 3.4.0.AB1565_AB1568

25.1. Main Changes

- Software features:
 - AB1565/AB1568 headset reference design and earbuds reference design
 - ULL (Ultra Low Latency) 2.0 Multi-Link
 - Supports connections with one ULL2.0 dongle and another source (e.g., BT Audio/LE Audio) at the same time. ULL2.0 Latency is dependent on coexisting sources.
- | Standby Mode | HFP | A2DP | LE Audio | Connecting |
|----------------|------|------|----------|------------|
| ULL2.0 Latency | 20ms | 30ms | 25ms | 40ms |
- Wireless MIC
 - Support ULL2.0 UL and RX can connect with 2TX at most
 - TX side support 3.5mm AUX in (external MIC)/USB in/USB out/Local recording/USB mass storage
 - RX side support 3.5mm AUX out/USB out/I2S Slave out
 - RX side support merge/split mode
 - Airoha Tool Kit (ATK)
 - Config Tool
 - 1-Wire UART COM mode baud rate support 9600, 19200, 38400 and 57600.
 - Added wireless MIC pages.
 - Supported Wired Audio Dual PEQ feature.
 - Android applications
 - Support ANC user trigger.
 - Update PEQ library to support more EQ filter type.
 - iOS applications and SDK
 - Added ANC user trigger.
 - Updated PEQ lib to support more EQ filter type.
 - Windows UT APP
 - Added Wireless MIC dongle/headset to the device selection menu.
 - Support dongle LEA/ULL2.0 coexist mode.
 - Wired USB audio Hi-res DL 96k/24bits
 - Added 96K support for both USB audio speakers.
 - Added separate PEQ control for 2nd USB audio speaker.
- Bug fixes:
 - Airoha Tool Kit (ATK)

- Config Tool
 - Fixed after the USB is removed, the tool fails for a long time.
 - Optimized the function of Google Fast Pairing. Users don't need to add 00 to the 4th byte.
- MP Tool
 - Fixed an issue that occurred where the tool did not respond for a long time after removing the USB.
- Android applications
 - Continue to run the next FOTA step even there is no RHO DONE event received before timeout.
- iOS applications and SDK
 - Fixed the display of the gesture UI.

25.2. Known Issues

There are known issues with this version of the SDK.

- The LE connection with an LE Audio stream may be disconnected when a headset is performing a device firmware update (DFU) via USB.
- The incoming HFP call may fail to accept when a ULL2.0 call is streaming.

25.3. Migration

Migrated the following applications when upgrading the SDK from version 3.3.0.AB1565_AB1568 to version 3.4.0.AB1565_AB1568:

25.3.1. Example project – earbuds_ref_design & headset_ref_design

- 3) Provided more flexibility for customizing the interactive behaviors of call and music.
 - How to migrate:
 - Replace the C function "bt_customer_config_allow_play" with the ones in the latest SDK in the following files.
 - project/ab156x/apps/headset_ref_design/src/bt_app_utility/bt_customer_config.c
 - project/ab156x/apps/earbuds_ref_design/src/bt_app_utility/bt_customer_config.c
- 4) Added new feature support in the ECNR library
 - How to migrate:
 - Add NVkey: KeyID="0xE174" in the following file
 - project/ab156x/apps/<project>/config_bin/*/nvkey.xml

(The content for 0xE174 NVkey can be copied from the nvkey.xml of ab158x project.)
- 5) Changed the integration of PMU management
 - How to migrate:

- Changed the C function “pmu_config_lp” to “pmu_init” and use #define HAL_PMU_MODULE_ENABLED to replace original define in project/ab156x/apps/<project>/src/sys_init.c file.
- Changed the return value of the C function “pmu_get_power_on_reason” in project/ab156x/apps/<project>/src/apps/app_battery/app_battery_idle_activity.c file

- Before update

```
if (s_battery_context.charger_exist_state == 0 || !(0x04
& pmu_get_power_on_reason()))
```

- After update

```
if (s_battery_context.charger_exist_state == 0 ||
((~PMU_CHRIN) & pmu_get_power_on_reason()) ||
pmu_get_power_on_reason() == 0)
```

6) Updated LC3, LC3PLUS and EC libraries to optimize their functionality

- How to migrate:
 - Replace the following files with the ones in the latest SDK.
 - i. dsp/project/ab156x/apps/dsp0_headset_ref_design/inc/preloader_pisplit_configure.h
 - ii. dsp/project/ab156x/apps/dsp0_headset_ref_sdesign/XT-XCC/Makefile

7) Enhanced the ANC feature option to support more types

- How to migrate:
 - Change “AIR_ANC_ENABLE = y” to “AIR_ANC_ENABLE_TYPE = ANC_STATIC” in the project/ab156x/apps/<project>/GCC/feature_*.mk and use AIR_ANC_ENABLE_TYPE to replace original option naming.
 - Change “AIR_HYBRID_PT_ENABLE = y” to “AIR_PASSTHRU_ENABLE_TYPE = PASSTHRU_HYBRID” in the project/ab156x/apps/<project>/GCC/feature_*.mk and use AIR_PASSTHRU_ENABLE_TYPE to replace original option naming.
 - Change “AIR_HYBRID_PT_ENABLE = n” to “AIR_PASSTHRU_ENABLE_TYPE = PASSTHRU_FF” in the project/ab156x/apps/<project>/GCC/feature_*.mk and use AIR_PASSTHRU_ENABLE_TYPE to replace original option naming.
 - Change “AIR_ANC_ENABLE = n” to “AIR_ANC_ENABLE_TYPE = none” & “AIR_PASSTHRU_ENABLE_TYPE = none” in the project/ab156x/apps/<project>/GCC/feature_*.mk file.

8) Updated the ULL latency definition

- How to migrate:
 - Update the following definitions with the ones in the latest SDK in the project/ab156x/apps/<project>/inc/bt_app_utility/bt_app_common.h file.
 - BT_APP_COMMON_ULL_STREAM_RETRY_COUNT_FOR_DISCOVER
 - BT_APP_COMMON_ULL_STREAM_RETRY_COUNT_FOR_CONNECTING
 - BT_APP_COMMON_ULL_STREAM_RETRY_COUNT_FOR_MULTI_LINK
 - BT_APP_COMMON_ULL_STREAM_RETRY_COUNT_FOR_MULTI_LINK_A2DP

25.3.2. Example project – dongle_ref_design

1) Added new feature support in the ECNR library

- How to migrate:
 - Add NVkey: KeyID="0xE174" in the following file
 - project/ab156x/apps/<project>/config_bin/*/nvkey.xml
- (The content for 0xE174 NVkey can be copied from the nvkey.xml of ab158x project.)

2) Changed the integration of PMU management

- How to migrate:
 - Changed the C function “pmu_config_lp” to “pmu_init” and use #define HAL_PMU_MODULE_ENABLED to replace original define in project/ab156x/apps/<project>/src/sys_init.c file.
 - Changed the return value of the C function “pmu_get_power_on_reason” in project/ab156x/apps/<project>/src/apps/app_battery/app_battery_idle_activity.c file

- Before update

```
if (s_battery_context.charger_exist_state == 0 || !(0x04  
& pmu_get_power_on_reason()))
```

- After update

```
if (s_battery_context.charger_exist_state == 0 ||  
((~PMU_CHRIN) & pmu_get_power_on_reason()) ||  
pmu_get_power_on_reason() == 0)
```

3) Enhanced the ANC feature option to support more types

- How to migrate:
 - Changed “AIR_ANC_ENABLE = n” to “AIR_ANC_ENABLE_TYPE = none” & “AIR_PASSTHRU_ENABLE_TYPE = none” in the project/ab156x/apps/<project>/GCC/feature_*.mk file.

4) Updated LC3, LC3PLUS and EC libraries to optimize their functionality

- How to migrate:
 - Replace the following files with the ones in the latest SDK.
 - i. dsp/project/ab156x/apps/dsp0_headset_ref_design/inc/preloader_pisplit_configure.h
 - ii. dsp/project/ab156x/apps/dsp0_headset_ref_sdesign/XT-XCC/Makefile

26. SDK Version 3.3.0.AB1585_AB1588

26.1. Main Changes

- Software features:
 - LE Audio
 - Get certificated and the Declaration ID is D061343
 - Upgraded profiles: BAP, CSIP and PACS.
 - Added profiles: CAP, TMAP, HAP and PBP.
 - AB1585/AB1588 headset reference design and earbuds reference design
 - Added support for ULL (Ultra Low Latency) 2.0
 - Low Latency (~20ms) Hi-Resolution Audio and more urgent data bandwidth to support feedback sensor data to Dongle.
 - LC3plus codec, DL: 96K/24bit, UL:32K/16bit
 - Single link mode: keep connection with single source (Smart Phone/Dongle) at the same time.
 - AB1585 Dongle reference design
 - Added support for ULL 2.0
 - Support Audio source come from line in/i2s in/USB
 - [GSound] Added support for hotword feature
 - [Spotify Tap] Added support for Spotify Tap feature
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Raw Command supported Dual-Chip headset.
 - Exporting audio NV by domain. ED, Hybrid Passthru and adaptive ANC are included in ANC related domains.
 - Android applications
 - Added PBP name parsing to the LEA BIS page.
 - Added support for hybrid passthrough.
 - iOS applications and SDK
 - Added support for Dual-Chip headset FOTA.
 - Windows UT APP
 - Added support for Dual-Chip headset local DFU.
 - Added support for two links on ULL 2.0.
- Bug fixes:
 - [AB1585] Improved RF desense between RF & USB module

26.2. Migration

Migrated the following applications when upgrading the SDK from version 3.2.0.AB1585_AB1588 to version 3.3.0.AB1585_AB1588:

26.2.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Corrected LC3 dynamic load rule with LE audio feature option.
 - How to migrate:
 - Replace the following files with the ones in the latest SDK.
 - `dsp/project/ab158x/apps/dsp0_headset_ref_design/inc/preloader_pisplit_configure.h`
- 2) Added audio calibration gain NVkey.
 - How to migrate:
 - Add NVkey: KeyID="0xE093" in the following file
 - `project/ab158x/apps/<project>/config_bin/*/nvkey.xml`
 - Add the NVkey "NVID_DSP_FW_PARA_COMPONENT_GAIN_OFFSET" into the reserved item list in the following file
 - `project/ab158x/apps/<project>/inc/nvdm_config_factory_reset.h`
- 3) Corrected configuration setting for the line in feature. (Only for earbuds_ref_design)
 - How to migrate:
 - Delete the feature option: "AIR_LINEIN_ENABLE = y" in the following file
 - i. `project/ab158x/apps/earbuds_ref_design/GCC/Makefile`

26.2.2. Example project – dongle_ref_design

- 1) Added audio calibration gain NVkey.
 - How to migrate:
 - Add NVkey: KeyID="0xE093" in the following file
 - `project/ab158x/apps/<project>/config_bin/*/nvkey.xml`
 - Add the NVkey "NVID_DSP_FW_PARA_COMPONENT_GAIN_OFFSET" into the reserved item list in the following file
 - `project/ab158x/apps/<project>/inc/nvdm_config_factory_reset.h`
- 2) Use the new BT ULL Service definition to replace the app module in the `app_ull_dongle_le.c` file.
 - How to migrate:
 - Modify `BT_ULL_LE_LINK_MAX_NUM` to `BT_ULL_LE_MAX_LINK_NUM` in the following file
 - i. `project/ab158x/apps/dongle_ref_design/src/app_dongle/app_ull_dongle_le.c`
- 3) Changed the implementation method to enhance the path of "air bt/port service bt/mux bt" to support three links. It is not necessary to call `ble_air_srv_switch_link` function to switch link to agent.

- How to migrate:
 - Delete the C function “ble_air_srv_switch_link” in the following file
 - i. project/ab158x/apps/dongle_ref_design/src/app_dongle_air/app_le_audio_air.c

27. SDK Version 3.3.0.AB1565_AB1568

27.1. Main Changes

- Software features:
 - LE Audio
 - Get certificated and the Declaration ID is D061343
 - Upgraded profiles: BAP, CSIP and PACS.
 - Added profiles: CAP, TMAP, HAP and PBP.
 - AB1565/AB1568 headset reference design and earbuds reference design
 - Added support for ULL (Ultra Low Latency) 2.0
 - Low Latency (~20ms) Hi-Resolution Audio and more urgent data bandwidth to support feedback sensor data to Dongle.
 - LC3plus codec, DL:96K/24bit, UL:16K/16bit
 - Inhouse codec, DL:48K/16bit, UL:16K/16bit
 - Single link mode: keep connection with single source (Smart Phone/Dongle) at the same time.
 - AB1565 Dongle reference design
 - Added support for ULL (Ultra Low Latency) 2.0
 - Support Audio source come from line in/i2s in/USB
 - Added support combo dongle; CIS/BIS/ULL2.0
 - [Spotify Tap] Added support for Spotify Tap feature
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Added hybrid passthrough pages.
 - Added sidetone 62 taps constraint description.
 - Android applications
 - Added support for hybrid passthrough.
 - Windows UT APP
 - Enabled DFU remote Dual-Chip option.
 - Added support for ULL 2.0 2 links.
- Bug fixes:
 - [AB1565] Fixed BT disconnection issue
 - [AB1565] Improved power consumption in RTC mode
 - Airoha Tool Kit (ATK)

- Config Tool
 - Fixed an issue where heavy reading made lock waiting too long.
- Android applications
 - Fixed the retry cmd of dual chip FOTA.
- iOS applications and SDK
 - Fixed the issue where it could not connect to 155x chip.
 - Fixed the issue where mmi enum notified only callback one time.
 - Fixed dual chip and 65 maindev3 FOTA was blocked by dual chip product category check
- Windows UT APP
 - Fixed DFU adaptive DFU.
 - Fixed command retry timer.

27.2. Migration

Migrated the following applications when upgrading the SDK from version 3.2.0.AB1565_AB1568 to version 3.3.0.AB1565_AB1568:

27.2.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Corrected LC3 dynamic load rule with LE audio feature option.
 - How to migrate:
 - Replace the following file with the one in the latest SDK.
 - `dsp/project/ab156x/apps/dsp0_headset_ref_design/inc/preloader_pisplit_configure.h`
- 2) Corrected configuration setting for the line in feature. (Only for earbuds_ref_design)
 - How to migrate:
 - Delete the feature option: “AIR_LINEIN_ENABLE = y” in the following file
 - i. `project/ab156x/apps/earbuds_ref_design/GCC/Makefile`

27.2.2. Example project – dongle_ref_design

- 1) Use the new BT ULL Service definition to replace the app module in the `app_ull_dongle_le.c` file.
 - How to migrate:
 - Modify `BT_ULL_LE_LINK_MAX_NUM` to `BT_ULL_LE_MAX_LINK_NUM` in the following file
 - i. `project/ab156x/apps/dongle_ref_design/src/app_dongle/app_ull_dongle_le.c`
- 2) Changed the implementation method to enhance the path of "air bt/port service bt/mux bt" to support three links. It is not necessary to call `ble_air_srv_switch_link` function to switch link to agent.
 - How to migrate:
 - Delete the C function “ble_air_srv_switch_link” in the following file
 - i. `project/ab156x/apps/dongle_ref_design/src/app_dongle_air/app_le_audio_air.c`

28. SDK Version 3.2.0.AB1585_AB1588

28.1. Main Changes

- Software features:
 - AB1585/AB1588 headset reference design and earbuds reference design
 - Added support for Zoom meeting software
 - SDK
 - Added GATT client discovery APIs to the SDK, replacing the original GATT client discovery module in the earbuds_ref_design and headset_ref_design projects. Please see Section 28.2.1 under Migration for more details.
 - Replaced the nvdm_write_data_item in the SDK with nvkey_write_data. The nvdm_write_data_item API will be deprecated.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Fixed the IGO bypass mode disappearing issue.
 - Updated the IGO tuning options in customer mode to include teams/FB range/FB comfort noise/1MIC, and 1+1MIC NR options.
 - Added DMIC4/5 selection to the Audio_HW_IO page.
 - Enabled sidetone 300 tuning.
 - Enabled the USB setting page for AB1585.
 - Android applications
 - Fixed the single FOTA failure that occurred in specific situations.
 - Fixed the online log share button.
 - Fixed the FOTA Long Packet re-send command mechanism that was incorrect in specific situations.
 - Changed the adaptive FOTA to use two pages per command to speed up the FOTA process.
 - iOS applications and SDK
 - Added a fully adaptive ANC function.
- Bug fixes:
 - Fixed the known issues in v3.1.0.AB1585_AB1588 (i.e. music auto resume)

28.2. Migration

Migrated the following applications when upgrading the SDK from version 3.1.0.AB1585_AB1588 to version 3.2.0.AB1585_AB1588:

28.2.1. Example project – earbuds_ref_design & headset_ref_design

1. Use the new GATT client discovery SDK APIs to replace the GATT client discovery module in the project.

- How to migrate:
 1. Remove files:
project/ab158x/apps/<project>/inc/bt_app_utility/bt_gattc_discovery.h
project/ab158x/apps/<project>/src/bt_app_utility/bt_gattc_discovery.c
 2. Modify project/ab158x/apps/<project>/GCC/Makefile:
Delete: "\$(APP_PATH_SRC)/bt_app_utility/bt_gattc_discovery.c \
Add feature option: "AIR_GATTC_DISCOVERY_ENHANCE_ENABLE = y"
 3. Follow the API Reference/Bluetooth Services/GATT Client Discovery Service and use the new GATT client discovery APIs to replace the implementation of the GATT discovery module in the project.
(API Reference: mcu/doc/Airoha_IoT_SDK_for_158x_API_Reference_Manual.html)
- 2. Remove the conditional statement wrapped by AIR_BTA_IC_PREMIUM_G2 in Makefile.
 - Replace lines 703 to 726 in SDK 3.1.0 with lines 684 to 697 in SDK 3.2.0's Makefile.
- 3. Replace the following files with the ones in the latest SDK.
 - <project>/config_bin/*/nvkey.xml
 - <project>/inc/nvdm_config.h & nvdm_config_factory_reset.h
- 4. <project>/src/nvdm_config.c & nvdm_config_factory_reset.c Merge v3.1.0.AB1585_AB1588 and the latest SDK delta of the following files.
 - <project>/src/bt_app_utility/bt_app_common.c
 - <project>/src/apps/app_idle/app_home_screen_idle_activity.c

29. SDK Version 3.2.0.AB1565_AB1568

29.1. Main Changes

- Software features:
 - Added support for AB1568 earbuds/headset
 - Added support for AB1565D LE audio dongle
 - AB1585/AB1588 headset reference design and earbuds reference design
 - Added support for Zoom meeting software
 - SDK
 - Revised the NVDM driver to support multiple partitions and changed the memory layout by adding a new partition (i.e. NVDM_OTA).
 - Replaced the nvdm_write_data_item in the SDK with nvkey_write_data. The nvdm_write_data_item API will be deprecated.
 - Added GATT client discovery APIs to the SDK, replacing the original GATT client discovery module in the earbuds_ref_design and headset_ref_design projects. Please see Section 29.3.1 Migration for details.
 - Airoha Tool Kit (ATK)
 - Config Tool
 - Added new option items to the input/output path settings of HW IO page:
 - I2S Slave in/out.
 - Added new settings to the Audio_HW_IO page:
 - detach MIC_Select_2 and detach and MIC_Bias_Enable.
 - Removed the Power ON Setting and Two Step CV Setting from the Battery page.
 - Logging tool
 - The logging tool now checks the log.bin to prevent the wrong tool from being used.
 - Lab test tool
 - Disabled the 2402, 2426, 2480MHz channels when the Modulation type is 2Mbps.
 - iOS applications and SDK
 - Increased the FOTA commit timeout.
- Bug fixes:
 - Airoha Tool Kit (ATK)
 - Config tool
 - Fixed the incorrect export format of ANC UI NV.
 - Fixed the incorrectly enabling ANC control flag in ANC FB tuning.
- Note:

- [Config Tool] The opened FW load folder must include the two nvdm bin files:
 - nvdm.bin and nvdm_ou.bin.

29.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- Gsound hotword may not work on earbuds or headset connected to Samsung S10.

29.3. Migration

Migrated the following applications when upgrading the SDK from version 3.1.1.AB1565_AB1568 to version 3.2.0.AB1565_AB1568:

29.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Replace the memory layout and link script files with the v3.2.0 release under the <project> folder:
 - all memory_map.h
 - all files with the suffix ld
- 2) Remove the conditional statement wrapped by AIR_BTA_IC_PREMIUM_G2 in Makefile.
 - Replace lines 703 to 726 in SDK 3.1.1 with lines 684 to 697 in SDK 3.2.0's Makefile.
- 3) Replace the following files with the ones in the latest SDK.
 - <project>/config_bin/*/nvkey.xml
 - <project>/inc/nvdm_config.h & nvdm_config_factory_reset.h
 - <project>/src/nvdm_config.c & nvdm_config_factory_reset.c
- 4) Merge v3.1.1.AB1565_AB1568 and the latest SDK delta of the following files.
 - <project>/src/bt_app_utility/bt_app_common.c
 - <project>/src/apps/app_idle/app_home_screen_idle_activity.c
- 5) Use the new GATT client discovery SDK APIs to replace the GATT client discovery module in the project.
 - How to migrate:
 1. Remove files:
project/ab156x/apps/<project>/inc/bt_app_utility/bt_gattc_discovery.h
project/ab156x/apps/<project>/src/bt_app_utility/bt_gattc_discovery.c
 2. Modify project/ab156x/apps/<project>/GCC/Makefile:
Delete: “\$(APP_PATH_SRC)/bt_app_utility/bt_gattc_discovery.c \”
Add feature option: “AIR_GATTC_DISCOVERY_ENHANCE_ENABLE = y”
 3. Follow the API Reference/Bluetooth Services/GATT Client Discovery Service and use the new GATT client discovery APIs to replace the implementation of the GATT discovery module in the project.
(API Reference: mcu/doc/Airoha_IoT_SDK_for_156x_API_Reference_Manual.html)

30. SDK Version 3.1.1.AB1565_AB1568

30.1. Main Changes

- Bug fixes:
 - Corrected board configuration setting to enable LED function on the headset_ref_design project.

31. SDK Version 3.1.0.AB1585_AB1588

31.1. Main Changes

- Software features:
 - Microsoft Teams function over USB for headset
 - AB1585/AB1588 headset reference design
 - [Add-on] Google SASS, Google SPOT/Find me (early release)
 - Adaptive ANC – environment detection and wind noise cancellation
 - AB1585/AB1588 earbuds reference design
 - [Add-on] Google SASS, Google SPOT/Find me (early release)
 - Airoha Tool Kit (ATK)
 - V3.1.x ATK is incompatible with V3.0.x SDK
 - Config tool
 - Added IGO preset V5
 - Added charts to show the detailed data for wind detection tuning
 - Added sidetone FIR EQ tuning page
 - Added USB settings page
 - Modified 1Wire UART baud rate options
 - Modified wording of settings on Audio_HW_IO page
 - Android applications and SDK
 - Added "Support 88.2k and 96k" option on PEQ page
 - Changed the log format to be structured log
 - iOS applications and SDK
 - Added "Support 88.2k and 96k" option on PEQ page
 - Added new error code and message for ed
 - Sealing check is supported when there is no music file
 - Windows UT APP
 - Added "Support 88.2k and 96k" option on PEQ page
 - Added Query FW version task in single DFU to avoid re-starting FOTA
 - Added ULL 2.0 dongle device type
 - Changed the log format to structured log
- Bug fixes:
 - Resolved an issue where the reset key would sometimes not reset the system.

31.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- There is a known issue in multipoint scenarios:
 - LE Dongle Call + Smartphone Play Music
 - Music cannot auto resume after the call ends when smartphone music is interrupted by the call. You can only listen to music by manually operation.

31.3. Migration

Migrate the following module-based applications when upgrading the SDK from version 3.0.0.AB1585_AB1588 to version 3.1.0.AB1585_AB1588:

31.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) LC3 feature refactoring and adding some support features to the project
 - How to migrate:
 1. Replace the following file with the ones in the latest SDK.
 - dsp/project/ab158x/apps/dsp0_headset_ref_design/XT-XCC/Makefile
 2. [Optional] Add some new feature options in feature_*.mk and enable it.
- 2) Adjust some DSP BOOMIC and CPD NVkeys
 - How to migrate:
 1. Modify the following content in inc/nvdm_config_factory_reset.h in the project folder.
 - Remove below content
 - NVID_DSP_ALG_AEC_NR_BMIC,\
 - NVID_DSP_ALG_EQ_NB_TX_BMIC,\
 - NVID_DSP_ALG_EQ_WB_TX_BMIC,\
 - NVID_DSP_ALG_CPD_WB_TX_VO_BMIC,\
 - NVID_DSP_ALG_EQ_TX_FIR_BMIC,\
 - Add below content
 - NVID_DSP_ALG_AEC_BOOMIC,\
 - NVID_DSP_ALG_NR_BOOMIC,\
 - NVID_DSP_ALG_INEAR_BOOMIC,\
 - NVID_DSP_ALG_AEC_NR_SWB_BOOMIC,\
 - NVID_DSP_ALG_EQ_NB_TX_BOOMIC,\
 - NVID_DSP_ALG_EQ_WB_TX_BOOMIC,\
 - NVID_DSP_ALG_EQ_SWB_TX_BOOMIC,\
 - NVID_DSP_ALG_CPD_NB_TX_VO_BOOMIC,\
 - NVID_DSP_ALG_CPD_WB_TX_VO_BOOMIC,\
 - NVID_DSP_ALG_CPD_SWB_TX_VO_BOOMIC,\
 - NVID_DSP_ALG_EQ_NB_TX_FIR_BOOMIC,\
 - NVID_DSP_ALG_EQ_WB_TX_FIR_BOOMIC,\
 - NVID_DSP_ALG_EQ_SWB_TX_FIR_BOOMIC,\
 2. Update NVkey 0xE4C0 value as below content in the config_bin/{board_type}/nvkey.xml in the project folder.

- Before update

```
0x00000000000000000000000000000000
```

- After update

```
0x0000000000000000000000000000000000000000
```

3) Fixed arguments too long in windows build environment

- How to migrate:

Method 1. Replace the following file with the ones in the latest SDK.

- mcu/project/ab158x/apps/bootloader/GCC/Makefile

Method 2. Only modify line 242 (remove all **white space**) and line 243 (add **** to each DOTA_ENC_IV data).

- After update – line 242

```
CFLAGS+=-
DOTA_ENC_KEY="{0xf,0xe,0xd,0xc,0xb,0xa,9,8,7,6,5,4,3,2,1,0}"
"
```

- After update – line 243

```
CFLAGS += -
DOTA_ENC_IV="{\\'c\\',\\'7\\',\\'8\\',\\'2\\',\\'d\\',\\'c\\'\\',\\'4\\',\\'c\\',\\'0\\',\\'9\\',\\'8\\',\\'c\\',\\'6\\',\\'6\\',\\'c\\',\\'b\\'}"
```

32. SDK Version 3.1.0.AB1565_AB1568

32.1. Main Changes

- SDK
 - Upgraded the dsp tool chain to RI-2021.8 and mcu tool chain from GCC 4.8.4 to GCC 9.2.1. Please get the Windows and Linux all-in-one package to reinstall the tool chain.
 - Applied 1585 SDK v3 changes to the AB1565_AB1568 package.
- Software features:
 - AB1565 earbuds reference design
 - 2.11.0 legacy features
 - TWS, Hybrid ANC, mcsync business (multipoint), FOTA
 - [Add-on] LE audio, AINR, AMA, Gsound, Google fast pair, MS teams
 - [Add-on] Google SASS, Google SPOT/Find me (early release)
 - AB1565 headset reference design
 - 2.11.0 legacy features
 - Hybrid ANC, mcsync business (multipoint), FOTA, Audio line-in, USB-in
 - [Add-on] LE audio, AINR, AMA, Gsound, Google fast pair, MS teams
 - [Add-on] Google SASS, Google SPOT/Find me (early release)
 - Airoha Tool Kit (ATK)
 - V3.x.x ATK is incompatible with V2.x.x SDK.
 - Config tool
 - Input/output files changes:
 - Two new files are required/updated in the open/save operation: nvkey_chip.xml and nvkey.xml
 - The file type of NVKEY import/export is changed to be XML
 - Added charts to show the detailed data for wind detection
 - Modified 1Wire UART baud rate options
 - Android applications and SDK
 - Supported SDK Version 3.1.0.AB1565_AB1568
 - Added option "Support 88.2k and 96k" on PEQ page
 - iOS applications and SDK
 - Supported SDK Version 3.1.0.AB1565_AB1568
 - Added option "Support 88.2k and 96k" on PEQ page
 - Windows UT APP
 - Supported SDK Version 3.1.0.AB1565_AB1568
 - Added option "Support 88.2k and 96k" on PEQ page

- Bug fixes:
 - Avoid battery charging in abnormal state. The earbuds also cannot play music when user removes earbuds from 1-wire charger case (AB1565 only)
 - Fixed an issue to avoid unexpected charging current at abnormal WARM/COLD temperatures that could violate battery specifications (AB1565 only)
 - Fixed an issue of current leakage (around 10mA) when into RTC mode by long press shutdown or pressing REGEN (for AB1565 headset)
- Note:
 - LE-audio dongle project on AB1565D is not ready in this release. We will officially release it with v3.2.0.
 - Earbuds/Headset major functions on AB1568 are functional work in this release. However, they do not meet MP quality. We will officially support AB1568 with v3.2.0.

32.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- There is a known issue in multipoint scenarios:
 - LE Dongle Call + Smartphone Play Music
 - Music cannot auto resume after the call ends when smartphone music is interrupted by the call. You can only listen to music by manually operation.

33. SDK Version 3.0.0.AB1585_AB1588

33.1. Main Changes

- SDK
 - Added the common folder at the same level as mcu and dsp folders, which are referenced by both the mcu side and the dsp side.
 - Improved feature options management with simplified feature_*.mk, added usage annotations and set dependency rules to check feature option settings.
 - Refined NVkey with ID naming and definition alignment for synchronization with other Airoha chips.
 - Changed the following list which contains MTK to airoha.
 - Folder name, file name, file content
- Software features:
 - AB1585/AB1588 earbuds reference design
 - TWS, Hybrid ANC, AINR, mcsync business (multipoint),
 - AMA, Gsound, Google fast pair, MS teams, FOTA
 - AB1585 headset reference design reference design
 - Hybrid ANC, AINR, mcsync business (multipoint),
 - AMA, Gsound, Google fast pair, MS teams, FOTA,
 - Audio line-in, USB-in
 - [Add-on] LE audio CIS (32K SWB), BIS early release
 - [Add-on] AB1585D dongle
 - Enterprise application
 - Airoha Tool Kit (ATK)
 - Add AB1585 Config Tool
 - Add AB1588 Config Tool
 - Config Tool
 - New pages
 - Leakage Detection under ANC category
 - Charger Case Config
 - PMU Config
 - New setting in RF Settings page
 - PA Voltage
 - Windows UT APP
 - Support all AB158x series chips
 - Android applications and SDK
 - Support all AB158x series chips

- New pages
 - Environment Detection
- New behavior on sealing check in MMI page
 - Sealing check will play specific music
- iOS applications and SDK
 - Support AB158x all series chip
 - New option in MMI page
 - Add ED function
 - New behavior on sealing check in MMI page
 - Sealing check will play specific music
 - Improvement on adaptive FOTA
 - The speed of adaptive FOTA will increase when not busy
- Note:
 - The deprecated list in Airoha_IoT_SDK_for_158x_API_Reference_Manual.html will be removed from this version.
 - Function - bt_device_manager_get_device_mode (void)
 - Function - bt_get_gatt_server (void)
 - Macro - BT_GAP_LINK_KEY_TYPE_INVAILIDE
 - For some major changes to the SDK, we provide a script to help reduce the effort of applying new NVkey name/ID value and replacing file content/folder name/file name from MTK to Airoha. Please refer to the convert_name script under the <sdk_root>\mcu\tools\scripts\misc\SDK_enhance folder. For the script usage, please find readme.txt under the SDK_enhance folder. We recommend running the script before starting to merge code from SDK version 2.x.x to version 3.0.0.AB1585_AB1588.

33.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- [Audio tuning tool] 1mic tuning function is ready (BT mode only), 2mic and SWB do not work.

34. SDK Version 2.11.0.AB1565_AB1568

34.1. Main Changes

- Software features:
 - [add-on] Microsoft Teams application, including LE Audio TWS earbuds, LE Audio headset, LE Audio dongle and Microsoft Teams protocol.
 - Added LE Audio headset support for Teams certification, includes functionality and audio performance (headset version).
 - [add-on] Ultra Low Latency (ULL) for AB1565A/AB1565M/AB1565AM/AB1568 gaming TWS, gaming headset, and AB1565/AB1565D gaming dongle. Key features are:
 - [add-on] [ULL] Support real-time DSP parameter tuning on dongle side for NR offload project by Config Tool.
 - [common] Added Microsoft Swift Pair support.
- Bug fixes:
 - [add-on] [LE Audio] [earbuds_ref_design]
 - Fixed an issue where there may have been temporary noise on HFP call/A2DP Music during a dongle link loss scenario.
- Note:
 - Changed USB dongle default setting as below for better compatibility:
 - Changed two audio devices to single audio device.
 - Changed high speed to full speed.

34.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- [add-on] [LE Audio] [earbuds_ref_design] There are several known issues in multipoint scenarios:
 1. LE Audio + LE Audio
 - Each earbud may be occupied by different LE Audio sources when rapidly switching between two LE Audio sources.
 2. LE Audio Call + EDR Call
 - Earbuds cannot handle call operation when there are two calls from each audio source in a multipoint scenario.

34.3. Migration

Migrate the following module-based applications when upgrading the SDK from version 2.10.1.AB1565_AB1568 to version 2.11.0.AB1565_AB1568:

34.3.1. Example project – earbuds_ref_design

1) API changes for LE AUDIO set volume and call control.

- How to migrate:

Please follow the files change list in Table 34-1 Files Change List.

Table 34-1. Files Change List

API or Event Handle or Enum Structure in SDK_V2.10.1	API or Event Handle or Enum Structure in SDK_V2.11.0	Files and Function
le_audio_stream_type_t;	bt_sink_srv_le_stream_type_t (Need to include header file: bt_sink_srv_le_volume.h)	app_hfp_idle_activity.c ● app_hfp_idle_proc_aws_data() ● Replace LE_AUDIO_STREAM_TYPE_IN with BT_SINK_SRV_LE_STREAM_TYPE_OUT
		app_hfp_utils.c ● app_hfp_mute_mic() ● Replace LE_AUDIO_STREAM_TYPE_IN with BT_SINK_SRV_LE_STREAM_TYPE_OUT
		app_home_screen_idle_activity.c ● _tile_trigger_classic_bt_power_off_flow() ● _trigger_power_off_flow() ● homescreen_app_bt_connection_manager_event_proc()
		app_le_audio_bis_activity.c ● app_le_audio_bis_mute()
		app_smcharger_utils.c ● app_smcharger_mute_audio()
le_audio_set_mute(le_audio_stream_type_t type, bool mute)	bt_sink_srv_le_volume_set_mute(bt_sink_srv_le_stream_type_t type, bool mute)	app_hfp_idle_activity.c ● app_hfp_idle_proc_aws_data()
		app_hfp_utils.c ● app_hfp_mute_mic()
		app_home_screen_idle_activity.c ● _tile_trigger_classic_bt_power_off_flow() ● _trigger_power_off_flow() ● homescreen_app_bt_connection_manager_event_proc()
		app_le_audio_bis_activity.c ● app_le_audio_bis_mute()
		app_smcharger_utils.c ● app_smcharger_mute_audio()
BLE_VCS_VOLUME_STEP	BT_SINK_LE_VOLUME_VALUE_STEP (Need to include header file: bt_sink_srv_le_volume.h)	bt_app_common_at_cmd.c ● bt_app_comm_at_cmd_le_audio_volume_hdl()

API or Event Handle or Enum Structure in SDK_V2.10.1	API or Event Handle or Enum Structure in SDK_V2.11.0	Files and Function
ble_ccp_call_control_point_t	ble_tbs_call_control_point_t	bt_app_common_at_cmd.c <ul style="list-style-type: none">● bt_app_comm_at_cmd_le_audio_call_hdl()

35. SDK Version 2.10.1.AB1565_AB1568

35.1. Main Changes

- Bug fixes:
 - [add-on] Microsoft Teams application, including LE Audio TWS earbuds, LE Audio dongle and Microsoft Teams protocol.
 - Fixed an issue where the uplink audio latency was too long during a call over the LE link.

36. SDK Version 2.10.0.AB1565_AB1568

36.1. Main Changes

- Software features:
 - [add-on] Microsoft Teams application, including LE Audio TWS earbuds, LE Audio dongle and Microsoft Teams protocol.
 - Ready for Teams certification, includes functionality and audio performance (headset version).
 - [add-on] Ultra Low Latency (ULL) for AB1565A/AB1565M/AB1565AM/AB1568 gaming TWS, gaming headset, and AB1565/AB1565D gaming dongle. Key features are:
 - Support AINR on 1565M
 - Support AINR offload to dongle (for 1-mic only)
 - Support gaming mode switch
 - Dual chip mixing mode
 - Added multiple voice assistant (AMA and GSound) switch mechanism

36.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- [add-on] [LE Audio] [earbuds_ref_design] There are several known issues in multipoint scenarios:
 - LE Audio + LE Audio
 - Each earbud may be occupied by different LE Audio sources when rapidly switching between two LE Audio sources.
 - LE Audio Call + EDR Call
 - Earbuds cannot handle call operation when there are two calls from each audio source in a multipoint scenario.
 - There may be temporary noise on HFP call/A2DP Music during a dongle link loss scenario.
- [add-on] [ULL] [earbuds_ref_design]
 - If your project has NR offload to dongle, you must manually reset the dongle to apply any DSP tuning parameters after they are set by Config Tool.

36.3. Migration

Migrate the following module-based applications when upgrading the SDK from version 2.9.0.ULL_TWS_Headset to version 2.10.0.AB1565_AB1568:

36.3.1. Example project – headset_ref_design

- Update the audio source control API and type definition.
 - Replace the following files with the ones in the latest SDK.

- mcu\project\ab1565_ab1568_evk\apps\headset_ref_design\src\apps\app_ama*.c
- mcu\project\ab1565_ab1568_evk\apps\headset_ref_design\inc\apps\app_ama*.h
- mcu\project\ab1565_ab1568_evk\apps\headset_ref_design\src\apps\app_line_in*.c
- mcu\project\ab1565_ab1568_evk\apps\headset_ref_design\src\apps\app_usb_audio*.c
- mcu\project\ab1565_ab1568_evk\apps\headset_ref_design\inc\apps\app_usb_audio*.h

37. SDK Version 2.9.0.ULL_TWS_Headset

37.1. Main Changes

- Software features:
 - [add-on] Ultra Low Latency (ULL) for AB1565A/AB1565M/AB1565AM/AB1568 gaming TWS, gaming headset, and AB1565/AB1565D gaming dongle. Key features are:
 - Support Xbox (hybrid wireless headset with ULL dongle)
 - Support dongle and A2DP standby mode
 - Support sidetone gain control via Windows app
 - Support silence detection for auto power off or external amplifier control
 - Dual chip mixing mode
 - Support 1-mic/2-mic AINR
 - Support 4-mic NR DSP framework (without NR algorithm)
 - Support ULL/BT/line-in mixing
- Note:
 - Xbox is not supported on AB1565A based TWS and headset

37.2. Migration

Migrate the following module-based applications when upgrading the SDK from version 2.8.0.AB1565_AB1568 to version 2.9.0.ULL_TWS_Headset:

37.2.1. Example project – earbuds_ref_design & headset_ref_design

- Remove NVKEYID_DSP_PARA_TX_FIR_EQ_BOOMIC, and add NVKEYID_DSP_PARA_NB_TX_FIR_EQ_BOOMIC and NVKEYID_DSP_PARA_WB_TX_FIR_EQ_BOOMIC
 - How to migrate:
 - Modify the following content in inc/nvdm_config_factory_reset.h in the project folder.
 - Remove NVKEYID_DSP_PARA_TX_FIR_EQ_BOOMIC
 - Add NVKEYID_DSP_PARA_NB_TX_FIR_EQ_BOOMIC and NVKEYID_DSP_PARA_WB_TX_FIR_EQ_BOOMIC
 - Add 0xE198 item to config_bin/{board_type}/nvkey.xml
 - Can copy the content of 0xE197 for 0xE198 item

38. SDK Version 2.8.0.AB1565_AB1568

This SDK release is NOT for TWS earbuds and headset (single chip) with the ULL features.

Please do not apply the package to it.

38.1. Main Changes

- Software features:
 - [add-on] Added enterprise applications support
 - LE Audio TWS earbuds
 - Support role UMR (Unicast Media Receiver), CT (Call Terminal) and BMR (Broadcast Media Receiver).
 - Support multipoint with LE Audio or Classic Audio.
 - This feature is only tested with LE Audio dongle and MTK smartphone.
 - LE Audio dongle
 - Support role UMS (Unicast Media Sender), CG (Call Gateway) and BMS (Broadcast Media Sender) when LE Audio feature is enabled.
 - Microsoft Teams protocol
 - Teams invocation, Teams notification and call control (answer, end, reject)
 - CFU (Component Firmware Update)
 - Added speaker reference design
 - Support MCSync broadcast speaker
 - Added dual chip mixing mode
 - Added support for more audio formats with the voice prompt
 - Support WAV format
 - Support OPUS format
 - Airoha Tool Kit (ATK)
 - Config tool
 - New settings on the Audio_HWIO page
 - pure line-in config
 - I2S sampling rate
 - New pages
 - USB settings
 - FOTA package tool
 - Support CFU bin file generation
 - Windows App
 - New pages

- DFU
- PEQ
- MMI
- KEY_ACTION
- HANDLE_PHONE
- GAME/CHAT VOLUME BALANCE
- Bug fixes:
 - Fixed the following three issues that occurred when a Bluetooth headset connected to Nintendo Switch with firmware V13.1.0:
 1. The headset may have had sound glitches when playing music on Nintendo Switch.
 2. The headset may have become silent after reconnecting after power off then power on.
 3. The headset may have become silent after link loss and reconnecting to Nintendo Switch.
- Note:
 - This version of the SDK does not include the following Microsoft Teams features:
 - Supported for call hold/unhold and multiple HID devices (transferring calls to a different Microsoft Teams device).
 - Microsoft Teams on Mac is not fully tested in this version of the SDK and it is necessary to modify the default value of the USB VID/PID/manufacture string to make it work because Microsoft Teams on Mac checks these settings.

38.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- [add-on] [LE Audio] [earbuds_ref_design] There are several known issues related to the dongle in multipoint scenarios:
 1. Earbuds cannot hang up on a classic call when connected via LE Audio.
 2. Earbuds are easily disconnected from an LE Audio dongle when performing a classic audio outgoing call.
 3. Earbuds cannot accept, reject or terminate a call with the 1st LE Audio dongle after reconnecting to a 2nd LE Audio dongle.
- [add-on] [LE Audio] [dongle_ref_design] Uplink voice becomes distorted if user modifies the LE Audio dongle microphone sampling rate on the PC during a call.

38.3. Migration

Migrate the following module-based applications when upgrading the SDK from version 2.7.1.ULL_TWS_Headset to version 2.8.0.AB1565_AB1568:

38.3.1. Example project – earbuds_ref_design & headset_ref_design

- Refine API `bt_status_t bt_cm_set_max_connection_number(uint8_t number, bt_bd_addr_t *keep_list, uint8_t list_size)` in `bt_connection_manager_internal.h`.

- How to migrate:
- Find the file <project>/src/apps/app_idle/app_bt_emp_service.c, and modify the parameter of bt_cm_set_max_connection_number. The API now is bt_status_t bt_cm_set_max_connection_number(uint8_t number, bt_bd_addr_t *keep_list, uint8_t list_size, bool if_recon).
- **if_recon** set to true means you want to reconnect the smart phone, otherwise set false.
- Refine API void race_dsprealtime_anc_adaptive_response(bool success, bool enable) in race_cmd_dsprealtime.h
- How to migrate:
- Find the file <project>/src/apps/app_adaptive_anc/app_adaptive_anc_idle_activity.c, and modify the parameter of race_dsprealtime_anc_adaptive_response. The API now is void race_dsprealtime_anc_adaptive_response(bool success, bool enable).
- **enable**: set to true means this response corresponds to starting user trigger, otherwise is canceling user trigger.
- Remove unused mp3 codec task in task_def.c
- How to migrate:
- Delete the related code of 'mp3_codec_task_main' in the file 'task_def.c'. The file path is <project_name>/src/task_def.c.
- Delete code:
- Line 108: extern void mp3_codec_task_main(void *arg);
- Line 125: { mp3_codec_task_main, MP3_CODEC_TASK_NAME, MP3_CODEC_TASK_STACKSIZE, NULL, MP3_CODEC_TASK_PRIO},
- Refine bt_sink_srv_am_result_t am_audio_side_tone_set_volume(int32_t side_tone_gain) and int32_t am_audio_side_tone_get_volume(void); SDK APIs in bt_sink_srv_ami.h
- How to migrate:
- Find the file <project>/src/apps/app_hfp/app_hfp_idle_activity.c, and rename the API to bt_sink_srv_am_result_t am_audio_side_tone_set_volume_by_scenario(sidetone_scenario_t scenario, int32_t side_tone_gain) and int32_t am_audio_side_tone_get_volume_by_scenario(sidetone_scenario_t scenario);.
- **[only for earbuds_ref_design]** Remove unused volume offset control service (VOCS)
- How to migrate:
 1. Delete &ble_vocs_service_channel_2 in bt_if_leaudio_gatt_server of the file earbuds_ref_design/src/bt_app_utility/gatt_service.c.

- **[only for earbuds_ref_design]** Refine `bt_status_t ble_csis_get_psri(uint8_t *psri)` SDK API in `ble_csis.h`
- How to migrate:
 1. Find the file `earbuds_ref_design\src\apps\app_le_audio\app_le_audio.c`, and rename the API to `bt_status_t ble_csis_get_rsi(uint8_t *rsi)` in the function `app_le_audio_get_adv_data`.

39. SDK Version 2.7.1.ULL_TWS_Headset

39.1. Main Changes

- Software features:
 - [add-on] [ULL] [dongle_ref_design] Support USB features for USB 2.0 certification, including USB suspend/resume, low power optimization, compliance tool check and other related changes.
- Bug fixes:
 - [common] Fixed an issue where headset/earbuds could not detect a charger out event after VBUS plug-out.
 - [earbuds_ref_design] Fixed an issue where earbuds crashed after factory reset.

40. SDK Version 2.7.0.ULL_TWS_Headset

40.1. Main Changes

- Software features:
 - [add-on] Ultra Low Latency (ULL) for AB1565A/AB1565AM gaming TWS, AB1568 gaming headset, and AB1565/AB1565D gaming dongle. Key features are:
 - Support dongle and HFP standby mode for TWS earbuds
 - Support THD+N performance improvement for uplink voice
 - Support TWS RF performance improvement
 - Support dongle OTA for headset
 - Support logging via USB HID
 - Support media control (play/pause/backward/forward/microphone mute) for PC application
 - Support call control commands (answer/end/reject) on PC side
 - Support individual left/right gain setting for headset
 - Support for automatically reducing the volume of game audio when chat audio is present
 - [GSound] remove iOS features
 - [Language model generator] No need to configure the address and length of the flash partition for the language model. Language model generator will read the configuration from the Id file and parse the related flash partition information (address and length) from Id file. But please make sure that the partition name in the configure file is matched with the Id file.
 - Means if the language model name in the Id file is ROM_LM, then the partition name of config.xml file also should be ROM_LM.
- Note:
 - The 1-Wire Logging tool only supports UART board with 1.8v VCCIO and 2M baud rate.

40.2. Migration

Migrate the following module-based applications when upgrading the SDK from version 2.6.1.ULL_TWS_Headset to version 2.7.0.ULL_TWS_Headset:

40.2.1. Example project – earbuds_ref_design with ULL

- 1) Removed unsupported iOS features for GSound in app layer.
- How to migrate:
 - Replace the following files with the ones in the latest SDK.

```
mcu\<project>\src\apps\app_gsound\app_gsound_multi_va.c
mcu\<project>\src\apps\app_gsound\app_gsound_service.c
mcu\<project>\src\bt_app_utility\ble_ancs_ios_notification\ble_ancs_app.c
mcu\<project>\src\bt_app_utility\ble_ancs_ios_notification\ble_ancs_common.c
mcu\<project>\src\bt_app_utility\gatt_service.c
```


2) Change configuration for the language model generator.

- How to migrate:

- Copy the following code and insert it into the Makefile of the project.

```
#####
# Transfer the feature option to the LM generator
# Check AMA and AMA WWE enabled or not
AMA_WWE_ENABLED = n
GVA_HOTWORD_ENABLED = n
ifeq ($(MTK_AMA_ENABLE)_$(AMA_TRIGGER_MODE_WWD_ENABLE),y_y)
AMA_WWE_ENABLED = y
endif
# Check GVA and GVA Hotword enabled or not
ifeq
$(G SOUND_LIBRARY_ENABLE)_$(G SOUND_HOTWORD_ENABLE),y_y)
GVA_HOTWORD_ENABLED = y
endif
#####
```

- Add the parameter of ld file and feature option for the language model generator to generate the language model binary file.

- Search for the following text in the Makefile of the project.

```
$(SOURCE_DIR)/$(LM_BIN_GENERATOR) -i
$(CONFIG_BIN_PATH)/language_model/config.xml -o $(OUTPATH)
```

- And replace it with the following:

```
$(SOURCE_DIR)/$(LM_BIN_GENERATOR) -i
$(CONFIG_BIN_PATH)/language_model/config.xml -o $(OUTPATH)
-l $(LINKER_SCRIPT_FILE) -a $(AMA_WWE_ENABLED) -g
$(GVA_HOTWORD_ENABLED); \
```

- Re-configure the config.xml.

Refer to the main changes for language model generator. The partition name in the file must be configured: earbuds_ref_design/config_bin/ab1565_evk/language_model/config.xml to be ROM_LM as below:

```
<partition name="ROM_LM">
```

Note: It is no longer necessary to configure the address and length.

41. SDK Version 2.6.1.ULL_TWS_Headset

This SDK release is only for TWS earbuds and headset with the ULL feature.

Please do not apply the package to earbuds/headset without the ULL feature.

41.1. Main Changes

- Bug fixes:
 - [add-on] [ULL] [headset_ref_design] Fixed an issue where the uplink audio was sometimes distorted during a call over the ULL link.
 - [add-on] [ULL] [headset_ref_design][earbuds_ref_design] Fixed an issue where there was sometimes no sound during music playback over the ULL link.
- Note:
 - Please note that to resolve the issue with the distorted uplink audio, the system adds an additional 2mA of current during game audio and chat audio scenarios.
 - The statement “[add-on] [ULL] [headset_ref_design] Add approximately 1mA current for game audio and chat audio scenarios” is a known issue carried over from version 2.6.0. It is caused by the AFH function on the Headset side and it is now considered reasonable and no longer an issue with this release.

42. SDK Version 2.6.0.ULL_TWS_Headset

This SDK release is only for TWS earbuds and headset with the ULL feature.

Please do not apply the package to earbuds/headset without the ULL feature.

42.1. Main Changes

- Software features:
 - [add-on] Ultra Low Latency (ULL) for AB1565A/AB1565AM gaming TWS, AB1568 gaming headset, and AB1565/AB1565D gaming dongle. Key features are:
 - Support AINR premium (official version) with AB1565AM and AB1568
 - Support Low latency data transmission for uplink
 - Support AB1565D for gaming dongle
 - Support dongle and HFP/A2DP standby mode
- Bug fixes:
 - [add-on] [ULL] [headset_ref_design] [earbuds_ref_design] Fixed an issue where there was a bad uplink sound after a long call.
 - [add-on] [ULL] [headset_ref_design] [earbuds_ref_design] Fixed an issue where there was sometimes noise when playing music after ending a voice recording.
 - [add-on] [ULL] [headset_ref_design] [earbuds_ref_design] Fixed an issue where there was sometimes no sound when playing music after ending a voice recording.
- Note:
 - There is an error in version 2.5.0 of the Release Notes. The statement “[add-on] Ultra Low Latency (ULL) for AB1565A/AB1565AM gaming and headset dongle” should say AB1568 gaming headset and AB1565 dongle. That is “[add-on] Ultra Low Latency (ULL) for AB1568 gaming headset and AB1565 dongle.

42.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- [add-on] [ULL] [headset_ref_design] Add approximately 1mA current for game audio and chat audio scenarios.
- [add-on] [ULL] [headset_ref_design] On rare occasions, the uplink sounds distorted during a call over the ULL link.

43. SDK Version 2.5.1.AB1565_AB1568

43.1. Main Changes

- Bug fixes:
 - [Common] Bluetooth stack of earbuds and headset projects (with or without ULL) may overflow when a smart phone tries to connect GSound and LE audio. This issue only occurs when the AMA features are disabled in the project.
 - [add-on] [dongle_ref_design] Fixed an issue where FOTA is always disabled in ULL dongle_ref_design project.

44. SDK Version 2.5.0.AB1565_AB1568

44.1. Main Changes

- Software features:
 - [add-on] Ultra Low Latency (ULL) for AB1565A/AB1565AM gaming headset and dongle. Key features are:
 - <20 ms latency audio downlink with a well-matched dongle (latency measurement: dongle received -> headset audio output)
 - Game audio and chat audio volume balance
 - Dongle/HPF standby mode
 - Support for USB HID (only in/out report)
 - USB FW update for dongle and headset
 - Support for USB HID feature report (new for version 2.5.0)
 - Line-in/out with A2DP/HFP mixing (new for version 2.5.0)
 - USB-in/out with A2DP/HFP mixing (new for version 2.5.0)
 - AINR premium (demo version, new for version 2.5.0)
 - The limitation for the AINR demo version “Before 1 min”/“After 30 min” is no sound for uplink (dongle, HFP, AUX, and USB).
 - Support machine learning NR that can identify unwanted noise from speech.
 - Enhance uplink SNR
 - AB1565/AB1568 earbuds and headset
 - MCSync business (multipoint) - connection behavior changed
 - Added wind noise detection (WND) for ANC. To improve user experience of ANC/passthrough, it can detect and suppress the noise caused by strong wind when ANC/passthrough is enabled.
 - [add-on] Added LE Audio CIS music
 - This feature is only tested with AB1565M source platform and MTK smartphone.
 - Sink API is ready. But it may be changed because the final LE Audio specification has not been adopted.
 - Added API to turn on/off LE Audio feature. It will cause a disconnection when this feature is disabled when LE Audio link is connected.
 - Airoha Tool Kit (ATK)
 - Config tool
 - New settings on the Audio_Volume page
 - Line-in/USB-in ratio
 - DSP_PARA_AUDIO_VOLUME_2.gain3_sample_per_step
 - New pages
 - General purpose software gain settings

- USB_IN_Level_Settings
 - USB/Line_OUT_Level_Settings
 - FOTA package tool
 - New header info in FOTA bin
 - Chip name and device type
 - Android applications and SDK
 - New page
 - LE Audio UT
 - LE Audio On/Off
- Bug fixes:
 - [FreeRTOS security hole] Fixed the integer overflow or wraparound issue in memory management API functions (MemMang, Queue, Streambuffer).
 - [SDK v2.4.0.ULL_TWS known issue] [Android applications] Fixed an issue where the online log was sometimes abnormal after the force system assert.
 - [SDK v2.4.0.ULL_TWS known issue] Fixed an issue where volume change did not work for Sony PlayStation 4/5.
 - [SDK v2.4.0.ULL_TWS known issue] Fixed an issue where there was no connected voice prompt in L channel after connecting dongle (seldom).
 - [SDK v2.4.0.ULL_TWS known issue] Fixed an issue where there sometimes was no voice prompt when disconnecting and reconnecting from a smartphone.
 - [SDK v2.4.0.ULL_TWS known issue] Fixed an issue where the PEQ setting did not operate as expected by using the button to switch PEQ.
 - [Common] Fixed an issue where there was an error when MUX BT was sending data.
 - [Common] Fixed an issue where the RF tester could not connect with DUT after entering the DUT mix mode.
 - [MCSync business (multipoint)] Fixed an issue that set highlight device or codec error after RHO.
- Note:
 - The AB1568 does not support one-wire UART in this release.
 - This SDK release does not include the AB1565A/AB1565AM ULL gaming TWS project.
 - Since the final LE Audio specification is not yet adopted, the SDK APIs provided in this release are a draft version. Please be aware that changes may occur in future when the LE Audio specification is officially announced.

44.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- MCSync business (multipoint) has the following issues if one of BT source devices is the Teams APP on PC or laptop. The major reason is that the PC/laptop usually does not inform the clients of the changing call state and the Teams APP uses A2DP to play the incoming ring tone on many PC/laptop OSs. For example:
 - Smartphone music does not automatically resume playing after PC's Teams call has ended.

- Smartphone incoming ringtone and audio cannot be heard when Teams is making an ongoing call on PC.
- Smartphone incoming call ringtone can still be heard when Teams is receiving an incoming call on PC.

44.3. Migration

Migrate the following module-based applications when upgrading the SDK from version 2.3.1.AB1565_AB1568 to version 2.5.0.AB1565_AB1568:

44.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Remove unused header file “bt_sink_srv_gsound.h”
 - How to migrate:
 - Remove the header file reference in project
- 2) Initialize the firmware_revision of the structure bt_fast_pair_init_parameters_t when calling bt_fast_pair_init()
 - How to migrate:
 - Find the function “app_fast_pair_init” in
<project>\src\apps\app_fast_pair\app_fast_pair_idle_activity.c, and find the line
“bt_fast_pair_init_parameters_t init_param;”
 - Add the content “memset(&init_param, 0, sizeof(init_param));” below the line which
you find in last step.

45. SDK Version 2.4.0.ULL_TWS

This SDK release is only for TWS earbuds with the ULL feature.

Please do not apply the package to earbuds without ULL feature.

Earbuds feature.mk with ULL feature

- feature_65_8m_cell_ull.mk
- feature_65_8m_evk_ull.mk
- feature_65_evk_ull_va.mk
- feature_65_evk_ull_xiaowei.mk
- feature_65_evk_ull.mk
- feature_68_evk_ull.mk

45.1. Main Changes

- Software features:
 - [add-on] Ultra Low Latency (ULL) for AB1565 gaming dongle and AB1568 earbuds (TWS)
 - [Earbuds] Support ULL for dongle and earbud connections
 - [Dongle] USB FW update
 - [Dongle] Set real time PEQ to Earbuds via Dongle
- Note:
 - RF performance for distance and interference environment is under improvement.

45.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- [Android applications] The online log may be abnormal after the force system assert.
 - Recovery Method: Exit APP and open again if you cannot set log config.
- Volume change does not work for Sony PlayStation 4/5.
- No connected voice prompt in L channel after connecting dongle (seldom).
- No voice prompt when disconnect and reconnect from smartphone (seldom).
- The PEQ setting does not operate as expected by using Earbuds button to switch PEQ.

46. SDK Version 2.3.1.AB1565_AB1568

46.1. Main Changes

- Bug fixes:
 - [Common] Fixed an issue where the system would power off during the RF performance test.
 - [Common] Fixed an issue where there was approximately 3.5mA current leakage of BT RF from earbuds that were fully charged and in the charging case.
 - [Common] Fixed an issue where the system would crash after speaker link loss and reconnect to eSCO.
 - [Common] Fixed an issue where there was no sound during the A2DP SBC streaming test.
 - [Common] Fixed an issue where the system would hang, possibly under the BT sniff or system idle scenario.
 - [Common] Fixed an issue that would probably cause the USB module to violate the USB standard.
 - [Common] Fixed an issue in the Over Current Protection (OCP) flow to avoid an unexpected system shutdown under charge mode.
 - [Common] Fixed an issue to avoid unstable charger current and then impact battery life when the system would wake up from RTC mode.
 - [Common] Fixed an issue where earbuds could not boot-up under charge mode if the battery was under 3.2v.

47. SDK Version 2.3.0.AB1565_AB1568

47.1. Main Changes

- Software features:
 - AB1565/AB1568 earbuds and headset
 - MCSync business (multipoint)
 - Added support RHO when connected with two speakers at the same time in earbuds.
 - Added support take over. It allows the new link to take over the idle link as the rule.
 - Added personal wearing adaptive ANC for earbuds. It detect the personal wearing condition and calculates a new ANC filter to approach the best noise cancellation performance.
 - Google fast pair characteristic UUID changed from 16-bit to 128-bit format. Refer to <https://developers.google.com/nearby/fast-pair/spec#CustomCharacteristics>
 - [add-on] Added GSound sub-feature
 - Device action
 - [add-on] Added AMA sub-features
 - Spotify control using Alexa
 - Alexa for Apps (hands-free app launch using Alexa)
 - [add-on] Added MI XiaoAI
 - Added WWE
 - Support EMP and takeover feature
 - [add-on] Added Tencent Xiaowei
 - Support Xiaowei basic features (connect/tap to talk/recognize)
 - [add-on early release] Added Ultra Low Latency (ULL) for AB1565 gaming dongle and AB1568 headset
 - ULL headset can provide < 20ms latency audio downlink with a well-matched dongle (latency measurement: dongle received -> headset audio output). It also provides a good experience with gaming and TV.
 - [Dongle] ULL USB game chat/music (USB audio: 1Rx + 1Tx)
 - [Headset] Line-in
 - [Headset] 1 USB audio
 - [add-on early release] Added LE Audio for earbuds reference design
 - LE Audio supports two roles defined in telephony and media audio profile (TMAP).
 - Call Terminal (CT)
 - Unicast Media Receiver (UMR)
 - Airoha Tool Kit (ATK)
 - Config tool

- New options in digital output gain tables
 - Mute(-120dB) and -80.5dB
- New settings in Audio_HW/IO_Config page
 - Line-in filter and IIR HPF
- New pages
 - VAD_Tuning
- Android/iOS applications and SDK
 - Improved active FOTA speed
 - New settings in MMI UT page and SDK
 - Auto play pause (in ear detection)
 - Auto power off
 - New options in key action UT page and SDK
 - Voice assistant: Xiaowei AI
 - Single click: Share_Mode_Switch, Share_Mode_Follower_Switch
- Bug fixes:
 - [Common] Modified the NVDM driver to avoid the problem of device constantly restarting due to race conditions in the user's code.
 - [MCSync business (multipoint)] Fixed an issue where the user could not hear AMA/GSound's voice response correctly while playing music and when two smartphones were connected to the same earbuds/headset.
 - [MCSync business (multipoint)] Fixed an issue where the second connected smartphone could not activate AMA correctly.
 - [MCSync business (multipoint)] Fixed an issue where switching devices could result in a double Agent and crash.
 - [MCSync] Fixed a seldom link-disconnecting crash issue.
 - [MCSync] Improved MCSync connection stability.
 - [MCSync] Fixed an issue where Partner power on might not play music when Agent plays music for more than 30 minutes.
 - [MCSync] Fixed a seldom issue where the Partner with BLE link would crash during RHO.
 - [Music Sharing] Fixed an issue where Partner could not play/pause after receiving or ending a call.
 - [Music Sharing] Fixed an issue where Partner could not receive the call state when the Follower was attached.
 - [Earbuds] Fixed a seldom music playing issue that occurred when earbuds were quickly put in or taken out of the charger case.
 - [Earbuds with one-wire UART] Fixed some seldom issues to enhance the stability of the one-wire charging case interaction with earbuds.
 - [Voice assistant] Fixed some seldom issues that incorrectly set the voice assistant state when triggering voice recognition during A2DP streaming.
- Note:

- LE Audio can co-exist with classic audio but cannot support RHO and role recovery in this release.
- Because the feature_65_8m_cell.mk is created, the feature_65_cell.mk is removed. If you used the feature_65_cell.mk as your base project, you can now refer to feature_65_8m_cell.mk.
- Removed the bsp_external_flash header file from the list of generated SDK files. Added Flash-related capacity and the starting address information of each flash type to the bsp_flash header file. It is recommended that users use bsp_flash uniformly.
- The following new features for Tencent VA - Xiaowei do not reach the MP quality: connect control, device control (only support ANC), custom skill, exchange serial number, RHO without disconnect, and support EMP.

47.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- For the firmware with 1Wire UART function, MP Tool cannot be executed normally when the PCBA is connected with the battery.
- For the product using AB1565/AB1568 built-in captouch and Class D amp, the captouch signal may be disturbed while playing music.
- For XiaoAI multi-point case, because XiaoAI APP does not notify the device of the session status, one speaker with the XiaoAI connection cannot voice reply normally when another speaker is playing music.
- When earbuds connected to two smart phones (EMP feature) and both phones are in call state, the earbuds may hear a false “disconnected” voice prompt. Then, if the BT connection is switched to the other phone, one earbud becomes silent.
- For Xiaowei:
 - When connecting Xiaowei with Pixel 4 (Android 11), after turning off the BT of Pixel 4, there are issues that cause the Xiaowei SPP link to not disconnect:
 - Cannot hear the “disconnected” voice prompt; and
 - Cannot connect to another smartphone.
 - When connected with an iPhone and playing music with a 3rd-party music application and then pausing it, the music will automatically play when the Xiaowei response is complete.
 - This is because the Xiaowei APP sends the resume command to request the device to send the AVRCP command with the play action to the iPhone.

47.3. Migration

Migrate the following module-based applications when upgrading the SDK from version 2.2.1.AB1565_AB1568 to version 2.3.0.AB1565_AB1568:

47.3.1. Example project – earbuds_ref_design & headset_ref_design

- 1) Refine BT device manager power SDK APIs in bt_device_manager_power.h.
 - How to migrate:
 - Please find BT device manager power related API/event/macro in Table 47-1. Files Change List, do search in column SDK Version 2.2.1.AB1565_AB1568 and replace the mapping one in column SDK Version 2.3.0.AB1565_AB1568.

Table 47-1. Files Change List

SDK Version 2.2.1.AB1565_AB1568	SDK Version 2.3.0.AB1565_AB1568
BT_DEVICE_TYPE_BLE	BT_DEVICE_TYPE_LE
BT_DM_EVT_POWER_PREPARE_ACTIVE	BT_DEVICE_MANAGER_POWER_EVT_PREPARE_ACTIVE
BT_DM_EVT_POWER_PREPARE_STANDBY	BT_DEVICE_MANAGER_POWER_EVT_PREPARE_STANDBY
BT_DM_EVT_POWER_ACTIVE_COMPLETE	BT_DEVICE_MANAGER_POWER_EVT_ACTIVE_COMPLETE
BT_DM_EVT_POWER_STANDBY_COMPLETE	BT_DEVICE_MANAGER_POWER_EVT_STANDBY_COMPLETE
bt_dm_event_t	bt_device_manager_power_event_t
bt_dm_callback_t	bt_device_manager_power_callback_t
BT_DM_POWER_RESET_PROGRESS_MEDIUM	BT_DEVICE_MANAGER_POWER_RESET_PROGRESS_MEDIUM
BT_DM_POWER_RESET_PROGRESS_COMPLETE	BT_DEVICE_MANAGER_POWER_RESET_PROGRESS_COMPLETE
bt_dm_power_reset_progress_t	bt_device_manager_power_reset_progress_t
bt_dm_power_reset_callback_t	bt_device_manager_power_reset_callback_t
BT_DM_POWER_STATE_OFF	BT_DEVICE_MANAGER_POWER_STATE_STANDBY
BT_DM_POWER_STATE_OFF_PENDING	BT_DEVICE_MANAGER_POWER_STATE_STANDBY_PENDING
BT_DM_POWER_STATE_ON	BT_DEVICE_MANAGER_POWER_STATE_ACTIVE
BT_DM_POWER_STATE_ON_PENDING	BT_DEVICE_MANAGER_POWER_STATE_ACTIVE_PENDING
BT_DM_POWER_STATE_RESTING	BT_DEVICE_MANAGER_POWER_STATE_RESTING
bt_dm_power_state_t	bt_device_manager_power_state_t
bt_dm_dev_set_power_state()	bt_device_manager_dev_set_power_state()
bt_dm_dev_register_callback ()	bt_device_manager_dev_register_callback ()
bt_dm_register_callback()	bt_device_manager_register_callback()
bt_dm_deregister_callback ()	bt_device_manager_deregister_callback ()
bt_dm_power_active()	bt_device_manager_power_active()
bt_dm_power_standby()	bt_device_manager_power_standby()
bt_dm_power_reset()	bt_device_manager_power_reset()
bt_dm_power_set_hold_mode()	Delete
bt_dm_power_get_power_state()	bt_device_manager_power_get_power_state()

2) AMA language model management and specification change.

- How to migrate:
 - Copy folder
mcu\project\ab1565_ab1568_evk\apps\xxxxx_ref_design\src\apps\app_ama and
mcu\project\ab1565_ab1568_evk\apps\xxxxx_ref_design\inc\apps\app_ama from the
new SDK and use it to replace the old SDK folder.

- Add the follow lines to the feature.mk of project.

```
AMA_TRIGGER_MODE_TTT_ENABLE = y
AMA_TRIGGER_MODE_PTT_ENABLE = y
AMA_TRIGGER_MODE_WWD_ENABLE = y
```

- Add the following lines to

mcu\project\ab1565_ab1568_evk\apps\xxxxx_ref_design\src\apps\module.mk.

```
ifeq ($(AMA_IAP2_SUPPORT_ENABLE), y)
CFLAGS += -DAMA_IAP2_SUPPORT_ENABLE
endif
ifeq ($(AMA_IAP2_APP_RELAY_ENABLE), y)
CFLAGS += -DAMA_IAP2_APP_RELAY_ENABLE
endif
ifeq ($(AMA_IAP2_VIA_MUX_ENABLE), y)
CFLAGS += -DAMA_IAP2_VIA_MUX_ENABLE
endif
ifeq ($(AMA_TRIGGER_MODE_TTT_ENABLE), y)
CFLAGS += -DAMA_TRIGGER_MODE_TTT_ENABLE
endif
ifeq ($(AMA_TRIGGER_MODE_PTT_ENABLE), y)
CFLAGS += -DAMA_TRIGGER_MODE_PTT_ENABLE
endif
ifeq ($(AMA_TRIGGER_MODE_WWD_ENABLE), y)
CFLAGS += -DAMA_TRIGGER_MODE_WWD_ENABLE
endif
```

- Delete the following lines in

mcu\project\ab1565_ab1568_evk\apps\xxxxx_ref_design\src\apps\app_ama_activity.c

```
#include "app_bt_takeover_service.h"
app_bt_takeover_service_user_register(APP_BT_TAKEOVER_ID_AM
A, app_ama_bt_takeover_handler);
```

- Delete the code in macro MTK_AMA_ENABLE of

mcu\project\ab1565_ab1568_evk\apps\xxxxx_ref_design\src\apps\events\apps_events
_bt_event.c.

3) Replace assert function by Airoha customized configASSERT().

- How to migrate:

Please mask or remove the following lines in

mcu\project\ ab1565_ab1568_evk\apps\xxxxx_ref_design\inc\FreeRTOSConfig.h

```
// #include "assert.h"
// extern void abort(void);
```

4) API changes for information in usbaudio_drv.h.

- How to migrate:

Please add the default value “0” for the new variable, port, when using the API as shown below.

1. USB_Audio_Register_SetInterface_Callback(0, setinterface_cb)
2. USB_Audio_Register_Unplug_Callback(0, unplug_cb)
3. USB_Audio_Register_VolumeChange_Callback(0, volumechange_cb)
4. USB_Audio_Register_Mute_Callback(0, mute_cb)

48. SDK Version 2.2.1.AB1565_AB1568

48.1. Main Changes

- Bug fixes:
 - AB1565/AB1568 earbuds and headset
 - Fixed a phone call assert fail bug for earbuds and headset enabled the Airoha 2+1 NR algorithm.
 - Fixed a pass through assert fail caused by microphone input exceeding the maximum level.
 - Fixed a firmware bug to let config tool display ANC feedback microphone tuning UI correctly.
 - Revised 8M flash project memory layout to extend DSP partition. The modification did not affect the start address of any partition and it is FOTA compatible with v2.2.0.
 - Fixed a firmware bug to align CM4 and DSP with their multimic option MTK_AUDIO_SUPPORT_MULTIPLE_MICROPHONE of earbuds_ref_design/headset_ref_design project feature_65_8m_evk.mk to prevent parameter misalignment. This option must be enabled on 1565 and 1568.
 - Airoha Tool Kit (ATK)
 - Fixed a bug that ANC component gains of L channel could not be set separately with R channel.

49. SDK Version 2.2.0.AB1565_AB1568

49.1. Main Changes

- Software features:
 - Add support for 1565M and 1565AM, which have 8MB internal flash.
 - AB1565/AB1565A/AB1568/Ab1565M/AB1565AM earbuds reference design
 - MCSync share – Enable two sets of earbuds to share the music stream from one smartphone.
 - MCSync business (multipoint) – Earbuds can connect with two smartphones at the same time, and can play or manage music and calls from one of them.
 - AB1565/AB1565A/AB1568/Ab1565M/AB1565AM headset reference design
 - Multipoint – Headset can connect with two smartphones at the same time and can play or manage music and calls from one of them.
 - Airoha Tool Kit (ATK)
 - Config tool
 - New menu item: special_export
 - Export all/changed NVKeys to NVKEY_Setting.c and save bin
 - New option in export NV button
 - All_NV or Changed_NV
 - New option in compare NV button
 - Compare with bin or compare with bin + imported_nvr
 - New option in wireless tuning connection button
 - Agent, Partner, or Agent + Partner
 - New setting in Captouch page
 - Auto suspend
 - UI changed in A2DP PEQ page
 - PostPEQ buttons are changed to two buttons: ANC Off PostPEQ and ANC on PostPEQ
 - Android applications and SDK
 - New option in FOTA page
 - Adaptive FOTA
 - New option in KeyAction page
 - DLONG
 - New pages about FW debugging
 - Log config page
 - Combine offline log page and mini dump page to form the exception dump page
 - iOS applications and SDK

- Support AB155x and AB156x all series chip.
 - New option in FOTA page
 - Adaptive FOTA
 - New option in KeyAction page
 - DLONG
 - Bug fixes:
 - Resolved SBC deviation on earbuds.
 - Resolved eSCO noise issues happened after talking 3 minutes in a phone call.
 - Improved the performance of ANC fitting detection and resolved an issue where the application reported it was good when the earbuds were not correctly worn.
 - Resolved a problem where GSound was not triggered when using the smartphone application to change the default VA from Alexa to GSound.
 - Corrected the A-Mic ADC mode setting to high performance mode for AB1565 and AB1568 series chips.
 - Note:
 - AB1565/AB1565M earbuds memory layout was changed. We reorder the flash partitions to make the reserved size of cm4 and LM (language model) partition more flexible. Customer can reserve memory layout to reserve the unused LM area for CM4 using, and the result image file is still FOTA compatible with the image before revised. However, user could not upgrade firmware from v2.1.0 to v2.2.0 using default layout by FOTA. Please use the flashtool instead FOTA to upgrade 2.2.0 firmware from 2.1.0, or replace the new layout setting with old one.
 - Exception dump default configuration has changes with this version of the SDK. There are three changes:
 - Enable <Reset after dump>
 - The system will reboot after exception dump.
 - Enable <WDT configure as reset mode>
 - The system will reboot if it hangs for more than 60 seconds.
 - Disable <Mask IRQ too long>
 - Ignore abnormal cases in which the mask IRQ is too long. This is a debugging feature only.
- The customer must keep these configurations during mass production. For more details, please refer to “AB1565_AB1568_Config_Tool_Users_Guide.pdf” section 2.13.

49.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- The multipoint function enables the earbuds/headset to connect two smart phone at the same time. However, the voice assistant (GSound and Alexa) function from multiple smart phone connection may abnormal. We will fixed the issues on 2.3.0.
- Although the package includes the new features “device action” for Alexa and GSound. There are some bugs such as the result of device action did not display correctly on smart phone side. We will fix the issue on 2.3.0.

50. SDK Version 2.1.0.AB1565_AB1568

50.1. Main Changes

- Software features:
 - AB1565/AB1565A earbuds reference design
 - ANC – fit detection
 - One-wire DFU
 - Software Negative Temperature Coefficient (NTC)
 - MCSync share (early release)
 - MCSync business (early release)
 - Add AB1568 earbuds design
 - Software features are as same as AB1565A
 - Add AB1565/AB1565A/AB1568 headset reference design
 - eSco, A2DP
 - 1-mic/2-mic EC/NR
 - ANC
 - Programmable EQ (PEQ)
 - Voice prompt
 - Capacitive touch
 - Firmware-over-the-Air (FOTA)
 - Google fast pair 2.0
 - USB audio (downlink)
 - Audio line in
 - [add-on] GSound (Google Assistant device firmware implementation) / Google Hotwording
 - [add-on] Alexa Mobile Accessory (AMA) /AMA Wake Word Engine (WWE)
 - Airoha Tool Kit (ATK)
 - UartComportSetting
 - New port type: USB
 - Config Tool
 - New settings in Captouch_Settings page
 - Long press shut down/wake up time setting
 - SW debounce setting
 - New settings in Audio_HW/IO_Config page
 - VAD
 - New settings in A2DP_PEQ page

- Post PEQ
 - New pages:
 - Dual_MIC_NR
 - Line-in_Level_Settings, Gain_Settings, PEQ, DRC_&_DBB, INS
 - Modify A2DP gain page:
 - Change A2DP digital gain resolution to 0.5db per step
 - Logging Tool
 - New log filter: log CPU filter
 - FOTA Package Tool
 - New UI option for FOTA bin generation settings by selecting a .cfg file
 - New UI option for reserved NVDM item update
 - Add one wire DFU Tool
- Android applications and SDK
 - App
 - Support headset
 - Rename the “Antenna UT” page title to “Field Trial”
 - Add “Get A2DP info” in field trial page
 - SDK
 - MMI
 - New API to get/set share mode
- iOS applications and SDK
 - SDK
 - Change bundle name and framework name
 - FOTA
 - Refine progress bar percentage counting
 - MMI
 - New API to get/set share mode
- Bug fixes:
 - Resolved a reset issue that seldom occurred when using FCD to make L/R earbuds become a set.
 - Resolved an issue where a single earbud did not output the stereo channel in A2DP streaming mode.
 - Resolved Google hotwording – Long recording does not work correctly.
- Note:
 - We did not release the add-on features with the SDK official package. Please contact Airoha service team to request the add-on release.
 - Although the package includes the MCSync business/MCSync Share, the related features are not completely verified and do not yet reach the MP quality. We plan to officially release the feature in v2.2.0.

50.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- The earbuds may seldom not correctly start ANC fit detection triggered by iPhone 11 after RHO.
- [GSound] The earbuds/headset project did not completely pass BART.
 - Earbuds: The pass rate is 99% and 97% for Android and iOS respectively.
 - Headset: The pass rate is 99% and 99% for Android and iOS respectively.

The known issues are as follows:

- Google FOTA triggered by iOS devices may not recover from an interruption.
- Google hotwording
 - Some languages are not correctly triggered with a keyword.
- Using the config tool to set audio line-in PEQ parameters for the headset project is not ready.

50.3. Migration

Migrate the following module-based applications when upgrading the SDK from version 2.0.0.AB1565 to version 2.1.0.AB1565_AB1568:

50.3.1. Example project – earbuds_ref_design & headset_ref_design

- With the new release of support Software NTC, the earbuds automatically shut down when a temperature abnormal occurs.
- The feature was controlled by the NVKEY NVKEYID_NTC_NTC_PARA_CONFIG1. The default value is off in this release. Please turn on the NVKEYID_NTC_NTC_PARA_CONFIG1 if your hardware supports this feature.
- The ab1565 EVK v1.0 did not support the NTC feature by default. You can turn on the feature by reworking the EVK. Please contact the Airoha SA team for details.
- The NVKEYID_NTC_NTC_PARA_CONFIG1 setting in SDK v2.0.0.AB1565 is on. If your hardware does not support the battery detection feature such as ab1565 EVK, please change the NVKEYID_NTC_NTC_PARA_CONFIG1 to off before upgrading FW from 2.0.0.AB1565 to 2.1.0.AB1565_AB1568 by using the flash tool or FOTA.

51. SDK Version 2.0.0.AB1565

51.1. Main Changes

- Software features:
 - AB1565/AB1565A earbuds reference design
 - Multi Cast Synchronization (MCSync): It is an Airoha proprietary profile to support voice/audio over multiple Bluetooth Audio devices.
 - ANC
 - 2+1 mic EC/NR
 - Programmable EQ (PEQ)
 - Voice prompt
 - Capacitive touch
 - Firmware-over-the-Air (FOTA)
 - Google fast pair 2.0
 - [add-on] GSound (Google Assistant device firmware implementation) / Google Hotwording
 - [add-on] Alexa Mobile Accessory (AMA) /AMA Wake Word Engine (WWE)
 - Airoha Tool Kit (ATK)
 - Logging
 - Config
 - FOTA package
 - Lab test
 - OTA by dongle tool
 - Flash tool
 - Android applications and SDK
 - App
 - FOTA
 - PEQ
 - MMI
 - Antenna test
 - 2-mic Dump, Mini Dump, Online log, Offline log.
 - ANC index and gain settings.
 - ROFS update in FOTA page.
 - SDK
 - FOTA support new RHO event.
 - iOS applications and SDK

- App
 - FOTA
 - PEQ
 - MMI
 - ANC index and gain settings
 - ROFS update in FOTA page
- SDK
 - FOTA support new RHO event
- Note:
 - We did not release the add-on features with the SDK official package. Please contact Airoha service team to request the add-on release.
 - Although the package includes the AB1568 earbuds project, the related features are not completely verified and do not yet reach the MP quality. We plan to officially release AB1568 earbuds in v2.1.0.
 - Although the package includes AB1565/AB1565A headset, the related features do not satisfy the MP criteria. The headset project in the release is only for early development purpose. We plan to officially release AB1565/AB1565A headset in v2.1.0. The headset reference design includes the following features:
 - eSco, A2DP
 - 1-mic/2-mic EC/NR
 - Firmware-over-the-Air (FOTA)
 - Programmable EQ (PEQ)
 - Google fast pair 2.0
 - Audio line in
 - Although the package includes adaptive ANC – leakage detection feature, it does not satisfy the MP criteria.
 - Please go to the following folders to get the corresponding release notes for the tool.
 - ATK: <sdk_root>\mcu\tools\pc_tool\atk\ab1565_ab1568
 - Android package: <sdk_root>\mcu\tools\headset_app_android_eng\ab1565_ab1568
 - iOS package: <sdk_root>\mcu\tools\headset_app_ios_eng\ab1565_ab1568
 - EPT (Easy Pinmux Tool): Please search "Easy_Pinmux_Tool" from [here](#), then download the latest version (v2.6.7 or higher) to use.

51.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- AMA sound may seldom play on smart phone speaker rather than earbuds after switching language mode.
- [GSound] The earbuds project did not pass BART complexly. The pass rate is 94% and 96% for Android and iOS respectively. The known issues are as follows:
 - Google FOTA triggered by iOS devices may not recover from interruption.

- Google hotwording
 - Long recording does not work correctly.
 - Some languages are not correctly triggered with a keyword.

52. SDK Version 1.6.0

52.1. Main Changes

- Software features and optimization:
 - [add-on] Added Xiaomi Xiaoi
 - [add-on] Added iAP2 for AMA
 - Added Google Fast Pair Service 2.0 optional feature
- Bug fixes:
 - [SDK v1.5.0 known issue] Fixed earbuds reconnection failure problem with Alexa application that occurred when user kills the Alexa application on iPhone.
 - [SDK v1.5.0 known issue] Fixed an issue to avoid user hearing the disconnected/connected voice prompt in the partner earbud after turning off the agent earbud.
 - [SDK v1.5.0 known issue] Fixed partner no sound issue when earbuds connect to FCD BT dongle.

53. SDK Version 1.5.0

53.1. Main Changes

- Software features and optimization:
 - [add-on] Added Tencent Xiaowei.
 - Added in-ear speech enhancement for call application.
- Bug fixes:
 - [SDK v1.4.0 known issue] Fixed an issue where an earbud disconnected then reconnected immediately, if user put another device in a charger case or turned off the device.
 - [SDK v1.4.0 known issue] Fixed an issue where a partner earbud may have no sound when FCD connects to earbuds and plays through A2DP.
- Note:
 - Change the name of feature.mk files.
 - In earbuds_ref_design:

Table 53-1. feature.mk Filename Change List

Old name	New name
feature_ab1552_asia.mk	feature_52_asia.mk
feature_ab1552_asia_anc.mk	feature_52_asia_anc.mk
feature_ab1552_asia_anc_mp_log.mk	feature_52_asia_anc_mp_log.mk
feature_ab1552_asia_bt_vendor_codec.mk	feature_52_asia_vendor_codec.mk
feature_ab1552_cnsy.mk	Removed
feature_ab1552_evk.mk	feature_52.mk
feature_ab1552_evk_airoha_aac_decoder.mk	feature_52_airoha_aac.mk
feature_ab1552_evk_bt_vendor_codec.mk	feature_52_vendor_codec.mk
feature_ab1552_evk_gsound.mk	feature_52_gsound.mk
feature_ab1552_evk_smart_charger.mk	feature_52_charger.mk
feature_ab1552_evk_smart_charger_1wire.mk	feature_52_charger_1wire.mk
feature_ab1555_evk.mk	feature_55.mk
feature_ab1555_evk_bt_vendor_codec.mk	feature_55_vendor_codec.mk
feature_ab1556_evk.mk	feature_56.mk
feature_ab1558_evk.mk	feature_58.mk
feature_ab1558_evk_fota_external_flash.mk	feature_58_ext_flash.mk

- In headset_ref_design:

Table 53-2. feature.mk Filename Change List

Old name	New name
feature_ab1552_evk.mk	feature_52.mk
feature_ab1552_evk_bt_vendor_1_codec.mk	Removed
feature_ab1552_evk_bt_vendor_codec.mk	Removed
feature_ab1552_evk_gsound.mk	feature_52_gsound.mk
feature_ab1552_evk_mp_log.mk	feature_52_mp_log.mk
feature_ab1552_line_in.mk	feature_52_line_in.mk
feature_ab1555_evk.mk	feature_55.mk
feature_ab1555_evk_bt_vendor_codec.mk	Removed
feature_ab1556_evk.mk	feature_56.mk
feature_ab1558_evk.mk	feature_58.mk
feature_ab1558_evk_fota_external_flash.mk	feature_58_ext_flash.mk

- Because the config tool reads an NVKey item (0x1001) to check the SDK version, if the customer uses FOTA to upgrade the FW, they must also update the NVKey during the FOTA upgrade procedure or the config tool cannot correctly show when it connects to the device.

53.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- None.

54. SDK Version 1.4.0

54.1. Main Changes

- Software features and optimization:
 - Added one-wire UART smart charger case.
 - Upgraded the GSound from version 30 to 36.
- Bug fixes:
 - Fixed an issue where the A2DP music becomes silent in the severe interference environment.
 - Reduced the power consumption of ANC function in the idle state.

54.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- The Bluetooth service on the iPhone unexpectedly switches on/off when the user performs the following actions when the earbuds are connected and the AMA is also connected: Kill the Alexa application on the iPhone; unpair the BLE and EDR links; reconnect the EDR link; and reopen the Alexa application.
- The EDR link of a partner earbud may be broken if user put the device in a charger case or turn off the device. The user may hear a reconnection voice prompt although the EDR link be reestablished immediately.
- FCD connects to earbuds and play A2DP, partner role may have no sound.

54.3. Migration

Migrate the following module-based applications when upgrading the SDK from version 1.3.2 to version 1.4.0:

54.3.1. Example project – earbuds_ref_design

1) Update memory layout files.

- How to migrate:
 - Replace the following files with the ones in the latest SDK.

```
mcu\project\ab155x_evk\apps\earbuds_ref_design\GCC\ab155x_flash_with_psr.am.ld
mcu\project\ab155x_evk\apps\earbuds_ref_design\GCC\ab155x_flash.ld
```

54.3.2. Example project – headset_ref_design

1) Update memory layout files.

- How to migrate:
 - Replace the following files with the ones in the latest SDK.

```
mcu\project\ab155x_evk\apps\headset_ref_design\GCC\ab155x_flash_with_psr.am.ld
mcu\project\ab155x_evk\apps\headset_ref_design\GCC\ab155x_flash.ld
```

55. SDK Version 1.3.2

55.1. Main Changes

- Bug fixes:
 - Fixed an issue where the USB COM port (Modem Port/Debug Port) could not be identified.
- Note:
 - Upgraded the ATK tool from version 1.3.5 to 1.3.10 and fixed an error related to the audio channel setting. Please upgrade to the latest version.

56. SDK Version 1.3.1

56.1. Main Changes

- Bug fixes:
 - Fixed an issue where the voice prompt was not synchronized between L/R earbuds for noise-cancelling/pass through notifications.
 - Fixed the failed reconnection issue that occurred if users forced the Alexa application to quit on the smartphone.
 - Fixed connection problems that occurred when users switched between different voice assistants (e.g. Alexa, Google Assistant, or Siri).
 - Fixed some interoperability issues to improve the stability of the Bluetooth connection.
 - Fixed a bug and improved the functionality of the ATK tool and SDK for ANC tuning and RF gain setting.
- Note:
 - Corrected the migration section in chapter “SDK Version 1.3.0”.

56.2. Known issues

There is a known issue that occurs with this version of the SDK:

- The Bluetooth service on the iPhone unexpectedly switches on/off when the user performs the following actions when the earbuds are connected and the AMA is also connected: Kill the Alexa application on the iPhone; unpair the BLE and EDR links; reconnect the EDR link; and reopen the Alexa application.

57. SDK Version 1.3.0

57.1. Main Changes

- Software features and optimization:
 - [add-on] Added AMA (Alexa Mobile Accessory)
 - Added multiple voice assistant (AMA and GSound) switch mechanism
 - Added smart charging cases via VBUS
 - Added sync online log to smart phone app
 - Added Google Fast Pair Service 2.0 (mandatory feature only)
- Bug fixes:
 - Enhance FOTA stability for some Android smartphones.
- Notes:
 - Rename Airoha IoT SDK GCC Build Environment Guide to Airoha IoT SDK for BT Audio Build Environment Guide. We also added a script installation approach for both MCU and DSP in the guide.

57.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- On iPhone X (iOS 13.2), the ringtone is output from the iPhone X instead of the headphones when you use Amazon Alexa to start an outgoing call.
- When the headphones are connected to an iPhone 11 (iOS 13.2) and you use the Airoha application to switch between different voice assistants, after some time, the Alexa application shows the device connection status incorrectly (i.e. AMA is connected but it is shown as being offline).
- When the headphones are connected to an iPhone X (iOS 13.2), the Bluetooth connection can break after some time when you use the iPhone settings to unpair and pair the headphones with AMA connected.

57.3. Migration

Migrate the following module-based applications when upgrading the SDK from version 1.2.1 to version 1.3.0:

57.3.1. Example project – earbuds_ref_design

- API naming changed for `audio_anc_force_disable()`.
- How to migrate:
 - Replace `audio_anc_force_disable()` with `audio_anc_suspend()`.
 - Bootloader's feature list updated for 'HAL_HW_SEMAPHORE_STATUS_OK' and 'HW_SEMAPHORE_APLL'.
- How to migrate:
 - Add feature in bootloader's feature list.

- <sdk_root>/project/ab155x_evk/apps/bootloader/inc/hal_feature_config.h

#define HAL_HW_SEMAPHORE_MODULE_ENABLED

- Race and FOTA API naming changed.
- How to migrate:
 - Replace the following files with the ones in the latest SDK.

project\ab155x_evk\apps\earbuds_ref_design\src\race*
project\ab155x_evk\apps\earbuds_ref_design\inc\race*
 - Replace project\ab155x_evk\apps\earbuds_ref_design\src\nvdm_config.c with the one in the latest SDK.
 - Remove race_init() block in task_def_init() defined in file
project\ab155x_evk\apps\earbuds_ref_design\src\task_def.c
 - Replace fota_flash_bootup() with fota_init_flash()

57.3.2. Example project – headset_ref_design

- Bootloader's feature list updated for 'HAL_HW_SEMAPHORE_STATUS_OK' and 'HW_SEMAPHORE_APLL'.
- How to migrate:
 - Add feature in bootloader's feature list.

<sdk_root>/project/ab155x_evk/apps/bootloader/inc/hal_feature_config.h
#define HAL_HW_SEMAPHORE_MODULE_ENABLED
 - Race and FOTA API naming changed.
- How to migrate:
 - Replace the following files with the ones in the latest SDK.

project\ab155x_evk\apps\headset_ref_design\src\race*
project\ab155x_evk\apps\headset_ref_design\inc\race*
 - Replace project\ab155x_evk\apps\headset_ref_design\src\nvdm_config.c with the one in the latest SDK.
 - Remove race_init() block in task_def_init() defined in file
project\ab155x_evk\apps\headset_ref_design\src\task_def.c
 - Replace fota_flash_bootup() with fota_init_flash()

58. SDK Version 1.2.1

58.1. Main changes

- Bug fixes:
 - Resolved an issue where ANC/Pass Through could not be turned off when putting the earbuds into the charging case.

59. SDK Version 1.2.0

59.1. Main changes

- Software features and optimization:
 - [add-on] Added GSound (Google Assistant device firmware implementation)
 - Added Hybrid ANC

60. SDK Version 1.1.0

60.1. Main changes

- Software features and optimization:
 - Added support FOTA with external flash.
 - Added support background FOTA.
 - Added support sync offline log to smart phone app.
 - Added a new service “bt_aws_mce_report” to exchange information between Agent and Partner.
 - Defined an independent key behavior in left and right earbuds.
 - Increased A2DP volume step resolution.
- Bug fixes:
 - Fixed a problem where the uplink voice distorted after a long call.

60.2. Migration

Migrate the following module-based applications when upgrading the SDK from version 1.0.1 to version 1.1.0:

60.2.1. Example project - earbuds_ref_design

- 2) Add the new service bt_aws_mce_report to your project:
 - Add the following module.mk in your GCC project Makefile.


```
include $(SOURCE_DIR)/middleware/MTK/bt_aws_mce_report/module.mk
```
- 3) API changes for information exchange between agent and partner.
 - How to migrate:

Please follow the files change list in Table 60-1. Files Change List.

Table 60-1. Files Change List

API or Event Handle or Enum Structure in SDK_V1.0.1	API or Event Handle or Enum Structure in SDK_V1.1.0	Files and Function
bt_sink_srv_aws_mce_packet_t	bt_aws_mce_report_info_t	app_hfp_idle_activity.c • app_hfp_aws_data_proc_proc()
bt_sink_srv_send_action(BT_SINK_S RV_ACTION_AWS_MCE_SEND_PACK ET)	bt_aws_mce_report_send_event (bt_aws_mce_report_info_t* info)	app_battery_idle_activity.c • partner_notify_battery_level _to_agent()
		app_fast_pair_idle_activity.c • app_fast_pair_transfer_account _key()
		apps_aws_sync_event.c • apps_aws_sync_event_send()
		app_voice_prompt.c

		<ul style="list-style-type: none"> app_voice_prompt_setLang()
		bt_app_common.c <ul style="list-style-type: none"> bt_app_common_sync_random_add() bt_app_common_sync_bonded_info()
bt_sink_srv_send_action(BT_SINK_SRV_ACTION_AWS_MCE_SEND_URGENT_PACKET)	bt_aws_mce_report_send_sync_event(bt_aws_mce_report_info_t* info)	app_voice_prompt.c <ul style="list-style-type: none"> app_voice_prompt_aws_play() app_voice_prompt_aws_stop()
BT_SINK_SRV_EVENT_AWS_MCE_PACKET_RECEIVED_IND	N/A (Note: BT_SINK_SRV_EVENT_AWS_MCE_PACKET_RECEIVED_IND has been removed in SDK V1.1.0.)	app_battery_idle_activity.c <ul style="list-style-type: none"> battery_app_bt_event_proc()
		app_fast_pair_idle_activity.c <ul style="list-style-type: none"> app_fast_pair_sink_event_handle()
		apps_events_bt_event.c <ul style="list-style-type: none"> bt_sink_srv_event_callback()
		app_home_screen_idle_activity.c <ul style="list-style-type: none"> homescreen_app_bt_sink_event_proc()
		app_music_utils.c <ul style="list-style-type: none"> app_bt_music_porc_basic_state_event()
		bt_app_common.c <ul style="list-style-type: none"> bt_app_common_sink_event_proc()
		race_app_aws_event_hdl.c <ul style="list-style-type: none"> race_app_aws_event_handler()
N/A	bt_aws_mce_report_register_callback(bt_aws_mce_report_module_id module_id, bt_aws_mce_report_callback_t callback)	apps_events_bt_event.c <ul style="list-style-type: none"> app_aws_report_event_init()
		apps_voice_prompt.c <ul style="list-style-type: none"> app_voice_prompt_init()
		bt_app_common.c <ul style="list-style-type: none"> bt_app_common_event_callback_register()
		race_app_bt_event_hdl.c <ul style="list-style-type: none"> race_app_init()
N/A	Callback of the service bt_aws_mce_report; Typedef void (*bt_aws_mce_report_callback_t)(bt_aws_mce_report_info_t *param)	apps_voice_prompt.c <ul style="list-style-type: none"> app_voice_prompt_sync_callback()
		bt_app_common.c <ul style="list-style-type: none"> bt_app_common_aws_data_received_ind_handler()
		race_app_aws_event_hdl.c <ul style="list-style-type: none"> bt_race_aws_report_handler()

		<ul style="list-style-type: none"> bt_race_aws_report_handler_int()
		apps_events_bt_event.c
		<ul style="list-style-type: none"> app_aws_report_event_callback()
<pre>typedef enum { EVENT_GROUP_UI_SHELL_APP_INTE RACTION = EVENT_GROUP_UI_SHELL_APP_BASE , EVENT_GROUP_UI_SHELL_KEY, EVENT_GROUP_UI_SHELL_BATTERY, EVENT_GROUP_UI_SHELL_BT, EVENT_GROUP_UI_SHELL_BT_SINK, EVENT_GROUP_UI_SHELL_BT_CONN _MANAGER, EVENT_GROUP_UI_SHELL_FOTA, EVENT_GROUP_UI_SHELL_CHARGER _CASE, EVENT_GROUP_UI_SHELL_AWS, EVENT_GROUP_UI_SHELL_FINDME, EVENT_GROUP_UI_SHELL_BT_FAST_ PAIR, } apps_event_group_t</pre>	<pre>typedef enum { EVENT_GROUP_UI_SHELL_APP_INT ERACTION = EVENT_GROUP_UI_SHELL_APP_BAS E, EVENT_GROUP_UI_SHELL_KEY, EVENT_GROUP_UI_SHELL_BATTERY, EVENT_GROUP_UI_SHELL_BT, EVENT_GROUP_UI_SHELL_BT_SINK, EVENT_GROUP_UI_SHELL_BT_CON N_MANAGER, EVENT_GROUP_UI_SHELL_FOTA, EVENT_GROUP_UI_SHELL_CHARGE R_CASE, EVENT_GROUP_UI_SHELL_AWS, EVENT_GROUP_UI_SHELL_FINDME, EVENT_GROUP_UI_SHELL_BT_FAST_ PAIR, #if defined(MTK_AWS_MCE_ENABLE) EVENT_GROUP_UI_SHELL_AWS_DA TA, #endif } apps_event_group_t;</pre>	apps_events_event_group.h
N/A	app_fast_pair_report_event_callback()	app_fast_pair_idle_activitiy.c app_fast_pair_ilde_activity_proc()
N/A	_proc_aws_report_group()	app_battery_idle_activity.c app_battery_idle_activity_proc()
app_hfp_aws_data_proc_proc()	app_hfp_aws_data_proc_proc()	app_hfp_idle_activity.c app_hfp_idle_activity_proc()
N/A	homescreen_app_aws_data_proc()	app_home_screen_idle_activity.c app_home_screen_idle_activity_proc()
N/A	app_bt_music_porc_aws_data_eve n t()	app_music_idle_activity.c app_music_idle_activity_proc()

4) API changes for information exchange cannot be include when MTK_AWS_MCE_ENABLE is not enabled.

- How to migrate:

- Add “#ifdef MTK_AWS_MCE_ENABLE” and “#endif” to mask all of the contents of <your_project>\inc\apps\utils\apps_aws_sync_event.h

60.2.2. Example project - headset_ref_design

- 1) API changes for information exchange cannot be included when MTK_AWS_MCE_ENABLE is not enabled.
 - How to migrate:

Add “#ifdef MTK_AWS_MCE_ENABLE” and “#endif” to mask all of the contents of <your_project>\inc\apps\utils\apps_aws_sync_event.h

61. SDK Version 1.0.1

61.1. Main changes

- Software features and optimization:
 - Stability enhancement for long time usage.
 - Enhanced voice quality during a phone call.
 - Increased the BT connection success rate.
- Bug fixes:
 - Resolved an issue where it took too long time for the device to connect to the smartphone. The device and smartphone now connect much more quickly when the device powers on.
 - Fixed a problem where the “incoming call” voice prompt was played at slightly different times by the left and right earbuds.
- Notes:
 - Corrected the Audio support descriptions in chapter “SDK Version 1.0.0”.

62. SDK Version 1.0.0

62.1. Main changes

- Software features and optimization
 - Bluetooth
 - Multi Cast Synchronization (MCSync): It's an Airoha proprietary profile to support voice/audio over multiple Bluetooth Audio devices.
 - A2DP(SINK) v1.3.1
 - AVRCP(CT) v1.6.1
 - HFP(HF) v1.7
 - HSP(HF) v1.2
 - Google fast pair v2.0
 - Air pairing
 - Bluetooth low energy
 - ANCS Client
 - AMS Client
 - Audio
 - 1 MIC/2 MIC noise reduction
 - Wind noise reduction
 - Echo cancellation
 - Voice prompt
 - Noise Dependent Volume Control (NDVC) for BT Voice
 - Hardware Sample Rate Converter (HWSRC)
 - EQ/DRC for A2DP
 - Codecs for A2DP (SBC/AAC) voice prompt (MP3) and BT voice (CVSD/mSBC)
 - audio passthrough
 - Charger
 - USB battery charging specification revision 1.2
 - Temperature detection (HW JEITA)
 - Fast charger Mode
 - Power Mode
 - Dynamic Voltage and Frequency Scaling (DVFS)
 - Other
 - UI Shell
 - Firmware-over-the-Air (FOTA)
- Notes:

- The features in this SDK Package are supported on AB1552.

62.2. Known issues

There are known issues with this version of the SDK. Avoid the following:

- There may be some issues where the audio does not play smoothly on some smartphones when the A2DP stream has a very low bitrate.
- An eSCO link is not created when a BT headset connects for the first time to a specific smartphone with Android version 9.0, and it is in talking mode.